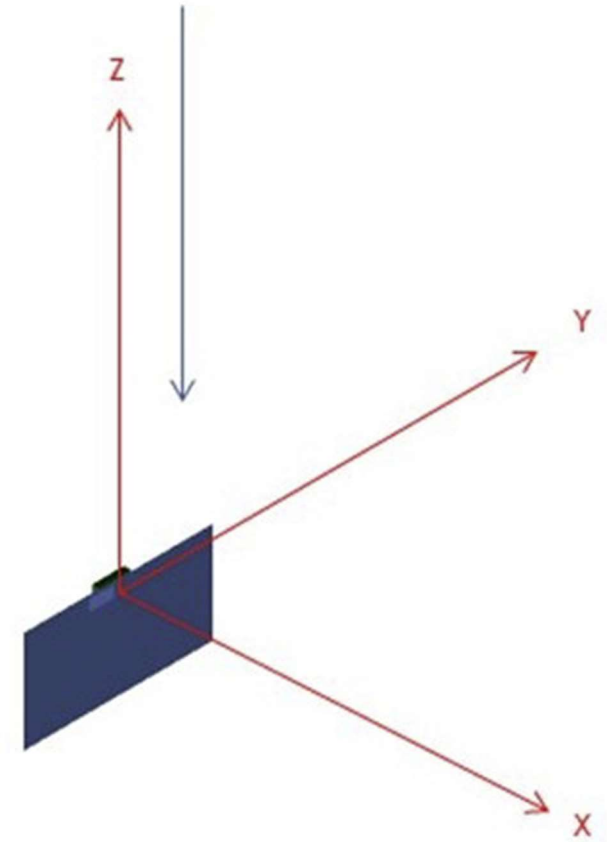
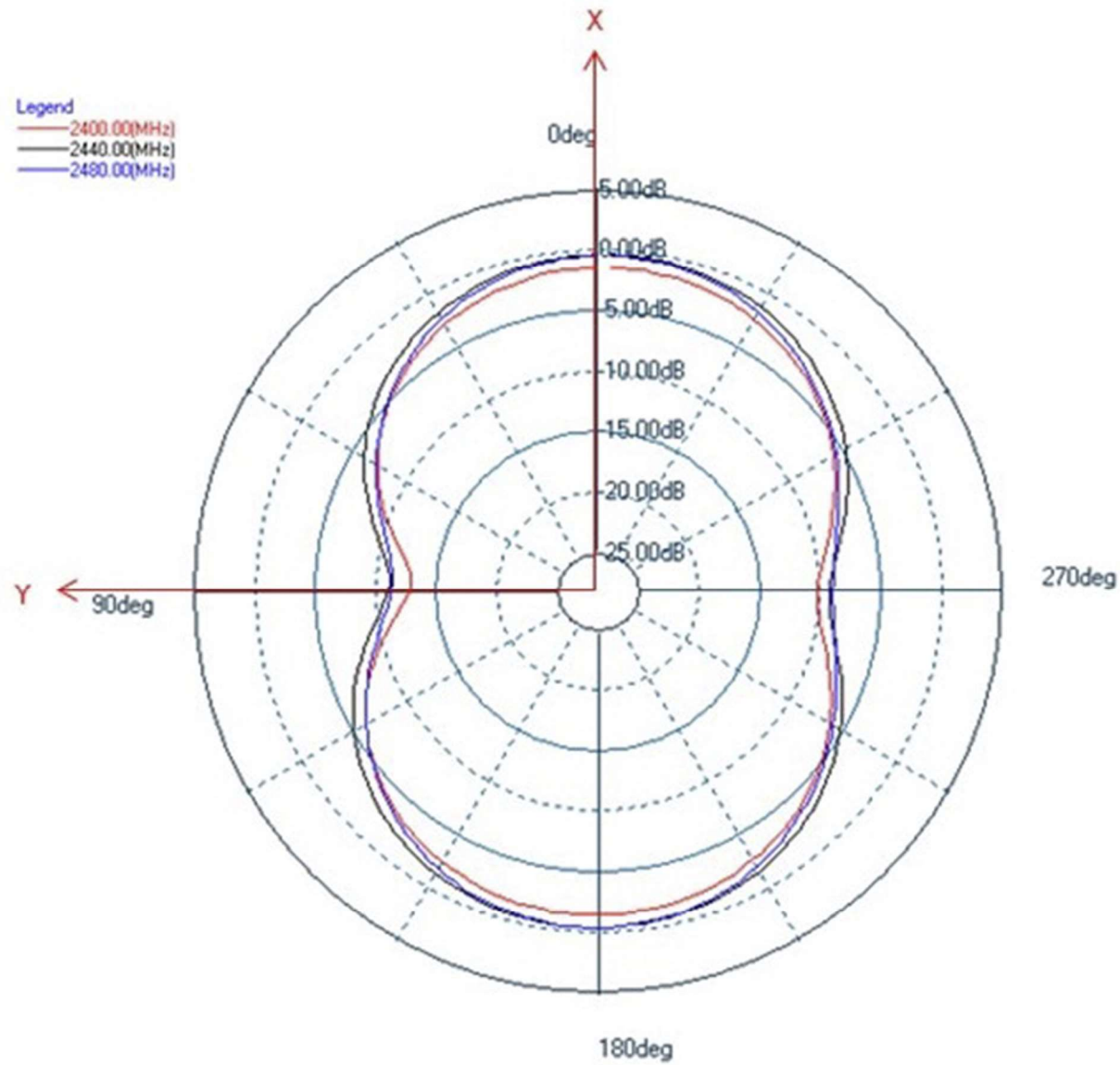


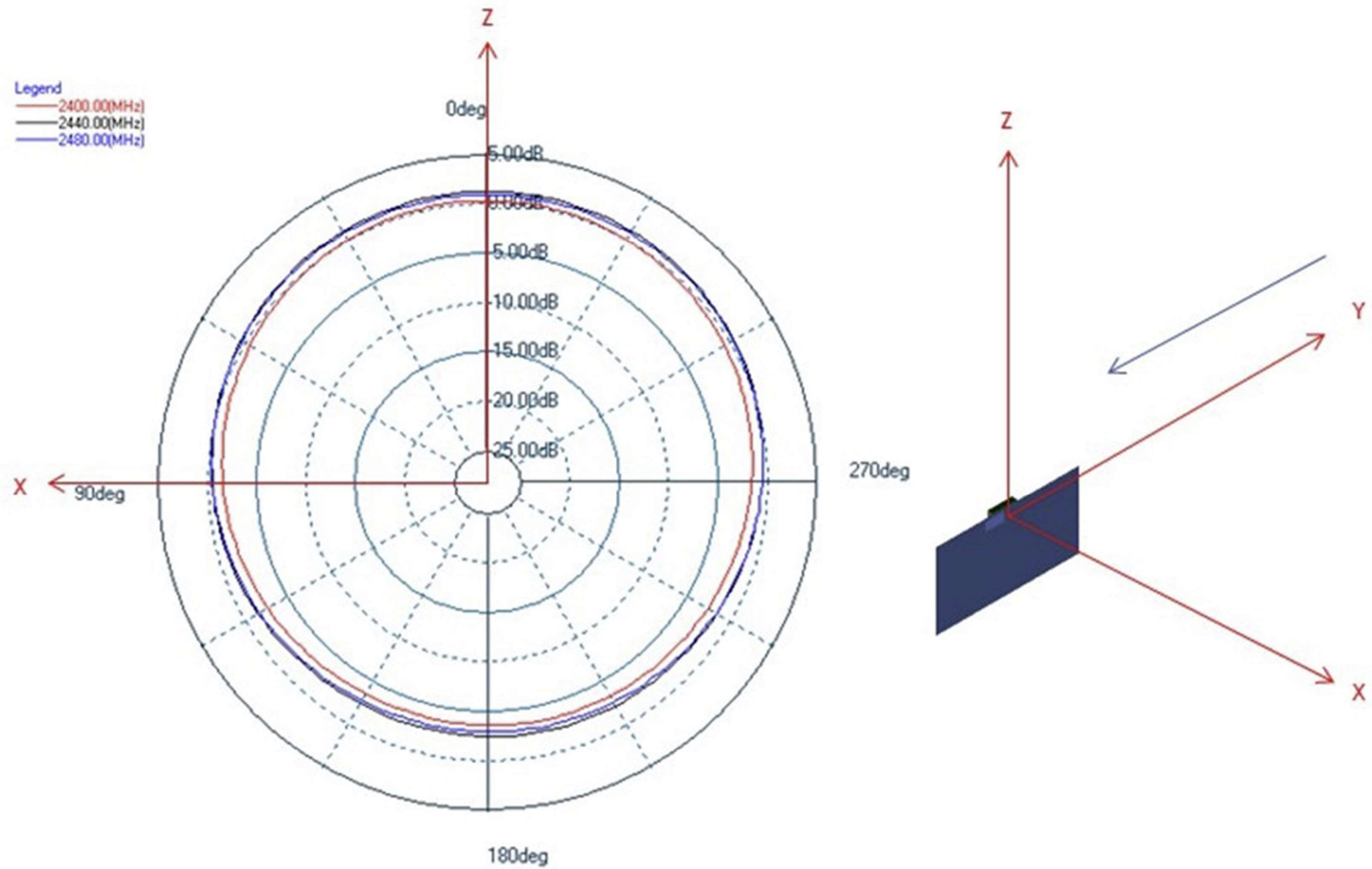
4. Antenna spec

- BGM121256V2 데이터 시트, 50~51쪽

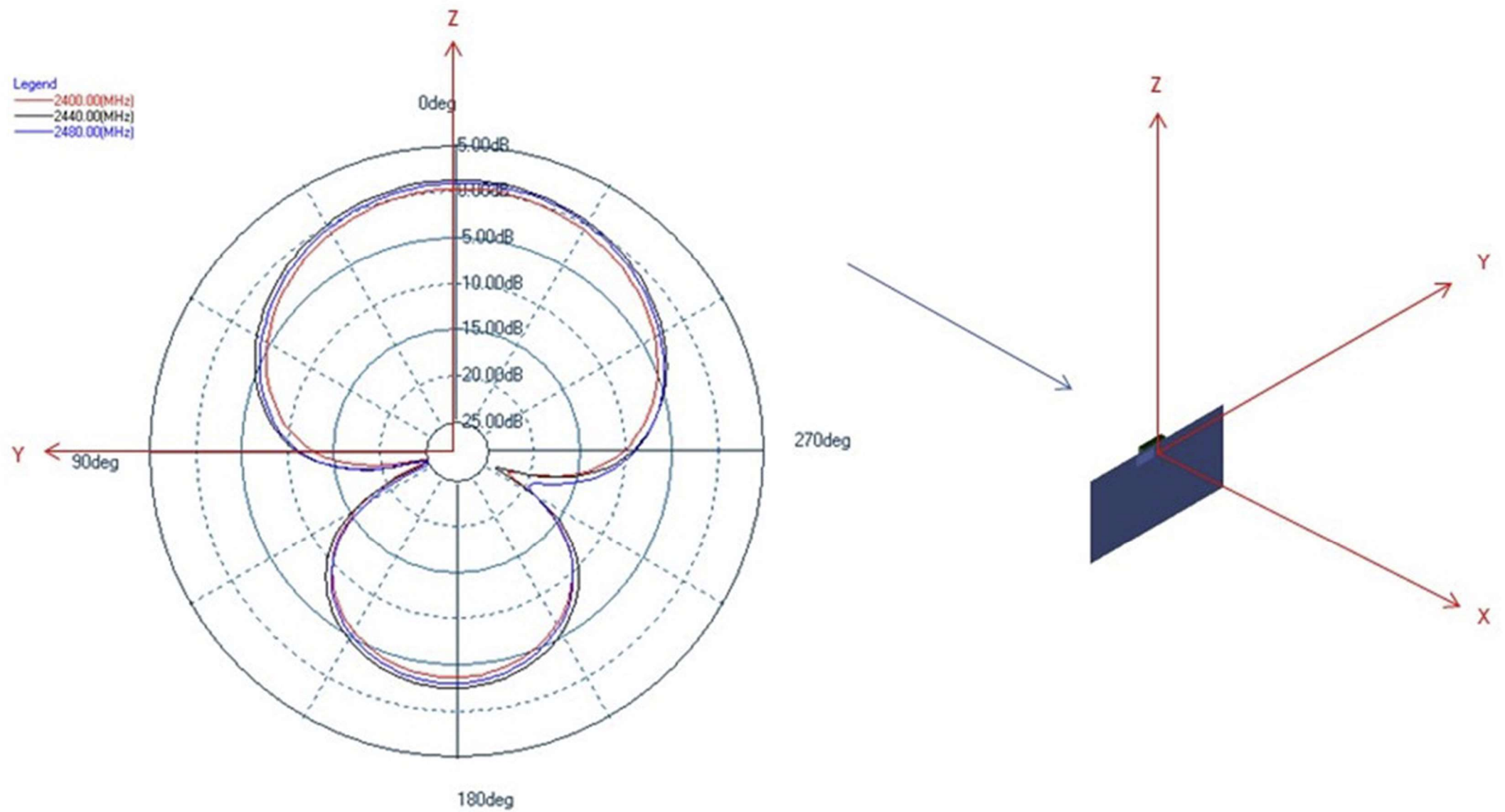
4.1 안테나 방사 패턴-front



4.2 안테나 방사 패턴-side



4.3 안테나 방사 패턴-top



BGM121/BGM123 Blue Gecko *Bluetooth*® SiP Module Data Sheet



The BGM121/BGM123 Blue Gecko *Bluetooth*® SiP Module family is targeted for applications where ultra-small size, reliable high performance RF, low-power consumption and easy application development are key requirements.

At 6.5 x 6.5 x 1.4 mm the BGM121/BGM123 module fits applications where size is a constraint. BGM121/BGM123 also integrates a high performance, ultra robust antenna, which requires minimal PCB, plastic and metal clearance. The total PCB area required by BGM121/BGM123 is only 51 mm².

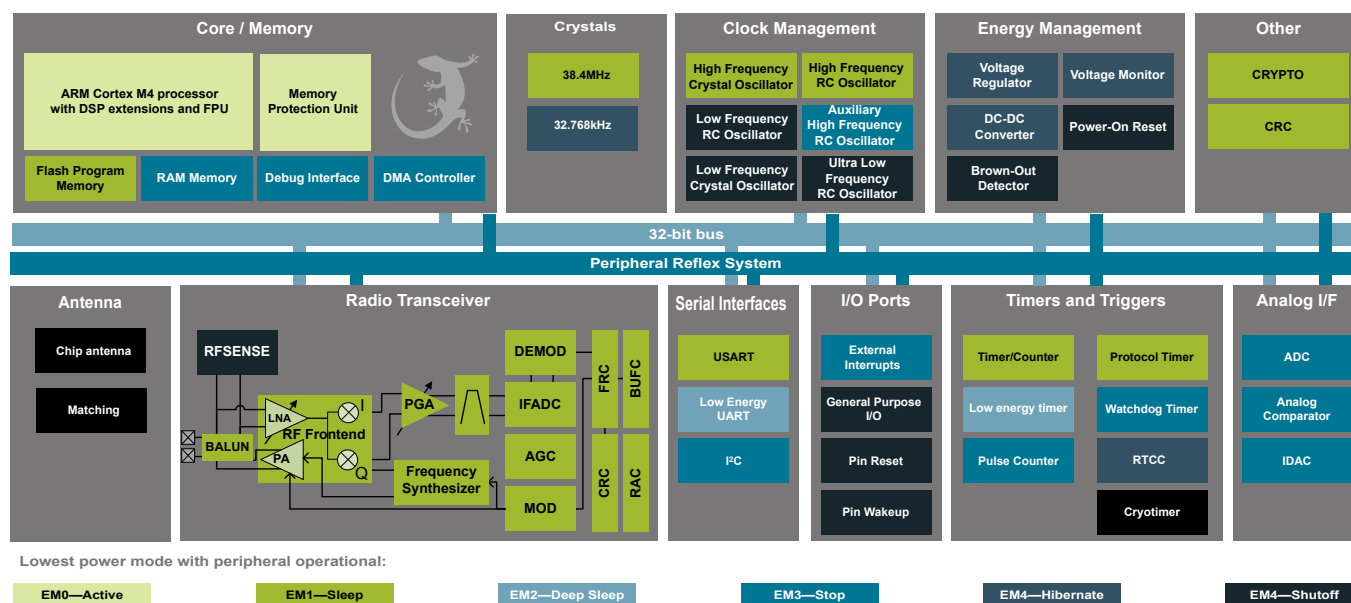
The BGM121/BGM123 also integrates a *Bluetooth* 4.2 compliant Bluetooth stack and it can also run end-user applications on-board or alternatively used as a network co-processor over one of the host interfaces.

BGM121/BGM123 SiP modules can be used in a wide variety of applications:

- Wearables
- IoT end devices and gateways
- Health, sports and wellness devices
- Industrial, home and building automation
- Smart phone, tablet and PC accessories
- Beacons

KEY FEATURES

- Bluetooth 4.2 low energy compliant
- Integrated antenna or RF pin
- TX power up to 8 dBm
- RX sensitivity: -90 dBm
- Range: up to 200 meters
- 32-bit ARM® Cortex®-M4 core at 38.4 MHz
- Flash memory: 256 kB
- RAM: 32 kB
- Autonomous Hardware Crypto Accelerator and Random Number Generator
- Integrated DC-DC Converter
- Onboard Bluetooth stack



1. Feature List

The BGM121/BGM123 highlighted features are listed below.

- **Low Power Wireless System-on-Chip.**
 - High Performance 32-bit 38.4 MHz ARM Cortex®-M4 with DSP instruction and floating-point unit for efficient signal processing
 - 256 kB flash program memory
 - 32 kB RAM data memory
 - 2.4 GHz radio operation
 - TX power up to 8 dBm
- **Low Energy Consumption**
 - 9.0 mA RX current at 2.4 GHz
 - 8.2 mA TX current @ 0 dBm output power at 2.4 GHz
 - 63 µA/MHz in Active Mode (EM0)
 - 2.5 µA EM2 DeepSleep current (full RAM retention and RTCC running from LFXO)
 - 2.1 µA EM3 Stop current (State/RAM retention)
 - Wake on Radio with signal strength detection, preamble pattern detection, frame detection and timeout
- **High Receiver Performance**
 - -90 dBm sensitivity @ 1 Mbit/s GFSK (2.4 GHz)
- **Supported Protocols**
 - Bluetooth®
- **Support for Internet Security**
 - General Purpose CRC
 - Random Number Generator
 - Hardware Cryptographic Acceleration for AES 128/256, SHA-1, SHA-2 (SHA-224 and SHA-256) and ECC
- **Wide Selection of MCU peripherals**
 - 12-bit 1 Msps SAR Analog to Digital Converter (ADC)
 - 2 × Analog Comparator (ACMP)
 - Digital to Analog Current Converter (IDAC)
 - 32 pins connected to analog channels (APORT) shared between Analog Comparators, ADC, and IDAC
 - 30 General Purpose I/O pins with output state retention and asynchronous interrupts
 - 8 Channel DMA Controller
 - 12 Channel Peripheral Reflex System (PRS)
 - 2×16-bit Timer/Counter
 - 3 + 4 Compare/Capture/PWM channels
 - 32-bit Real Time Counter and Calendar
 - 16-bit Low Energy Timer for waveform generation
 - 32-bit Ultra Low Energy Timer/Counter for periodic wake-up from any Energy Mode
 - 16-bit Pulse Counter with asynchronous operation
 - Watchdog Timer with dedicated RC oscillator @ 50nA
 - 2×Universal Synchronous/Asynchronous Receiver/Transmitter (UART/SPI/SmartCard (ISO 7816)/IrDA/I²S)
 - Low Energy UART (LEUART™)
 - I²C interface with SMBus support and address recognition in EM3 Stop
- **Wide Operating Range**
 - 1.85 V to 3.8 V single power supply
 - 2.4 V to 3.8 V when using DC-DC
 - Integrated DC-DC
 - -40 °C to +85 °C
- **Dimensions**
 - 6.5 x 6.5 x 1.4 mm

2. Ordering Information

Ordering Code	Protocol Stack	Frequency Band	Max TX Power (dBm)	Antenna	Flash (KB)	RAM (KB)	GPIO	Package
BGM123A256V1R ¹	Bluetooth Smart	2.4 GHz	+3	Built-in	256	32	30	1000 pcs reel
BGM123A256V1 ¹	Bluetooth Smart	2.4 GHz	+3	Built-in	256	32	30	260 pcs tray
BGM123N256V1R ¹	Bluetooth Smart	2.4 GHz	+3	RF pin	256	32	30	1000 pcs reel
BGM123N256V1 ¹	Bluetooth Smart	2.4 GHz	+3	RF pin	256	32	30	260 pcs tray
BGM121A256V1R ¹	Bluetooth Smart	2.4 GHz	+8	Built-in	256	32	30	1000 pcs reel
BGM121A256V1 ¹	Bluetooth Smart	2.4 GHz	+8	Built-in	256	32	30	260 pcs tray
BGM121N256V1R ¹	Bluetooth Smart	2.4 GHz	+8	RF pin	256	32	30	1000 pcs reel
BGM121N256V1 ¹	Bluetooth Smart	2.4 GHz	+8	RF pin	256	32	30	260 pcs tray
BGM123A256V2R	Bluetooth Smart	2.4 GHz	+3	Built-in	256	32	30	1000 pcs reel
BGM123A256V2	Bluetooth Smart	2.4 GHz	+3	Built-in	256	32	30	260 pcs tray
BGM123N256V2R	Bluetooth Smart	2.4 GHz	+3	RF pin	256	32	30	1000 pcs reel
BGM123N256V2	Bluetooth Smart	2.4 GHz	+3	RF pin	256	32	30	260 pcs tray
BGM121A256V2R	Bluetooth Smart	2.4 GHz	+8	Built-in	256	32	30	1000 pcs reel
BGM121A256V2	Bluetooth Smart	2.4 GHz	+8	Built-in	256	32	30	260 pcs tray
BGM121N256V2R	Bluetooth Smart	2.4 GHz	+8	RF pin	256	32	30	1000 pcs reel
BGM121N256V2	Bluetooth Smart	2.4 GHz	+8	RF pin	256	32	30	260 pcs tray
SLWSTK6101C ²								
SLWRB4302A ³								

Note:

1. V1 is the Initial production / engineering sample version and is not certified. V2 is the Full production version and will be certified.
2. Blue Gecko Bluetooth Module Wireless Starter Kit (WSTK) with BGM121A256 radio board (SLWRB4302A) and BGM111A256 radio board (SLWRB4300A), expansion board and accessories.
3. BGM121A256 Radio Board

3. System Overview

3.1 Introduction

The BGM121/BGM123 product family combines an energy-friendly MCU with a highly integrated radio transceiver. The devices are well suited for any battery operated application, as well as other system requiring high performance and low-energy consumption. This section gives a short introduction to the full radio and MCU system. A detailed functional description can be found in the *EFR32BG1 Blue Gecko Bluetooth® Smart SoC Family Data Sheet* (see general sections and QFN48 2.4 GHz SoC related sections).

A detailed block diagram of the EFR32BG SoC is shown in the figure below which is used in the BGM121/BGM123 Bluetooth Smart module.

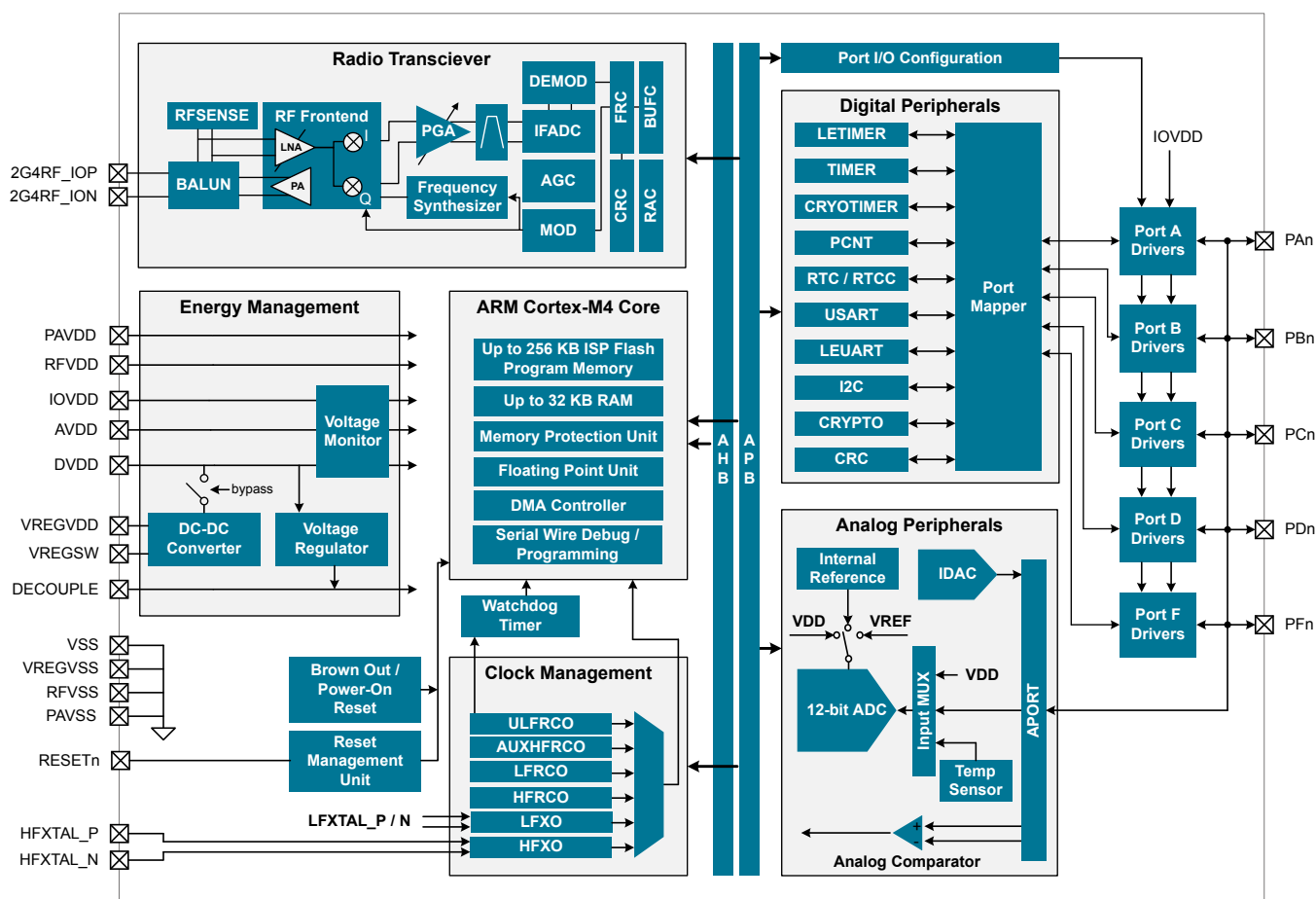


Figure 3.1. Detailed EFR32BG1 Block Diagram

3.2 Radio

The BGM121/BGM123 features a radio transceiver supporting Bluetooth® low energy protocol.

3.2.1 Antenna Interface

BGM121/BGM123 has a built in 2.4GHz ceramic chip antenna or 50 ohm RF pin.

Table 3.1. Antenna Efficiency and Peak Gain

Parameter	With optimal layout	Note
Efficiency	-1 to -2 dB	Efficiency and peak gain depend on the application PCB layout and mechanical design
Peak gain	1 dBi	

3.2.2 Wake on Radio

The Wake on Radio feature allows flexible, autonomous RF sensing, qualification, and demodulation without required MCU activity, using a subsystem of the BGM121/BGM123 including the Radio Controller (RAC), Peripheral Reflex System (PRS), and Low Energy peripherals.

3.2.3 RFSENSE

The RFSENSE module generates a system wakeup interrupt upon detection of wideband RF energy at the antenna interface, providing true RF wakeup capabilities from low energy modes including EM2, EM3 and EM4.

RFSENSE triggers on a relatively strong RF signal and is available in the lowest energy modes, allowing exceptionally low energy consumption. RFSENSE does not demodulate or otherwise qualify the received signal, but software may respond to the wakeup event by enabling normal RF reception.

Various strategies for optimizing power consumption and system response time in presence of false alarms may be employed using available timer peripherals.

3.2.4 Packet and State Trace

The BGM121/BGM123 Frame Controller has a packet and state trace unit that provides valuable information during the development phase. It features:

- Non-intrusive trace of transmit data, receive data and state information
- Data observability on a single-pin UART data output, or on a two-pin SPI data output
- Configurable data output bitrate / baudrate
- Multiplexed transmitted data, received data and state / meta information in a single serial data stream

3.2.5 Random Number Generator

The Frame Controller (FRC) implements a random number generator that uses entropy gathered from noise in the RF receive chain. The data is suitable for use in cryptographic applications.

Output from the random number generator can be used either directly or as a seed or entropy source for software-based random number generator algorithms such as Fortuna.

3.3 Power

The BGM121/BGM123 has an Energy Management Unit (EMU) and efficient integrated regulators to generate internal supply voltages. Only a single external supply voltage is required, from which all internal voltages are created. An integrated DC-DC buck regulator is utilized to further reduce the current consumption.

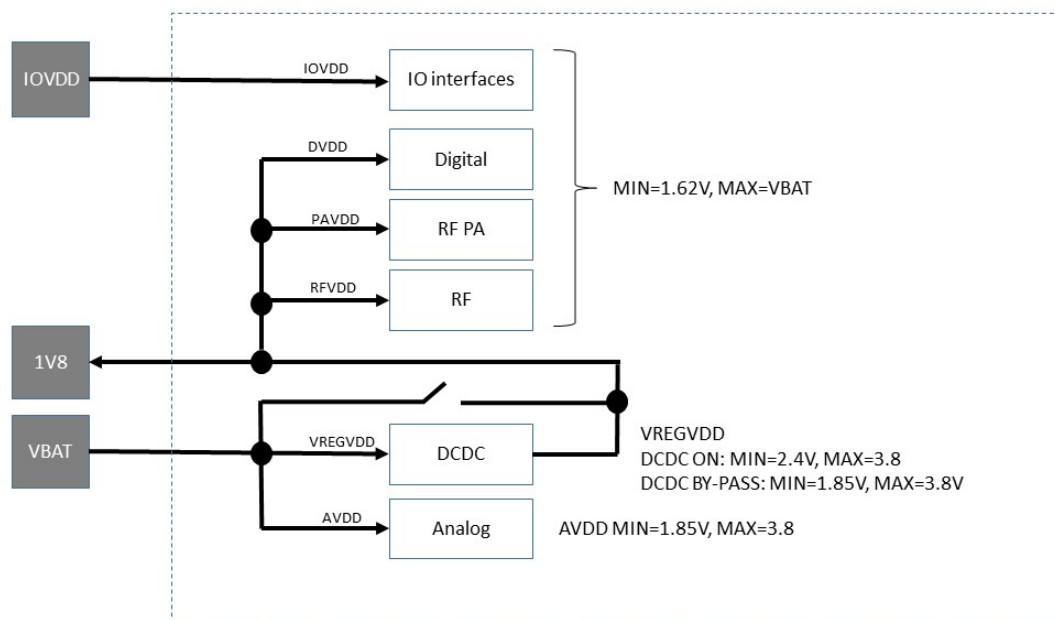


Figure 3.2. Power Supply Configuration

3.3.1 Energy Management Unit (EMU)

The Energy Management Unit manages transitions of energy modes in the device. Each energy mode defines which peripherals and features are available and the amount of current the device consumes. The EMU can also be used to turn off the power to unused RAM blocks, and it contains control registers for the dc-dc regulator and the Voltage Monitor (VMON). The VMON is used to monitor multiple supply voltages. It has multiple channels which can be programmed individually by the user to determine if a sensed supply has fallen below a chosen threshold.

3.3.2 DC-DC Converter

The DC-DC buck converter covers a wide range of load currents and provides up to 90% efficiency in energy modes EM0, EM1, EM2 and EM3. Patented RF noise mitigation allows operation of the DC-DC converter without degrading sensitivity of radio components. Protection features include programmable current limiting, short-circuit protection, and dead-time protection. The DC-DC converter may also enter bypass mode when the input voltage is too low for efficient operation. In bypass mode, the DC-DC input supply is internally connected directly to its output through a low resistance switch. Bypass mode also supports in-rush current limiting to prevent input supply voltage droops due to excessive output current transients.

3.4 General Purpose Input/Output (GPIO)

BGM121/BGM123 has up to 30 General Purpose Input/Output pins. Each GPIO pin can be individually configured as either an output or input. More advanced configurations including open-drain, open-source, and glitch-filtering can be configured for each individual GPIO pin. The GPIO pins can be overridden by peripheral connections, like SPI communication. Each peripheral connection can be routed to several GPIO pins on the device. The input value of a GPIO pin can be routed through the Peripheral Reflex System to other peripherals. The GPIO subsystem supports asynchronous external pin interrupts.

3.5 Clocking

3.5.1 Clock Management Unit (CMU)

The Clock Management Unit controls oscillators and clocks in the BGM121/BGM123. Individual enabling and disabling of clocks to all peripheral modules is performed by the CMU. The CMU also controls enabling and configuration of the oscillators. A high degree of flexibility allows software to optimize energy consumption in any specific application by minimizing power dissipation in unused peripherals and oscillators.

3.5.2 Internal Oscillators

The BGM121/BGM123 fully integrates two crystal oscillators and four RC oscillators, listed below.

- A 38.4MHz high frequency crystal oscillator (HFXO) provides a precise timing reference for the MCU and radio.
- A 32.768 kHz crystal oscillator (LFXO) provides an accurate timing reference for low energy modes.
- An integrated high frequency RC oscillator (HFRCO) is available for the MCU system, when crystal accuracy is not required. The HFRCO employs fast startup at minimal energy consumption combined with a wide frequency range.
- An integrated auxiliary high frequency RC oscillator (AUXHFRCO) is available for timing the general-purpose ADC and the Serial Wire debug port with a wide frequency range.
- An integrated low frequency 32.768 kHz RC oscillator (LFRCO) can be used as a timing reference in low energy modes, when crystal accuracy is not required.
- An integrated ultra-low frequency 1 kHz RC oscillator (ULFRCO) is available to provide a timing reference at the lowest energy consumption in low energy modes.

3.6 Counters/Timers and PWM

3.6.1 Timer/Counter (TIMER)

TIMER peripherals keep track of timing, count events, generate PWM outputs and trigger timed actions in other peripherals through the PRS system. The core of each TIMER is a 16-bit counter with up to 4 compare/capture channels. Each channel is configurable in one of three modes. In capture mode, the counter state is stored in a buffer at a selected input event. In compare mode, the channel output reflects the comparison of the counter to a programmed threshold value. In PWM mode, the TIMER supports generation of pulse-width modulation (PWM) outputs of arbitrary waveforms defined by the sequence of values written to the compare registers, with optional dead-time insertion available in timer unit TIMER_0 only.

3.6.2 Real Time Counter and Calendar (RTCC)

The Real Time Counter and Calendar (RTCC) is a 32-bit counter providing timekeeping in all energy modes. The RTCC includes a Binary Coded Decimal (BCD) calendar mode for easy time and date keeping. The RTCC can be clocked by any of the on-board oscillators with the exception of the AUXHFRCO, and it is capable of providing system wake-up at user defined instances. When receiving frames, the RTCC value can be used for timestamping. The RTCC includes 128 bytes of general purpose data retention, allowing easy and convenient data storage in all energy modes.

3.6.3 Low Energy Timer (LETIMER)

The unique LETIMER is a 16-bit timer that is available in energy mode EM2 Deep Sleep in addition to EM1 Sleep and EM0 Active. This allows it to be used for timing and output generation when most of the device is powered down, allowing simple tasks to be performed while the power consumption of the system is kept at an absolute minimum. The LETIMER can be used to output a variety of waveforms with minimal software intervention. The LETIMER is connected to the Real Time Counter and Calendar (RTCC), and can be configured to start counting on compare matches from the RTCC.

3.6.4 Ultra Low Power Wake-up Timer (CRYOTIMER)

The CRYOTIMER is a 32-bit counter that is capable of running in all energy modes. It can be clocked by either the 32.768 kHz crystal oscillator (LFXO), the 32.768 kHz RC oscillator (LFRCO), or the 1 kHz RC oscillator (ULFRCO). It can provide periodic Wakeup events and PRS signals which can be used to wake up peripherals from any energy mode. The CRYOTIMER provides a wide range of interrupt periods, facilitating flexible ultra-low energy operation.

3.6.5 Pulse Counter (PCNT)

The Pulse Counter (PCNT) peripheral can be used for counting pulses on a single input or to decode quadrature encoded inputs. The clock for PCNT is selectable from either an external source on pin PCTNn_S0IN or from an internal timing reference, selectable from among any of the internal oscillators, except the AUXHFRCO. The module may operate in energy mode EM0 Active, EM1 Sleep, EM2 Deep Sleep, and EM3 Stop.

3.6.6 Watchdog Timer (WDOG)

The watchdog timer can act both as an independent watchdog or as a watchdog synchronous with the CPU clock. It has windowed monitoring capabilities, and can generate a reset or different interrupts depending on the failure mode of the system. The watchdog can also monitor autonomous systems driven by PRS.

3.7 Communications and Other Digital Peripherals

3.7.1 Universal Synchronous/Asynchronous Receiver/Transmitter (USART)

The Universal Synchronous/Asynchronous Receiver/Transmitter is a flexible serial I/O module. It supports full duplex asynchronous UART communication with hardware flow control as well as RS-485, SPI, MicroWire and 3-wire. It can also interface with devices supporting:

- ISO7816 SmartCards
- IrDA
- I²S

3.7.2 Low Energy Universal Asynchronous Receiver/Transmitter (LEUART)

The unique LEUART™ provides two-way UART communication on a strict power budget. Only a 32.768 kHz clock is needed to allow UART communication up to 9600 baud. The LEUART includes all necessary hardware to make asynchronous serial communication possible with a minimum of software intervention and energy consumption.

3.7.3 Inter-Integrated Circuit Interface (I²C)

The I²C module provides an interface between the MCU and a serial I²C bus. It is capable of acting as both a master and a slave and supports multi-master buses. Standard-mode, fast-mode and fast-mode plus speeds are supported, allowing transmission rates from 10 kbit/s up to 1 Mbit/s. Slave arbitration and timeouts are also available, allowing implementation of an SMBus-compliant system. The interface provided to software by the I²C module allows precise timing control of the transmission process and highly automated transfers. Automatic recognition of slave addresses is provided in active and low energy modes.

3.7.4 Peripheral Reflex System (PRS)

The Peripheral Reflex System provides a communication network between different peripheral modules without software involvement. Peripheral modules producing Reflex signals are called producers. The PRS routes Reflex signals from producers to consumer peripherals which in turn perform actions in response. Edge triggers and other functionality can be applied by the PRS. The PRS allows peripheral to act autonomously without waking the MCU core, saving power.

3.8 Security Features

3.8.1 GPCRC (General Purpose Cyclic Redundancy Check)

The GPCRC module implements a Cyclic Redundancy Check (CRC) function. It supports both 32-bit and 16-bit polynomials. The supported 32-bit polynomial is 0x04C11DB7 (IEEE 802.3), while the 16-bit polynomial can be programmed to any value, depending on the needs of the application.

3.8.2 Crypto Accelerator (CRYPTO)

The Crypto Accelerator is a fast and energy-efficient autonomous hardware encryption and decryption accelerator. It supports AES encryption and decryption with 128- or 256-bit keys and ECC over both GF(P) and GF(2^m), SHA-1 and SHA-2 (SHA-224 and SHA-256).

Supported modes of operation for AES include: ECB, CTR, CBC, PCBC, CFB, OFB, CBC-MAC, GMAC and CCM.

Supported ECC NIST recommended curves include P-192, P-224, P-256, K-163, K-233, B-163 and B-233.

The CRYPTO is tightly linked to the Radio Buffer Controller (BUFC) enabling fast and efficient autonomous cipher operations on data buffer content. It allows fast processing of GCM (AES), ECC and SHA with little CPU intervention. CRYPTO also provides trigger signals for DMA read and write operations.

3.9 Analog

3.9.1 Analog Port (APORT)

The Analog Port (APORT) is an analog interconnect matrix allowing access to analog modules ADC, ACMP, and IDAC on a flexible selection of pins. Each APORT bus consists of analog switches connected to a common wire. Since many clients can operate differentially, buses are grouped by X/Y pairs.

3.9.2 Analog Comparator (ACMP)

The Analog Comparator is used to compare the voltage of two analog inputs, with a digital output indicating which input voltage is higher. Inputs are selected from among internal references and external pins. The tradeoff between response time and current consumption is configurable by software. Two 6-bit reference dividers allow for a wide range of internally-programmable reference sources. The ACMP can also be used to monitor the supply voltage. An interrupt can be generated when the supply falls below or rises above the programmable threshold.

3.9.3 Analog to Digital Converter (ADC)

The ADC is a Successive Approximation Register (SAR) architecture, with a resolution of up to 12 bits at up to 1 MSamples/s. The output sample resolution is configurable and additional resolution is possible using integrated hardware for averaging over multiple samples. The ADC includes integrated voltage references and an integrated temperature sensor. Inputs are selectable from a wide range of sources, including pins configurable as either single-ended or differential.

3.9.4 Digital to Analog Current Converter (IDAC)

The Digital to Analog Current Converter can source or sink a configurable constant current. This current can be driven on an output pin or routed to the selected ADC input pin for capacitive sensing. The current is programmable between 0.05 µA and 64 µA with several ranges with various step sizes.

3.10 Reset Management Unit (RMU)

The RMU is responsible for handling reset of the BGM121/BGM123. A wide range of reset sources are available, including several power supply monitors, pin reset, software controlled reset, core lockup reset and watchdog reset.

3.11 Core and Memory

3.11.1 Processor Core

The ARM Cortex-M4F processor includes a 32-bit RISC processor integrating the following features and tasks in the system:

- ARM Cortex-M4F RISC processor achieving 1.25 Dhrystone MIPS/MHz
- Memory Protection Unit (MPU) supporting up to 8 memory segments
- 256 KB flash program memory
- 32 KB RAM data memory
- Configuration and event handling of all modules
- 2-pin Serial-Wire debug interface

3.11.2 Memory System Controller (MSC)

The Memory System Controller (MSC) is the program memory unit of the microcontroller. The flash memory is readable and writable from both the Cortex-M and DMA. The flash memory is divided into two blocks; the main block and the information block. Program code is normally written to the main block, whereas the information block is available for special user data and flash lock bits. There is also a read-only page in the information block containing system and device calibration data. Read and write operations are supported in energy modes EM0 Active and EM1 Sleep.

3.11.3 Linked Direct Memory Access Controller (LDMA)

The Linked Direct Memory Access (LDMA) controller features 8 channels capable of performing memory operations independently of software. This reduces both energy consumption and software workload. The LDMA allows operations to be linked together and staged, enabling sophisticated operations to be implemented.

3.12 Memory Map

The BGM121/BGM123 memory map is shown in the figures below.

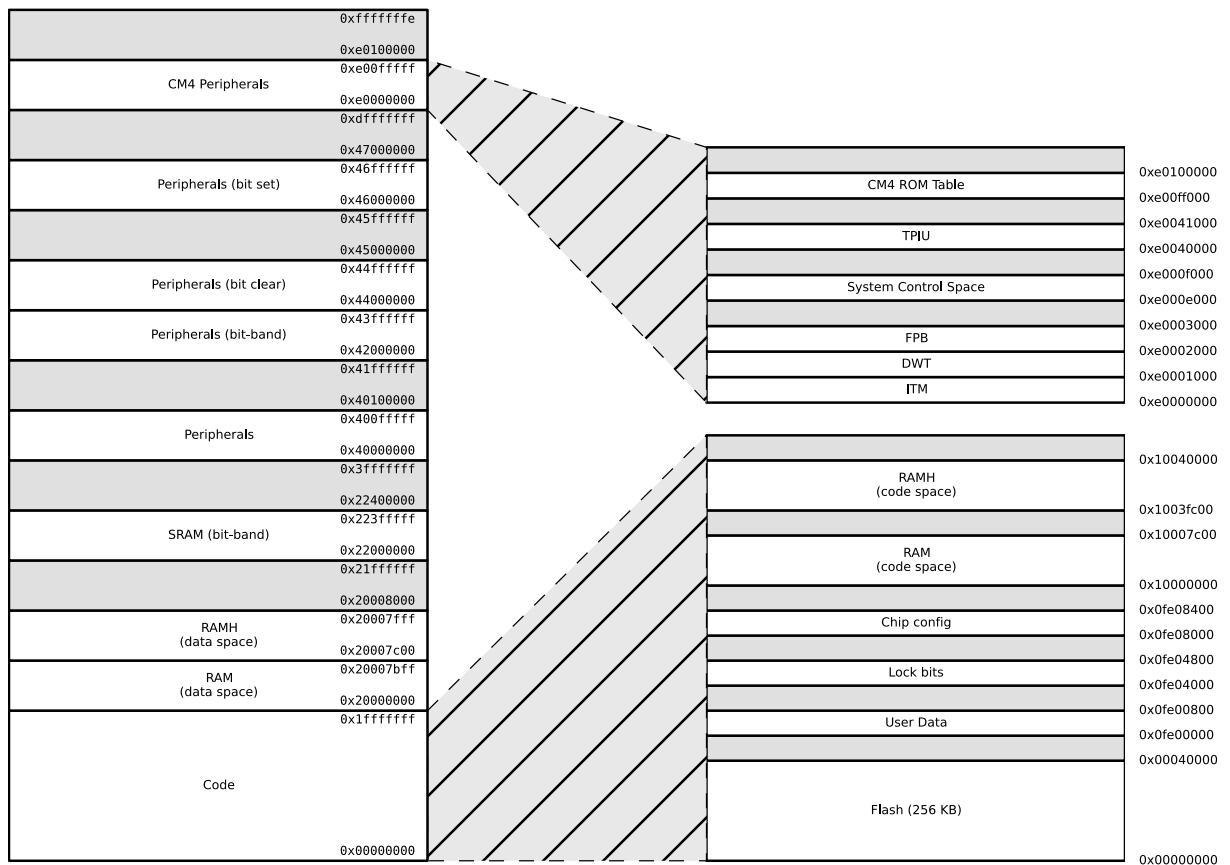


Figure 3.3. BGM121/BGM123 Memory Map — Core Peripherals and Code Space

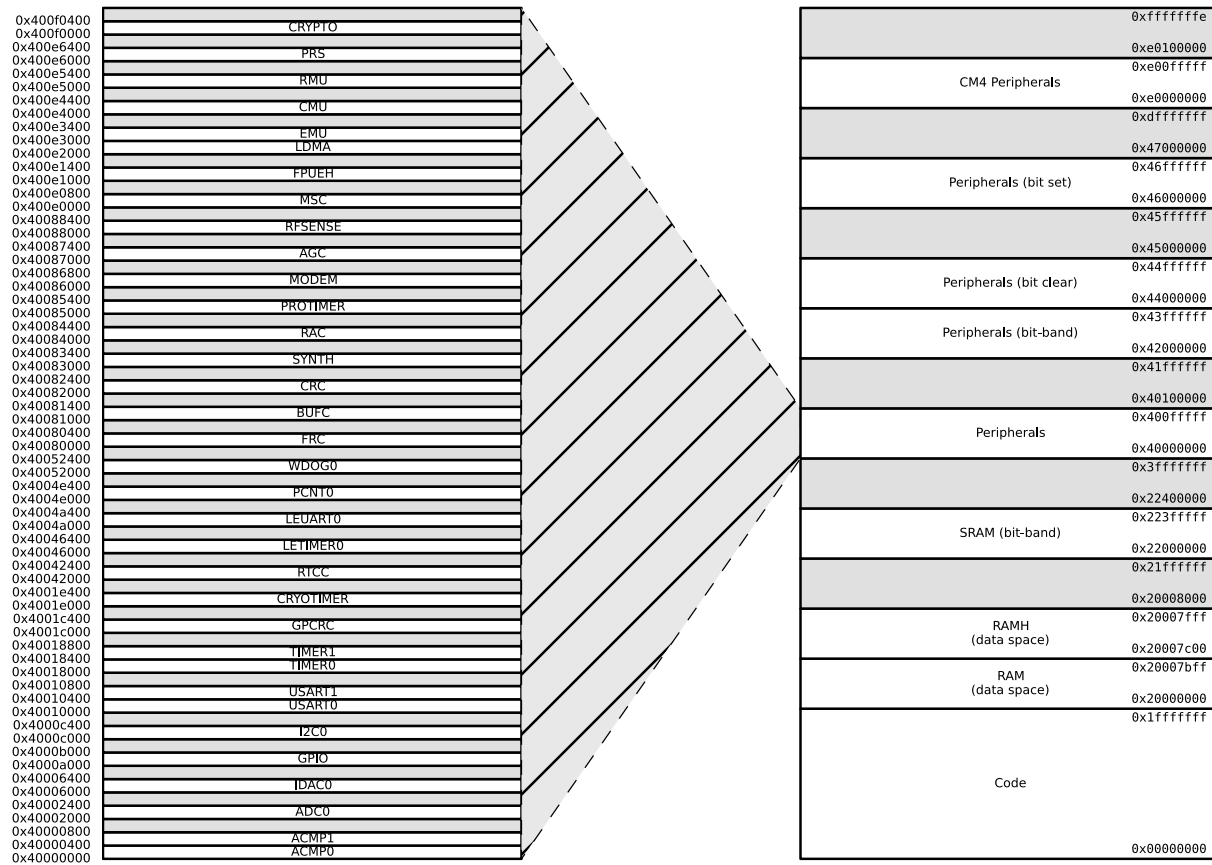


Figure 3.4. BGM121/BGM123 Memory Map — Peripherals

3.13 Configuration Summary

The features of the BGM121/BGM123 are a subset of the feature set described in the device reference manual. The table below describes device specific implementation of the features. Remaining modules support full configuration.

Table 3.2. Configuration Summary

Module	Configuration	Pin Connections
USART0	IrDA SmartCard	US0_TX, US0_RX, US0_CLK, US0_CS
USART1	IrDA I ² S SmartCard	US1_TX, US1_RX, US1_CLK, US1_CS
TIMER0	with DTI	TIM0_CC[2:0], TIM0_CDTI[2:0]
TIMER1		TIM1_CC[3:0]

4. Electrical Specifications

4.1 Electrical Characteristics

All electrical parameters in all tables are specified under the following conditions, unless stated otherwise:

- Typical values are based on $T_{AMB}=25^{\circ}\text{C}$ and $V_{DD}=3.3\text{ V}$, by production test and/or technology characterization.
- Radio performance numbers are measured in conducted mode, based on Silicon Laboratories reference designs using output power-specific external RF impedance-matching networks for interfacing to a 50 Ω antenna.
- Minimum and maximum values represent the worst conditions across supply voltage, process variation, and operating temperature, unless stated otherwise.

Refer to [Table 4.2 General Operating Conditions on page 13](#) for more details about operational supply and temperature limits.

4.1.1 Absolute Maximum Ratings

Stresses above those listed below may cause permanent damage to the device. This is a stress rating only and functional operation of the devices at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability. For more information on the available quality and reliability data, see the Quality and Reliability Monitor Report at <http://www.silabs.com/support/quality/pages/default.aspx>.

Table 4.1. Absolute Maximum Ratings

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Storage temperature range	T_{STG}		-40	—	+85	$^{\circ}\text{C}$
External main supply voltage	V_{DDMAX}		0	—	3.8	V
External main supply voltage ramp rate	$V_{DDRAMPMAX}$		—	—	1	V / μs
External main supply voltage with DC-DC in bypass mode			1.85		3.8	V
Voltage on any 5V tolerant GPIO pin ¹	V_{DIGPIN}		-0.3	—	Min of 5.25 and IOVDD +2	V
Voltage on non-5V tolerant GPIO pins			-0.3	—	IOVDD+0.3	V
Max RF level at input	$P_{RFMAX2G4}$		—	—	10	dBm
Total current into VDD power lines (source)	I_{VDDMAX}		—	—	200	mA
Total current into VSS ground lines (sink)	I_{VSSMAX}		—	—	200	mA
Current per I/O pin (sink)	I_{IOMAX}		—	—	50	mA
Current per I/O pin (source)			—	—	50	mA
Current for all I/O pins (sink)	$I_{IOALLMAX}$		—	—	200	mA
Current for all I/O pins (source)			—	—	200	mA
Voltage difference between AVDD and VREGVDD	ΔV_{DD}		—	—	0.3	V

Note:

1. When a GPIO pin is routed to the analog module through the APORT, the maximum voltage = IOVDD.

4.1.2 Operating Conditions

The following subsections define the operating conditions for the module.

4.1.2.1 General Operating Conditions

Table 4.2. General Operating Conditions

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Operating temperature range	T _{OP}	Ambient temperature range	-40	25	85	°C
VDD Operating supply voltage ¹	V _{VDD}	DCDC in regulation	2.4	3.3	3.8	V
		DCDC in bypass, 50mA load	1.85	3.3	3.8	V
VDD Current	I _{VDD}	DCDC in bypass	—	—	200	mA
HFCLK frequency	f _{CORE}	0 wait-states (MODE = WS0) ²	—	—	26	MHz
		1 wait-states (MODE = WS1) ²	—	38.4	40	MHz

Note:

1. The minimum voltage required in bypass mode is calculated using R_{BYP} from the DC-DC specification table. Requirements for other loads can be calculated as $V_{VDD_min} + I_{LOAD} * R_{BYP_max}$
2. In MSC_READCTRL register

4.1.3 DC-DC Converter

Test conditions: $V_{\text{DCDC_I}}=3.3\text{ V}$, $V_{\text{DCDC_O}}=1.8\text{ V}$, $I_{\text{DCDC_LOAD}}=50\text{ mA}$, Heavy Drive configuration, $F_{\text{DCDC_LN}}=7\text{ MHz}$, unless otherwise indicated.

Table 4.3. DC-DC Converter

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Input voltage range	$V_{\text{DCDC_I}}$	Bypass mode, $I_{\text{DCDC_LOAD}} = 50\text{ mA}$	1.85	—	$V_{\text{VREGVDD_MAX}}$	V
		Low noise (LN) mode, 1.8 V output, $I_{\text{DCDC_LOAD}} = 100\text{ mA}$, or Low power (LP) mode, 1.8 V output, $I_{\text{DCDC_LOAD}} = 10\text{ mA}$	2.4	—	$V_{\text{VREGVDD_MAX}}$	V
		Low noise (LN) mode, 1.8 V output, $I_{\text{DCDC_LOAD}} = 200\text{ mA}$	2.6	—	$V_{\text{VREGVDD_MAX}}$	V
Output voltage programmable range ¹	$V_{\text{DCDC_O}}$		1.8	—	V_{VREGVDD}	V
Regulation DC Accuracy	ACC_{DC}	Low noise (LN) mode, 1.8 V target output	1.7	—	1.9	V
Regulation Window ²	WIN_{REG}	Low power (LP) mode, $\text{LPCMPBIAS}^3 = 0$, 1.8 V target output, $I_{\text{DCDC_LOAD}} \leq 75\text{ }\mu\text{A}$	1.63	—	2.2	V
		Low power (LP) mode, $\text{LPCMPBIAS}^3 = 3$, 1.8 V target output, $I_{\text{DCDC_LOAD}} \leq 10\text{ mA}$	1.63	—	2.1	V
Steady-state output ripple	V_{R}	Radio disabled.	—	3	—	mVpp
Output voltage under/overshoot	V_{OV}	CCM Mode ($\text{LNFORCECCM}^3 = 1$), Load changes between 0 mA and 100 mA	—	—	150	mV
		DCM Mode ($\text{LNFORCECCM}^3 = 0$), Load changes between 0 mA and 10 mA	—	—	150	mV
		Overshoot during LP to LN CCM/DCM mode transitions compared to DC level in LN mode	—	200	—	mV
		Undershoot during BYP/LP to LN CCM ($\text{LNFORCECCM}^3 = 1$) mode transitions compared to DC level in LN mode	—	50	—	mV
		Undershoot during BYP/LP to LN DCM ($\text{LNFORCECCM}^3 = 0$) mode transitions compared to DC level in LN mode	—	125	—	mV
DC line regulation	V_{REG}	Input changes between $V_{\text{VREGVDD_MAX}}$ and 2.4 V	—	0.1	—	%
DC load regulation	I_{REG}	Load changes between 0 mA and 100 mA in CCM mode	—	0.1	—	%

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Note: 1. Due to internal dropout, the DC-DC output will never be able to reach its input voltage, $V_{VREGVDD}$ 2. LP mode controller is a hysteretic controller that maintains the output voltage within the specified limits 3. In EMU_DCDCMISCCTRL register 4. Drive levels are defined by configuration of the PFETCNT and NFETCNT registers. Light Drive: PFETCNT=NFETCNT=3; Medium Drive: PFETCNT=NFETCNT=7; Heavy Drive: PFETCNT=NFETCNT=15.						

4.1.4 Current Consumption

4.1.4.1 Current Consumption 3.3 V (DC-DC in Bypass Mode)

Unless otherwise indicated, typical conditions are: VDD = 3.3 V. T_{OP} = 25 °C. EMU_PWRCFG_PWRCG=NODCDC. EMU_DCDCCTRL_DCDCMODE=BYPASS. Minimum and maximum values in this table represent the worst conditions across supply voltage and process variation at T_{OP} = 25 °C.

Table 4.4. Current Consumption 3.3V without DC/DC

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Current consumption in EM0 Active mode with all peripherals disabled	I _{ACTIVE}	38.4 MHz crystal, CPU running while loop from flash ¹	—	130	—	µA/MHz
		38 MHz HFRCO, CPU running Prime from flash	—	88	—	µA/MHz
		38 MHz HFRCO, CPU running while loop from flash	—	100	105	µA/MHz
		38 MHz HFRCO, CPU running CoreMark from flash	—	112	—	µA/MHz
		26 MHz HFRCO, CPU running while loop from flash	—	102	106	µA/MHz
		1 MHz HFRCO, CPU running while loop from flash	—	222	350	µA/MHz
Current consumption in EM1 Sleep mode with all peripherals disabled	I _{EM1}	38.4 MHz crystal ¹	—	65	—	µA/MHz
		38 MHz HFRCO	—	35	38	µA/MHz
		26 MHz HFRCO	—	37	41	µA/MHz
		1 MHz HFRCO	—	157	275	µA/MHz
Current consumption in EM2 Deep Sleep mode.	I _{EM2}	Full RAM retention and RTCC running from LFXO	—	3.3	—	µA
		4 kB RAM retention and RTCC running from LFRCO	—	3	6.3	µA
Current consumption in EM3 Stop mode	I _{EM3}	Full RAM retention and CRYO-TIMER running from ULFRCO	—	2.8	6	µA
Current consumption in EM4H Hibernate mode	I _{EM4}	128 byte RAM retention, RTCC running from LFXO	—	1.1	—	µA
		128 byte RAM retention, CRYO-TIMER running from ULFRCO	—	0.65	—	µA
		128 byte RAM retention, no RTCC	—	0.65	1.3	µA
Current consumption in EM4S Shutoff mode	I _{EM4S}	no RAM retention, no RTCC	—	0.04	0.20	µA
Note: 1. CMU_HFXOCTRL_LOWPOWER=0						

4.1.4.2 Current Consumption 3.3 V using DC-DC Converter

Unless otherwise indicated, typical conditions are: VDD = 3.3V. T_{OP} = 25 °C. Minimum and maximum values in this table represent the worst conditions across supply voltage and process variation at T_{OP} = 25 °C.

Table 4.5. Current Consumption 3.3V with DC-DC

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Current consumption in EM0 Active mode with all peripherals disabled, DCDC in Low Noise DCM mode ¹ .	I _{ACTIVE}	38.4 MHz crystal, CPU running while loop from flash ²	—	88	—	µA/MHz
		38 MHz HFRCO, CPU running Prime from flash	—	63	—	µA/MHz
		38 MHz HFRCO, CPU running while loop from flash	—	71	—	µA/MHz
		38 MHz HFRCO, CPU running CoreMark from flash	—	78	—	µA/MHz
		26 MHz HFRCO, CPU running while loop from flash	—	76	—	µA/MHz
Current consumption in EM0 Active mode with all peripherals disabled, DCDC in Low Noise CCM mode ³ .		38.4 MHz crystal, CPU running while loop from flash ²	—	98	—	µA/MHz
		38 MHz HFRCO, CPU running Prime from flash	—	75	—	µA/MHz
		38 MHz HFRCO, CPU running while loop from flash	—	81	—	µA/MHz
		38 MHz HFRCO, CPU running CoreMark from flash	—	88	—	µA/MHz
		26 MHz HFRCO, CPU running while loop from flash	—	94	—	µA/MHz
Current consumption in EM1 Sleep mode with all peripherals disabled, DCDC in Low Noise DCM mode ¹ .	I _{EM1}	38.4 MHz crystal ²	—	49	—	µA/MHz
		38 MHz HFRCO	—	32	—	µA/MHz
		26 MHz HFRCO	—	38	—	µA/MHz
Current consumption in EM1 Sleep mode with all peripherals disabled, DCDC in Low Noise CCM mode ³ .		38.4 MHz crystal ²	—	61	—	µA/MHz
		38 MHz HFRCO	—	45	—	µA/MHz
		26 MHz HFRCO	—	58	—	µA/MHz
Current consumption in EM2 Deep Sleep mode. DCDC in Low Power mode ⁴ .	I _{EM2}	Full RAM retention and RTCC running from LFXO	—	2.5	—	µA
		4 kB RAM retention and RTCC running from LFRCO	—	2.2	—	µA
Current consumption in EM3 Stop mode	I _{EM3}	Full RAM retention and CRYO-TIMER running from ULFRCO	—	2.1	—	µA
Current consumption in EM4H Hibernate mode	I _{EM4}	128 byte RAM retention, RTCC running from LFXO	—	0.86	—	µA
		128 byte RAM retention, CRYO-TIMER running from ULFRCO	—	0.58	—	µA
		128 byte RAM retention, no RTCC	—	0.58	—	µA
Current consumption in EM4S Shutoff mode	I _{EM4S}	no RAM retention, no RTCC	—	0.04	—	µA

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Note: 1. DCDC Low Noise DCM Mode = Light Drive (PFETCNT=NFETCNT=3), F=3.0 MHz (RCOBAND=0), ANASW=DVDD 2. CMU_HFXOCTRL_LOWPOWER=0 3. DCDC Low Noise CCM Mode = Light Drive (PFETCNT=NFETCNT=3), F=6.4 MHz (RCOBAND=4), ANASW=DVDD 4. DCDC Low Power Mode = Medium Drive (PFETCNT=NFETCNT=7), LPOSCDIV=1, LPBIAS=3, LPCILIMSEL=1, ANASW=DVDD						

4.1.4.3 Current Consumption 1.85 V (DC-DC in Bypass Mode)

Unless otherwise indicated, typical conditions are: VDD = 1.85 V. T_{OP} = 25 °C. DC-DC in bypass mode. Minimum and maximum values in this table represent the worst conditions across supply voltage and process variation at T_{OP} = 25 °C.

Table 4.6. Current Consumption 1.85V without DC/DC

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Current consumption in EM0 Active mode with all peripherals disabled	I _{ACTIVE}	38.4 MHz crystal, CPU running while loop from flash ¹	—	131	—	μA/MHz
		38 MHz HFRCO, CPU running Prime from flash	—	88	—	μA/MHz
		38 MHz HFRCO, CPU running while loop from flash	—	100	—	μA/MHz
		38 MHz HFRCO, CPU running CoreMark from flash	—	112	—	μA/MHz
		26 MHz HFRCO, CPU running while loop from flash	—	102	—	μA/MHz
		1 MHz HFRCO, CPU running while loop from flash	—	220	—	μA/MHz
Current consumption in EM1 Sleep mode with all peripherals disabled	I _{EM1}	38.4 MHz crystal ¹	—	65	—	μA/MHz
		38 MHz HFRCO	—	35	—	μA/MHz
		26 MHz HFRCO	—	37	—	μA/MHz
		1 MHz HFRCO	—	154	—	μA/MHz
Current consumption in EM2 Deep Sleep mode	I _{EM2}	Full RAM retention and RTCC running from LFXO	—	3.2	—	μA
		4 kB RAM retention and RTCC running from LFRCO	—	2.8	—	μA
Current consumption in EM3 Stop mode	I _{EM3}	Full RAM retention and CRYO-TIMER running from ULFRCO	—	2.7	—	μA
Current consumption in EM4H Hibernate mode	I _{EM4}	128 byte RAM retention, RTCC running from LFXO	—	1	—	μA
		128 byte RAM retention, CRYO-TIMER running from ULFRCO	—	0.62	—	μA
		128 byte RAM retention, no RTCC	—	0.62	—	μA
Current consumption in EM4S Shutoff mode	I _{EM4S}	No RAM retention, no RTCC	—	0.02	—	μA
Note: 1. CMU_HFXOCTRL_LOWPOWER=0						

4.1.4.4 Current Consumption Using Radio

Unless otherwise indicated, typical conditions are: VDD = 3.3 V. T_{OP} = 25 °C. DC-DC on. Minimum and maximum values in this table represent the worst conditions across supply voltage and process variation at T_{OP} = 25 °C.

Table 4.7. Current Consumption Using Radio 3.3 V with DC-DC

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Current consumption in receive mode, active packet reception (MCU in EM1 @ 38.4 MHz, peripheral clocks disabled)	I _{RX}	1 Mbit/s, 2GFSK, F = 2.4 GHz, Radio clock prescaled by 4	—	9.0	—	mA
Current consumption in transmit mode (MCU in EM1 @ 38.4 MHz, peripheral clocks disabled)	I _{TX}	F = 2.4 GHz, CW, 0 dBm output power, Radio clock prescaled by 3	—	8.2	—	mA
		F = 2.4 GHz, CW, 3 dBm output power	—	16.5	—	mA
		F = 2.4 GHz, CW, 8 dBm output power	—	24.6	—	mA
RFSENSE current consumption	I _{RFSENSE}		—	51	—	nA

4.1.5 Wake up times

Table 4.8. Wake up times

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Wake up from EM2 Deep Sleep	t _{EM2_WU}	Code execution from flash	—	10.7	—	µs
		Code execution from RAM	—	3	—	µs
Wakeup time from EM1 Sleep	t _{EM1_WU}	Executing from flash	—	3	—	AHB Clocks
		Executing from RAM	—	3	—	AHB Clocks
Wake up from EM3 Stop	t _{EM3_WU}	Executing from flash	—	10.7	—	µs
		Executing from RAM	—	3	—	µs
Wake up from EM4H Hibernation ¹	t _{EM4H_WU}	Executing from flash	—	60	—	µs
Wake up from EM4S Shut-off ¹	t _{EM4S_WU}		—	290	—	µs

Note:

1. Time from wakeup request until first instruction is executed. Wakeup results in device reset.

4.1.6 Brown Out Detector

For the table below, see [Figure 3.2 Power Supply Configuration on page 5](#) on page 5 to see the relation between the modules external VDD pin and internal voltage supplies. The module itself has only one external power supply input (VDD).

Table 4.9. Brown Out Detector

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
AVDD BOD threshold	$V_{AVDDBOD}$	AVDD rising	—	—	1.85	V
		AVDD falling	1.62	—	—	V
AVDD BOD hysteresis	$V_{AVDDBOD_HYST}$		—	21	—	mV
AVDD response time	$t_{AVDDBOD_DELAY}$	Supply drops at 0.1V/ μ s rate	—	2.4	—	μ s
EM4 BOD threshold	V_{EM4BOD}	AVDD rising	—	—	1.7	V
		AVDD falling	1.45	—	—	V
EM4 BOD hysteresis	V_{EM4BOD_HYST}		—	46	—	mV
EM4 response time	t_{EM4BOD_DELAY}	Supply drops at 0.1V/ μ s rate	—	300	—	μ s

4.1.7 Frequency Synthesizer Characteristics

Table 4.10. Frequency Synthesizer Characteristics

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
RF Synthesizer Frequency range	F_{RANGE_2400}	2.4 GHz frequency range	2400	—	2483.5	MHz
LO tuning frequency resolution with 38.4 MHz crystal	F_{RES_2400}	2400 - 2483.5 MHz	—	—	73	Hz
Maximum frequency deviation with 38.4 MHz crystal	ΔF_{MAX_2400}		—	—	1677	kHz

4.1.8 2.4 GHz RF Transceiver Characteristics

4.1.8.1 RF Transmitter General Characteristics for the 2.4 GHz Band

Unless otherwise indicated, typical conditions are: $T_{OP} = 25\text{ }^{\circ}\text{C}$, $V_{DD} = 3.3\text{ V}$, DC-DC on. Crystal frequency = 38.4 MHz. RF center frequency 2.45 GHz. Conducted measurement from the antenna feedpoint.

Table 4.11. RF Transmitter General Characteristics for 2.4 GHz Band

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Maximum TX power	$POUT_{MAX}$		—	8	—	dBm
Minimum active TX Power	$POUT_{MIN}$	CW		-26	—	dBm
Output power step size	$POUT_{STEP}$	-5 dBm < Output power < 0 dBm	—	1	—	dB
		0 dBm < output power < $POUT_{MAX}$	—	0.5	—	dB
Output power variation vs supply at $POUT_{MAX}$	$POUT_{VAR_V}$	1.85 V < $V_{VREGVDD}$ < 3.3 V, PAVDD connected directly to external supply, for output power = 8 dBm.	—	3.8	—	dB
		1.85 V < $V_{VREGVDD}$ < 3.3 V using DC-DC converter	—	2.2	—	dB
Output power variation vs temperature at $POUT_{MAX}$	$POUT_{VAR_T}$	From -40 to +85 °C, PAVDD connected to DC-DC output	—	1.5	—	dB
Output power variation vs RF frequency at $POUT_{MAX}$	$POUT_{VAR_F}$	Over RF tuning frequency range	—	0.4	—	dB
RF tuning frequency range	F_{RANGE}		2400	—	2483.5	MHz

4.1.8.2 RF Receiver General Characteristics for the 2.4 GHz Band

Unless otherwise indicated, typical conditions are: $T_{OP} = 25\text{ }^{\circ}\text{C}$, $V_{DD} = 3.3\text{ V}$, DC-DC on. Crystal frequency = 38.4 MHz. RF center frequency 2.440 GHz. Conducted measurement from the antenna feedpoint.

Table 4.12. RF Receiver General Characteristics for 2.4 GHz Band

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
RF tuning frequency range	F_{RANGE}		2400	—	2483.5	MHz
Receive mode maximum spurious emission	SPUR_{RX}	30 MHz to 1 GHz	—	-57	—	dBm
		1 GHz to 12 GHz	—	-47	—	dBm
Max spurious emissions during active receive mode, per FCC Part 15.109(a)	$\text{SPUR}_{\text{RX_FCC}}$	216 MHz to 960 MHz, Conducted Measurement	—	-55.2	—	dBm
		Above 960 MHz, Conducted Measurement	—	-47.2	—	dBm
Level above which RFSENSE will trigger ¹	$\text{RFSENSE}_{\text{TRIG}}$	CW at 2.45 GHz	—	-24	—	dBm
Level below which RFSENSE will not trigger ¹	$\text{RFSENSE}_{\text{THRES}}$		—	-50	—	dBm

Note:

1. RFSENSE performance is only valid from 0 to 85 °C. RFSENSE should be disabled outside this temperature range.

4.1.8.3 RF Receiver Characteristics for Bluetooth Smart in the 2.4 GHz Band

Unless otherwise indicated, typical conditions are: $T_{OP} = 25\text{ }^{\circ}\text{C}$, $V_{DD} = 3.3\text{ V}$. Crystal frequency = 38.4 MHz. RF center frequency 2.440 GHz. DC-DC on. Conducted measurement from the antenna feedpoint.

Table 4.13. RF Receiver Characteristics for Bluetooth Smart in the 2.4GHz Band

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Max usable receiver input level, 0.1% BER	SAT	Signal is reference signal ¹ . Packet length is 20 bytes.	—	10	—	dBm
30.8% Packet Error Rate ²	SENS	With non-ideal signals as specified in RF-PHY.TS.4.2.2, section 4.6.1	—	-90	—	dBm
Signal to co-channel interferer, 0.1% BER	C/I_{CC}	Desired signal 3 dB above reference sensitivity	—	8.3	—	dB
Blocking, 0.1% BER, Desired is reference signal at -67 dBm. Interferer is CW in OOB range.	BLOCK _{OOB}	Interferer frequency $30\text{ MHz} \leq f \leq 2000\text{ MHz}$	—	-27	—	dBm
		Interferer frequency $2003\text{ MHz} \leq f \leq 2399\text{ MHz}$	—	-32	—	dBm
		Interferer frequency $2484\text{ MHz} \leq f \leq 2997\text{ MHz}$	—	-32	—	dBm
		Interferer frequency $3\text{ GHz} \leq f \leq 12.75\text{ GHz}$	—	-27	—	dBm
Intermodulation performance	IM	Per Core_4.1, Vol 6, Part A, Section 4.4 with $n = 3$	—	-25.8	—	dBm
Upper limit of input power range over which RSSI resolution is maintained	RSSI _{MAX}		4	—	—	dBm
Lower limit of input power range over which RSSI resolution is maintained	RSSI _{MIN}		—	—	-101	dBm
RSSI resolution	RSSI _{RES}	Over RSSI _{MIN} to RSSI _{MAX}	—	—	0.5	dB

Note:

- Reference signal is defined 2GFSK at -67 dBm, Modulation index = 0.5, BT = 0.5, Bit rate = 1 Mbps, desired data = PRBS9; interferer data = PRBS15; frequency accuracy better than 1 ppm
- Receive sensitivity on Bluetooth Smart channel 26 is -86 dBm

4.1.9 Oscillators

4.1.9.1 LFXO

Table 4.14. LFXO

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Crystal frequency	f_{LFXO}		—	32.768	—	kHz
Overall frequency tolerance in all conditions ¹			-100		100	ppm
Note: 1. XTAL nominal frequency tolerance = +/- 20 ppm						

4.1.9.2 HFXO

Table 4.15. HFXO

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Crystal frequency	f_{HFXO}		-	38.4	-	MHz
Crystal frequency tolerance			-40		40	ppm

4.1.9.3 LFRCO

Table 4.16. LFRCO

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Oscillation frequency	f _{LFRCO}	ENVREF = 1 in CMU_LFRCOCTRL	30.474	32.768	34.243	kHz
		ENVREF = 0 in CMU_LFRCOCTRL	30.474	32.768	33.915	kHz
Startup time	t _{LFRCO}		—	500	—	μs
Current consumption ¹	I _{LFRCO}	ENVREF = 1 in CMU_LFRCOCTRL	—	342	—	nA
		ENVREF = 0 in CMU_LFRCOCTRL	—	494	—	nA
Note: 1. Block is supplied by AVDD if ANASW = 0, or DVDD if ANASW=1 in EMU_PWRCTRL register						

4.1.9.4 HFRCO and AUXHFRCO

Table 4.17. HFRCO and AUXHFRCO

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Frequency Accuracy	f_{HFRCO}	Any frequency band, across supply voltage and temperature	-2.5	—	2.5	%
Start-up time	t_{HFRCO}	$f_{\text{HFRCO}} \geq 19 \text{ MHz}$	—	300	—	ns
		$4 < f_{\text{HFRCO}} < 19 \text{ MHz}$	—	1	—	μs
		$f_{\text{HFRCO}} \leq 4 \text{ MHz}$	—	2.5	—	μs
Current consumption on all supplies	I_{HFRCO}	$f_{\text{HFRCO}} = 38 \text{ MHz}$	—	204	228	μA
		$f_{\text{HFRCO}} = 32 \text{ MHz}$	—	171	190	μA
		$f_{\text{HFRCO}} = 26 \text{ MHz}$	—	147	164	μA
		$f_{\text{HFRCO}} = 19 \text{ MHz}$	—	126	138	μA
		$f_{\text{HFRCO}} = 16 \text{ MHz}$	—	110	120	μA
		$f_{\text{HFRCO}} = 13 \text{ MHz}$	—	100	110	μA
		$f_{\text{HFRCO}} = 7 \text{ MHz}$	—	81	91	μA
		$f_{\text{HFRCO}} = 4 \text{ MHz}$	—	33	35	μA
		$f_{\text{HFRCO}} = 2 \text{ MHz}$	—	31	35	μA
		$f_{\text{HFRCO}} = 1 \text{ MHz}$	—	30	35	μA
Step size	SS_{HFRCO}	Coarse (% of period)	—	0.8	—	%
		Fine (% of period)	—	0.1	—	%
Period Jitter	PJ_{HFRCO}		—	0.2	—	% RMS

4.1.9.5 ULFRCO

Table 4.18. ULFRCO

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Oscillation frequency	f_{ULFRCO}		0.95	1	1.07	kHz

4.1.10 Flash Memory Characteristics

Table 4.19. Flash Memory Characteristics¹

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Flash erase cycles before failure	EC _{FLASH}		10000	—	—	cycles
Flash data retention	RET _{FLASH}		10	—	—	years
Word (32-bit) programming time	t _{W_PROG}		20	26	40	μs
Page erase time	t _{PERASE}		20	27	40	ms
Mass erase time	t _{MERASE}		20	27	40	ms
Device erase time ²	t _{DERASE}		—	60	74	ms
Page erase current ³	I _{ERASE}		—	—	3	mA
Mass or Device erase current ³			—	—	5	mA
Write current ³	I _{WRITE}		—	—	3	mA
Note: 1. Flash data retention information is published in the Quarterly Quality and Reliability Report. 2. Device erase is issued over the AAP interface and erases all flash, SRAM, the Lock Bit (LB) page, and the User data page Lock Word (ULW) 3. Measured at 25°C						

4.1.11 GPIO

For the table below, see [Figure 3.2 Power Supply Configuration on page 5](#) on page 5 to see the relation between the modules external VDD pin and internal voltage supplies. The module itself has only one external power supply input (VDD).

Table 4.20. GPIO

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Input low voltage	V_{IOIL}		—	—	$IOVDD \cdot 0.3$	V
Input high voltage	V_{IOIH}		$IOVDD \cdot 0.7$	—	—	V
Output high voltage relative to IOVDD	V_{IOOH}	Sourcing 3 mA, $IOVDD \geq 3$ V, DRIVESTRENGTH ¹ = WEAK	$IOVDD \cdot 0.8$	—	—	V
		Sourcing 1.2 mA, $IOVDD \geq 1.62$ V, DRIVESTRENGTH ¹ = WEAK	$IOVDD \cdot 0.6$	—	—	V
		Sourcing 20 mA, $IOVDD \geq 3$ V, DRIVESTRENGTH ¹ = STRONG	$IOVDD \cdot 0.8$	—	—	V
		Sourcing 8 mA, $IOVDD \geq 1.62$ V, DRIVESTRENGTH ¹ = STRONG	$IOVDD \cdot 0.6$	—	—	V
Output low voltage relative to IOVDD	V_{IOOL}	Sinking 3 mA, $IOVDD \geq 3$ V, DRIVESTRENGTH ¹ = WEAK	—	—	$IOVDD \cdot 0.2$	V
		Sinking 1.2 mA, $IOVDD \geq 1.62$ V, DRIVESTRENGTH ¹ = WEAK	—	—	$IOVDD \cdot 0.4$	V
		Sinking 20 mA, $IOVDD \geq 3$ V, DRIVESTRENGTH ¹ = STRONG	—	—	$IOVDD \cdot 0.2$	V
		Sinking 8 mA, $IOVDD \geq 1.62$ V, DRIVESTRENGTH ¹ = STRONG	—	—	$IOVDD \cdot 0.4$	V
Input leakage current	I_{IOLEAK}	All GPIO except LFXO pins, $GPIO \leq IOVDD$	—	0.1	30	nA
		LFXO Pins, $GPIO \leq IOVDD$	—	0.1	50	nA
Input leakage current on 5VTOL pads above IOVDD	$I_{5VTOLLEAK}$	$IOVDD < GPIO \leq IOVDD + 2$ V	—	3.3	15	μ A
I/O pin pull-up resistor	R_{PU}		30	43	65	k Ω
I/O pin pull-down resistor	R_{PD}		30	43	65	k Ω
Pulse width of pulses removed by the glitch suppression filter	$t_{IOGLITCH}$		20	25	35	ns

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Output fall time, From 70% to 30% of V_{IO}	t_{IOF}	$C_L = 50\text{ pF}$, $DRIVESTRENGTH^1 = \text{STRONG}$, $SLEWRATE^1 = 0x6$	—	1.8	—	ns
		$C_L = 50\text{ pF}$, $DRIVESTRENGTH^1 = \text{WEAK}$, $SLEWRATE^1 = 0x6$	—	4.5	—	ns
Output rise time, From 30% to 70% of V_{IO}	t_{IOR}	$C_L = 50\text{ pF}$, $DRIVESTRENGTH^1 = \text{STRONG}$, $SLEWRATE = 0x6^1$	—	2.2	—	ns
		$C_L = 50\text{ pF}$, $DRIVESTRENGTH^1 = \text{WEAK}$, $SLEWRATE^1 = 0x6$	—	7.4	—	ns

Note:
1. In GPIO_Pn_CTRL register

4.1.12 VMON

Table 4.21. VMON

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
VMON Supply Current	I_{VMON}	In EM0 or EM1, 1 supply monitored	—	5.8	8.26	μA
		In EM0 or EM1, 4 supplies monitored	—	11.8	16.8	μA
		In EM2, EM3 or EM4, 1 supply monitored	—	62	—	nA
		In EM2, EM3 or EM4, 4 supplies monitored	—	99	—	nA
VMON Loading of Monitored Supply	I_{SENSE}	In EM0 or EM1	—	2	—	μA
		In EM2, EM3 or EM4	—	2	—	nA
Threshold range	V_{VMON_RANGE}		1.62	—	3.4	V
Threshold step size	N_{VMON_STESP}	Coarse	—	200	—	mV
		Fine	—	20	—	mV
Response time	t_{VMON_RES}	Supply drops at 1V/μs rate	—	460	—	ns
Hysteresis	V_{VMON_HYST}		—	26	—	mV

4.1.13 ADC

For the table below, see [Figure 3.2 Power Supply Configuration on page 5](#) on page 5 to see the relation between the modules external VDD pin and internal voltage supplies. The module itself has only one external power supply input (VDD).

Table 4.22. ADC

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Resolution	$V_{\text{RESOLUTION}}$		6	—	12	Bits
Input voltage range	V_{ADCIN}	Single ended	0	—	$2 \cdot V_{\text{REF}}$	V
		Differential	$-V_{\text{REF}}$	—	V_{REF}	V
Input range of external reference voltage, single ended and differential	$V_{\text{ADCREFIN_P}}$		1	—	V_{AVDD}	V
Power supply rejection ¹	PSRR_{ADC}	At DC	—	80	—	dB
Analog input common mode rejection ratio	CMRR_{ADC}	At DC	—	80	—	dB
Current from all supplies, using internal reference buffer. Continuous operation. $\text{WARMUPMODE}^2 = \text{KEEPADC-WARM}$	$I_{\text{ADC_CONTINUOUS_LP}}$	1 Msps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 1 ₃	—	301	350	μA
		250 ksps / 4 MHz ADCCLK, BIASPROG = 6, GPBIASACC = 1 ₃	—	149	—	μA
		62.5 ksps / 1 MHz ADCCLK, BIASPROG = 15, GPBIASACC = 1 ₃	—	91	—	μA
Current from all supplies, using internal reference buffer. Duty-cycled operation. $\text{WARMUPMODE}^2 = \text{NORMAL}$	$I_{\text{ADC_NORMAL_LP}}$	35 ksps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 1 ₃	—	51	—	μA
		5 ksps / 16 MHz ADCCLK BIASPROG = 0, GPBIASACC = 1 ₃	—	9	—	μA
Current from all supplies, using internal reference buffer. Duty-cycled operation. $\text{AWARMUPMODE}^2 = \text{KEEPINSTANDBY}$ or KEEPINSLOWACC	$I_{\text{ADC_STANDBY_LP}}$	125 ksps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 1 ₃	—	117	—	μA
		35 ksps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 1 ₃	—	79	—	μA
Current from all supplies, using internal reference buffer. Continuous operation. $\text{WARMUPMODE}^2 = \text{KEEPADC-WARM}$	$I_{\text{ADC_CONTINUOUS_HP}}$	1 Msps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 0 ₃	—	345	—	μA
		250 ksps / 4 MHz ADCCLK, BIASPROG = 6, GPBIASACC = 0 ₃	—	191	—	μA
		62.5 ksps / 1 MHz ADCCLK, BIASPROG = 15, GPBIASACC = 0 ₃	—	132	—	μA

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Current from all supplies, using internal reference buffer. Duty-cycled operation. WARMUPMODE ² = NORMAL	I _{ADC_NORMAL_HP}	35 ksp/s / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 0 ₃	—	102	—	μA
		5 ksp/s / 16 MHz ADCCLK BIASPROG = 0, GPBIASACC = 0 ₃	—	17	—	μA
Current from all supplies, using internal reference buffer. Duty-cycled operation. AWARMUPMODE ² = KEEPINSTANDBY or KEEPINSLOWACC	I _{ADC_STANDBY_HP}	125 ksp/s / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 0 ₃	—	162	—	μA
		35 ksp/s / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 0 ₃	—	123	—	μA
Current from HFPERCLK	I _{ADC_CLK}	HFPERCLK = 16 MHz	—	140	—	μA
ADC Clock Frequency	f _{ADCCLK}		—	—	16	MHz
Throughput rate	f _{ADCRATE}		—	—	1	Msp/s
Conversion time ⁴	t _{ADCCONV}	6 bit	—	7	—	cycles
		8 bit	—	9	—	cycles
		12 bit	—	13	—	cycles
Startup time of reference generator and ADC core	t _{ADCSTART}	WARMUPMODE ² = NORMAL	—	—	5	μs
		WARMUPMODE ² = KEEPINSTANDBY	—	—	2	μs
		WARMUPMODE ² = KEEPINSLOWACC	—	—	1	μs
SNDR at 1Msp/s and f _{in} = 10kHz	SNDR _{ADC}	Internal reference, 2.5 V full-scale, differential (-1.25, 1.25)	58	67	—	dB
		v _{refp_in} = 1.25 V direct mode with 2.5 V full-scale, differential	—	68	—	dB
Spurious-Free Dynamic Range (SFDR)	SFDR _{ADC}	1 MSamples/s, 10 kHz full-scale sine wave	—	75	—	dB
Input referred ADC noise, rms	V _{REF_NOISE}	Including quantization noise and distortion	—	380	—	μV
Offset Error	V _{ADCOFFSETERR}		-3	0.25	3	LSB
Gain error in ADC	V _{ADC_GAIN}	Using internal reference	—	-0.2	5	%
		Using external reference	—	-1	—	%
Differential non-linearity (DNL)	DNL _{ADC}	12 bit resolution	-1	—	2	LSB
Integral non-linearity (INL), End point method	INL _{ADC}	12 bit resolution	-6	—	6	LSB
Temperature Sensor Slope	V _{TS_SLOPE}		—	-1.84	—	mV/°C

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Note: 1. PSRR is referenced to AVDD when ANASW=0 and to DVDD when ANASW=1 in EMU_PWRCTRL 2. In ADCn_CNTL register 3. In ADCn_BIASPROG register 4. Derived from ADCCLK						

4.1.14 IDAC

For the table below, see [Figure 3.2 Power Supply Configuration on page 5](#) on page 5 to see the relation between the modules external VDD pin and internal voltage supplies. The module itself has only one external power supply input (VDD).

Table 4.23. IDAC

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Number of Ranges	N _{IDAC_RANGES}		—	4	—	-
Output Current	I _{IDAC_OUT}	RANGSEL ¹ = RANGE0	0.05	—	1.6	μA
		RANGSEL ¹ = RANGE1	1.6	—	4.7	μA
		RANGSEL ¹ = RANGE2	0.5	—	16	μA
		RANGSEL ¹ = RANGE3	2	—	64	μA
Linear steps within each range	N _{IDAC_STEPS}		—	32	—	
Step size	SS _{IDAC}	RANGSEL ¹ = RANGE0	—	50	—	nA
		RANGSEL ¹ = RANGE1	—	100	—	nA
		RANGSEL ¹ = RANGE2	—	500	—	nA
		RANGSEL ¹ = RANGE3	—	2	—	μA
Total Accuracy, STEPSEL ¹ = 0x10	ACC _{IDAC}	EM0 or EM1, AVDD=3.3 V, T = 25 °C	-2	—	2	%
		EM0 or EM1	-18	—	22	%
		EM2 or EM3, Source mode, RANGSEL ¹ = RANGE0, AVDD=3.3 V, T = 25 °C	—	-2	—	%
		EM2 or EM3, Source mode, RANGSEL ¹ = RANGE1, AVDD=3.3 V, T = 25 °C	—	-1.7	—	%
		EM2 or EM3, Source mode, RANGSEL ¹ = RANGE2, AVDD=3.3 V, T = 25 °C	—	-0.8	—	%
		EM2 or EM3, Source mode, RANGSEL ¹ = RANGE3, AVDD=3.3 V, T = 25 °C	—	-0.5	—	%
		EM2 or EM3, Sink mode, RANGSEL ¹ = RANGE0, AVDD=3.3 V, T = 25 °C	—	-0.7	—	%
		EM2 or EM3, Sink mode, RANGSEL ¹ = RANGE1, AVDD=3.3 V, T = 25 °C	—	-0.6	—	%
		EM2 or EM3, Sink mode, RANGSEL ¹ = RANGE2, AVDD=3.3 V, T = 25 °C	—	-0.5	—	%
		EM2 or EM3, Sink mode, RANGSEL ¹ = RANGE3, AVDD=3.3 V, T = 25 °C	—	-0.5	—	%

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Start up time	t _{IDAC_SU}	Output within 1% of steady state value	—	5	—	μs
Settling time, (output settled within 1% of steady state value)	t _{IDAC_SETTLE}	Range setting is changed	—	5	—	μs
		Step value is changed	—	1	—	μs
Current consumption in EM0 or EM1 ²	I _{IDAC}	Source mode, excluding output current	—	8.9	13	μA
		Sink mode, excluding output current	—	12	16	μA
Current consumption in EM2 or EM3 ²		Source mode, excluding output current, duty cycle mode, T = 25 °C	—	1.04	—	μA
		Sink mode, excluding output current, duty cycle mode, T = 25 °C	—	1.08	—	μA
		Source mode, excluding output current, duty cycle mode, T ≥ 85 °C	—	8.9	—	μA
		Sink mode, excluding output current, duty cycle mode, T ≥ 85 °C	—	12	—	μA
Output voltage compliance in source mode, source current change relative to current sourced at 0 V	I _{COMP_SRC}	RANGESEL1=0, output voltage = min(V _{IOVDD} , V _{AVDD} ² -100 mV)	—	0.04	—	%
		RANGESEL1=1, output voltage = min(V _{IOVDD} , V _{AVDD} ² -100 mV)	—	0.02	—	%
		RANGESEL1=2, output voltage = min(V _{IOVDD} , V _{AVDD} ² -150 mV)	—	0.02	—	%
		RANGESEL1=3, output voltage = min(V _{IOVDD} , V _{AVDD} ² -250 mV)	—	0.02	—	%
Output voltage compliance in sink mode, sink current change relative to current sunk at IOVDD	I _{COMP_SINK}	RANGESEL1=0, output voltage = 100 mV	—	0.18	—	%
		RANGESEL1=1, output voltage = 100 mV	—	0.12	—	%
		RANGESEL1=2, output voltage = 150 mV	—	0.08	—	%
		RANGESEL1=3, output voltage = 250 mV	—	0.02	—	%

Note:

1. In IDAC_CURPROG register
2. The IDAC is supplied by either AVDD, DVDD, or IOVDD based on the setting of ANASW in the EMU_PWRCTRL register and PWRSEL in the IDAC_CTRL register. Setting PWRSEL to 1 selects IOVDD. With PWRSEL cleared to 0, ANASW selects between AVDD (0) and DVDD (1).

4.1.15 Analog Comparator (ACMP)

Table 4.24. ACMP

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Input voltage range	V_{ACMPIN}	$ACMPVDD = ACMPn_CTRL_PWRSEL^1$	0	—	$V_{ACMPVDD}$	V
Supply Voltage	$V_{ACMPVDD}$	$BIASPROG^2 \leq 0x10$ or FULL-BIAS ² = 0	1.85	—	$V_{VREGVDD_MAX}$	V
		$0x10 < BIASPROG^2 \leq 0x20$ and FULLBIAS ² = 1	2.1	—	$V_{VREGVDD_MAX}$	V
Active current not including voltage reference	I_{ACMP}	$BIASPROG^2 = 1$, FULLBIAS ² = 0	—	50	—	nA
		$BIASPROG^2 = 0x10$, FULLBIAS ² = 0	—	306	—	nA
		$BIASPROG^2 = 0x20$, FULLBIAS ² = 1	—	74	95	μA
Current consumption of internal voltage reference	$I_{ACMPREF}$	VLP selected as input using 2.5 V Reference / 4 (0.625 V)	—	50	—	nA
		VLP selected as input using VDD	—	20	—	nA
		VBDIV selected as input using 1.25 V reference / 1	—	4.1	—	μA
		VADIV selected as input using VDD/1	—	2.4	—	μA
Hysteresis ($V_{CM} = 1.25$ V, $BIASPROG^2 = 0x10$, FULL-BIAS ² = 1)	$V_{ACMPHYST}$	HYSTSEL ³ = HYST0	-1.75	0	1.75	mV
		HYSTSEL ³ = HYST1	10	18	26	mV
		HYSTSEL ³ = HYST2	21	32	46	mV
		HYSTSEL ³ = HYST3	27	44	63	mV
		HYSTSEL ³ = HYST4	32	55	80	mV
		HYSTSEL ³ = HYST5	38	65	100	mV
		HYSTSEL ³ = HYST6	43	77	121	mV
		HYSTSEL ³ = HYST7	47	86	148	mV
		HYSTSEL ³ = HYST8	-4	0	4	mV
		HYSTSEL ³ = HYST9	-27	-18	-10	mV
		HYSTSEL ³ = HYST10	-47	-32	-18	mV
		HYSTSEL ³ = HYST11	-64	-43	-27	mV
		HYSTSEL ³ = HYST12	-78	-54	-32	mV
		HYSTSEL ³ = HYST13	-93	-64	-37	mV
		HYSTSEL ³ = HYST14	-113	-74	-42	mV
		HYSTSEL ³ = HYST15	-135	-85	-47	mV

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Comparator delay ⁴	$t_{ACMPDELAY}$	BIASPROG ² = 1, FULLBIAS ² = 0	—	30	—	μs
		BIASPROG ² = 0x10, FULLBIAS ² = 0	—	3.7	—	μs
		BIASPROG ² = 0x20, FULLBIAS ² = 1	—	35	—	ns
Offset voltage	$V_{ACMPOFFSET}$	BIASPROG ² = 0x10, FULLBIAS ² = 1	-35	—	35	mV
Reference Voltage	$V_{ACMPREF}$	Internal 1.25 V reference	1	1.25	1.47	V
		Internal 2.5 V reference	2	2.5	2.8	V
Capacitive Sense Internal Resistance	R_{CSRES}	CSRESSEL ⁵ = 0	—	inf	—	kΩ
		CSRESSEL ⁵ = 1	—	15	—	kΩ
		CSRESSEL ⁵ = 2	—	27	—	kΩ
		CSRESSEL ⁵ = 3	—	39	—	kΩ
		CSRESSEL ⁵ = 4	—	51	—	kΩ
		CSRESSEL ⁵ = 5	—	102	—	kΩ
		CSRESSEL ⁵ = 6	—	164	—	kΩ
		CSRESSEL ⁵ = 7	—	239	—	kΩ

Note:

1. ACMPVDD is a supply chosen by the setting in ACMPn_CTRL_PWRSEL and may be IOVDD, AVDD or DVDD
2. In ACMPn_CTRL register
3. In ACMPn_HYSTERESIS register
4. ±100 mV differential drive
5. In ACMPn_INPUTSEL register

The total ACMP current is the sum of the contributions from the ACMP and its internal voltage reference as given as:

$$I_{ACMPTOTAL} = I_{ACMP} + I_{ACMPREF}$$

$I_{ACMPREF}$ is zero if an external voltage reference is used.

4.1.16 I2C

I2C Standard-mode (Sm)

Table 4.25. I2C Standard-mode (Sm)¹

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
SCL clock frequency ²	f _{SCL}		0	—	100	kHz
SCL clock low time	t _{LOW}		4.7	—	—	μs
SCL clock high time	t _{HIGH}		4	—	—	μs
SDA set-up time	t _{SU,DAT}		250	—	—	ns
SDA hold time ³	t _{HD,DAT}		100	—	3450	ns
Repeated START condition set-up time	t _{SU,STA}		4.7	—	—	μs
(Repeated) START condition hold time	t _{HD,STA}		4	—	—	μs
STOP condition set-up time	t _{SU,STO}		4	—	—	μs
Bus free time between a STOP and START condition	t _{BUF}		4.7	—	—	μs

Note:

1. For CLHR set to 0 in the I2Cn_CTRL register
2. For the minimum HPPERCLK frequency required in Standard-mode, refer to the I2C chapter in the reference manual
3. The maximum SDA hold time (t_{HD,DAT}) needs to be met only when the device does not stretch the low time of SCL (t_{LOW})

I2C Fast-mode (Fm)**Table 4.26. I2C Fast-mode (Fm)¹**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
SCL clock frequency ²	f _{SCL}		0	—	400	kHz
SCL clock low time	t _{LOW}		1.3	—	—	μs
SCL clock high time	t _{HIGH}		0.6	—	—	μs
SDA set-up time	t _{SU,DAT}		100	—	—	ns
SDA hold time ³	t _{HD,DAT}		100	—	900	ns
Repeated START condition set-up time	t _{SU,STA}		0.6	—	—	μs
(Repeated) START condition hold time	t _{HD,STA}		0.6	—	—	μs
STOP condition set-up time	t _{SU,STO}		0.6	—	—	μs
Bus free time between a STOP and START condition	t _{BUF}		1.3	—	—	μs

Note:

1. For CLHR set to 1 in the I2Cn_CTRL register
2. For the minimum HPERCLK frequency required in Fast-mode, refer to the I2C chapter in the reference manual
3. The maximum SDA hold time (t_{HD,DAT}) needs to be met only when the device does not stretch the low time of SCL (t_{LOW})

I2C Fast-mode Plus (Fm+)**Table 4.27. I2C Fast-mode Plus (Fm+)¹**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
SCL clock frequency ²	f _{SCL}		0	—	1000	kHz
SCL clock low time	t _{LOW}		0.5	—	—	μs
SCL clock high time	t _{HIGH}		0.26	—	—	μs
SDA set-up time	t _{SU,DAT}		50	—	—	ns
SDA hold time	t _{HD,DAT}		100	—	—	ns
Repeated START condition set-up time	t _{SU,STA}		0.26	—	—	μs
(Repeated) START condition hold time	t _{HD,STA}		0.26	—	—	μs
STOP condition set-up time	t _{SU,STO}		0.26	—	—	μs
Bus free time between a STOP and START condition	t _{BUF}		0.5	—	—	μs

Note:

1. For CLHR set to 0 or 1 in the I2Cn_CTRL register
2. For the minimum HPERCLK frequency required in Fast-mode Plus, refer to the I2C chapter in the reference manual

4.1.17 USART SPI

SPI Master Timing

Table 4.28. SPI Master Timing

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
SCLK period ^{1 2}	t_{SCLK}		2 * t_{HFERCLK}	—	—	ns
CS to MOSI ^{1 2}	$t_{\text{CS_MO}}$		0	—	8	ns
SCLK to MOSI ^{1 2}	$t_{\text{SCLK_MO}}$		3	—	20	ns
MISO setup time ^{1 2}	$t_{\text{SU_MI}}$	IOVDD = 1.62 V	56	—	—	ns
		IOVDD = 3.0 V	37	—	—	ns
MISO hold time ^{1 2}	$t_{\text{H_MI}}$		6	—	—	ns

Note:

1. Applies for both CLKPHA = 0 and CLKPHA = 1 (figure only shows CLKPHA = 0)
2. Measurement done with 8 pF output loading at 10% and 90% of V_{DD} (figure shows 50% of V_{DD})

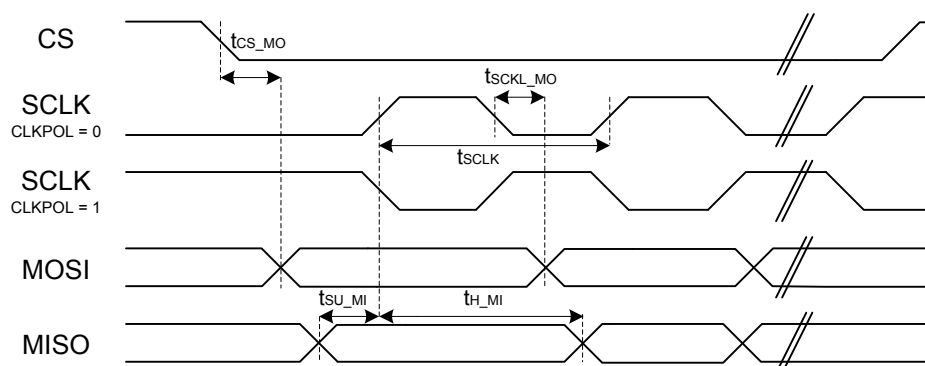


Figure 4.1. SPI Master Timing Diagram

SPI Slave Timing

Table 4.29. SPI Slave Timing

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
SCKL period ^{1 2}	$t_{\text{SCLK_sl}}$		2 * t_{HFERCLK}	—	—	ns
SCLK high period ^{1 2}	$t_{\text{SCLK_hi}}$		3 * t_{HFERCLK}	—	—	ns
SCLK low period ^{1 2}	$t_{\text{SCLK_lo}}$		3 * t_{HFERCLK}	—	—	ns
CS active to MISO ^{1 2}	$t_{\text{CS_ACT_MI}}$		4	—	50	ns
CS disable to MISO ^{1 2}	$t_{\text{CS_DIS_MI}}$		4	—	50	ns
MOSI setup time ^{1 2}	$t_{\text{SU_MO}}$		4	—	—	ns
MOSI hold time ^{1 2}	$t_{\text{H_MO}}$		3 + 2 * t_{HFERCLK}	—	—	ns
SCLK to MISO ^{1 2}	$t_{\text{SCLK_MI}}$		16 + t_{HFERCLK}	—	66 + 2 * t_{HFERCLK}	ns

Note:

1. Applies for both CLKPHA = 0 and CLKPHA = 1 (figure only shows CLKPHA = 0)
2. Measurement done with 8 pF output loading at 10% and 90% of V_{DD} (figure shows 50% of V_{DD})

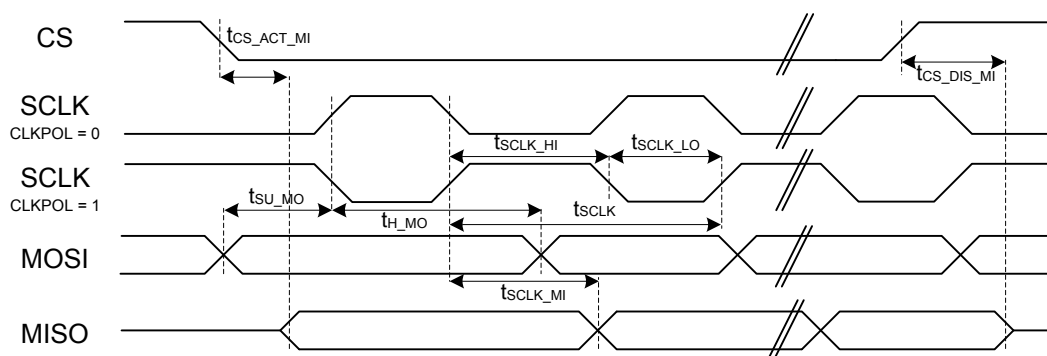


Figure 4.2. SPI Slave Timing Diagram

5. Typical Connection Diagrams

5.1 Power, Ground, Debug and Host UART

Typical power supply, ground and MCU debug and host (NCP) UART connections are shown in the figure below.

Note: The Module Reset signal is recommended to be connected to a GPIO line on the Host CPU.

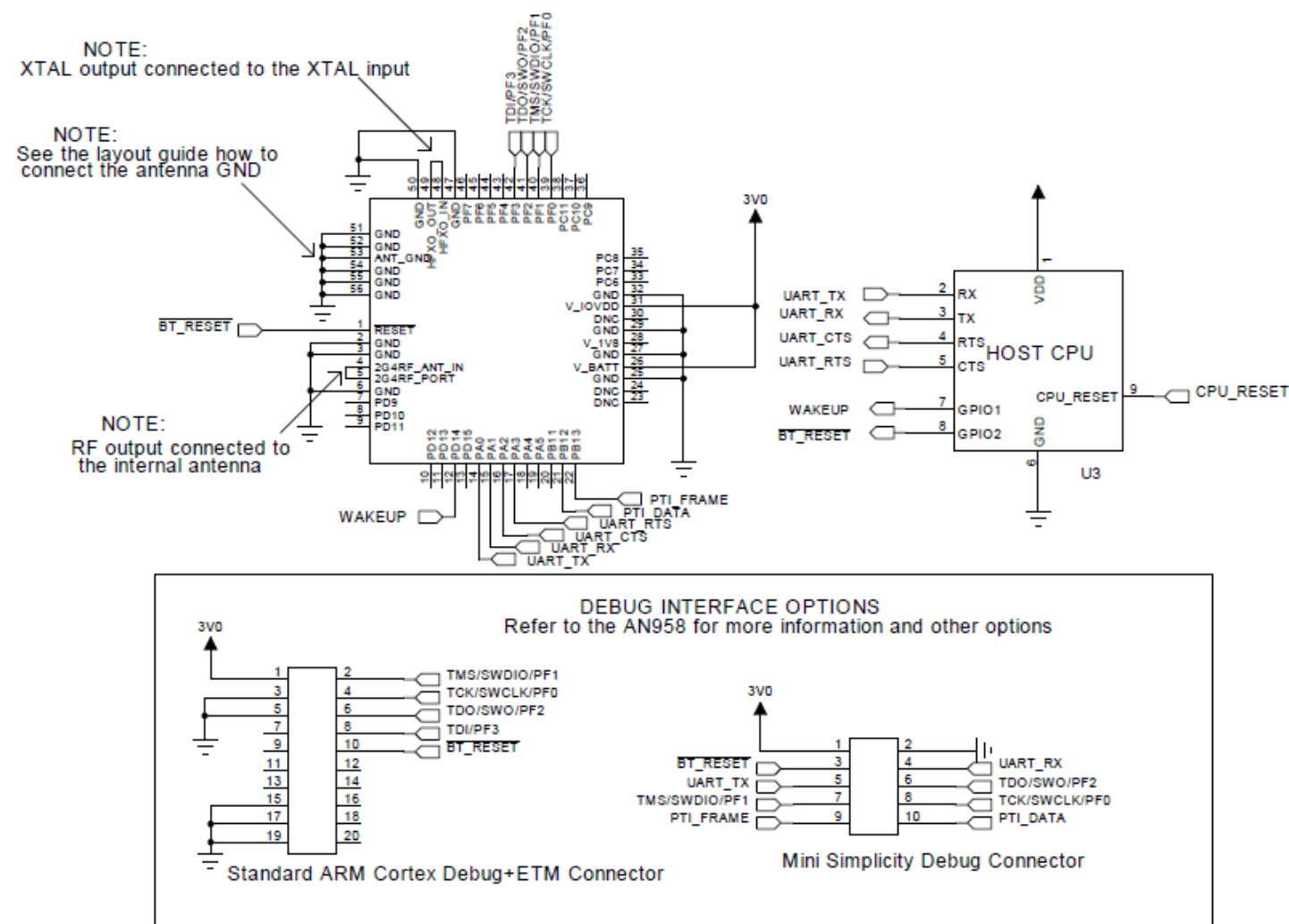


Figure 5.1. BGM121/BGM123 Connected to a Host CPU with Typical Power Supply, Ground and Debug connections

5.2 SPI Peripheral Connection

The figure below shows how to connect a SPI peripheral device

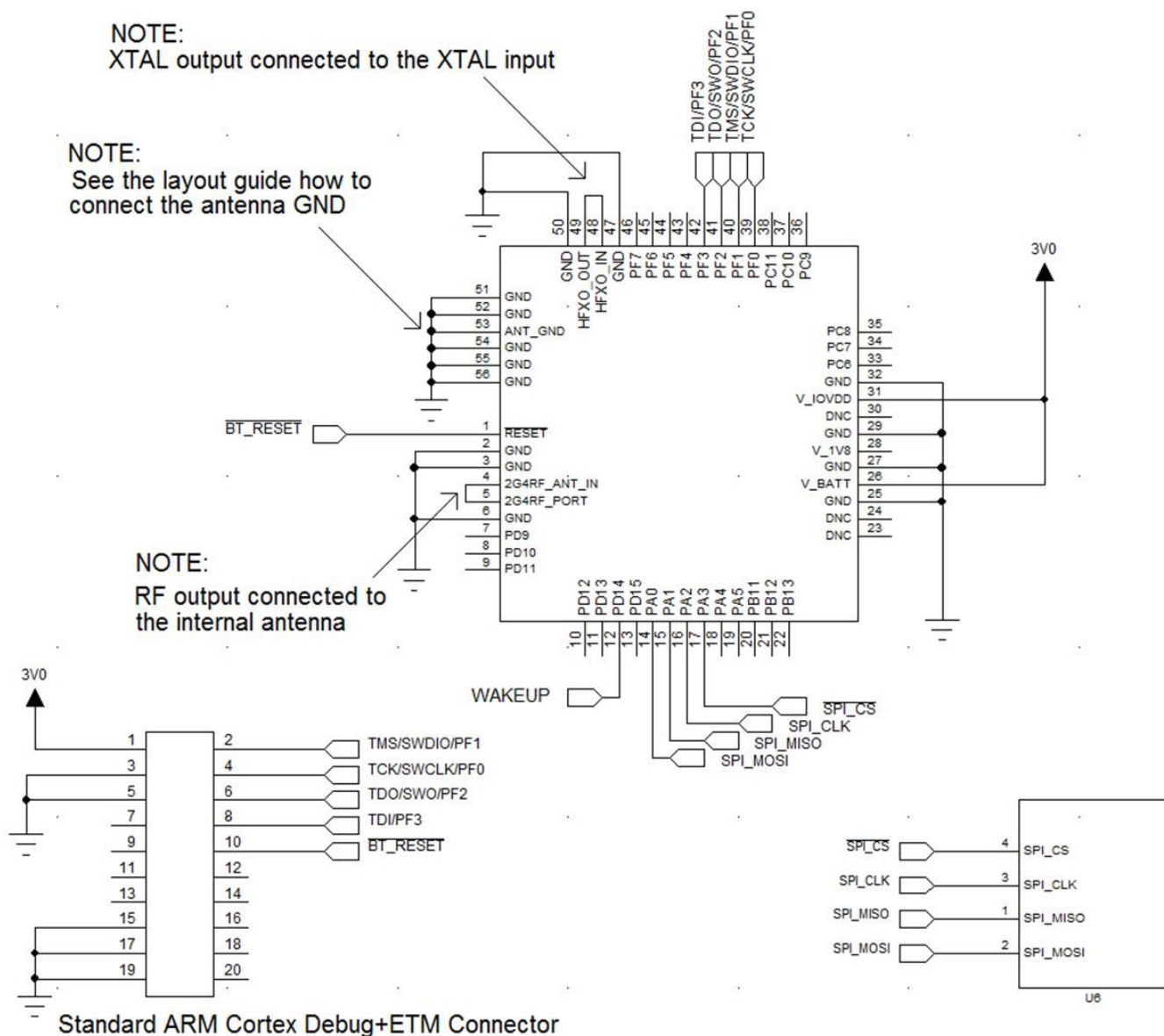


Figure 5.2. SPI Peripheral Connections

5.3 I²C Peripheral Connection

The figure below shows how to connect an I²C peripheral.

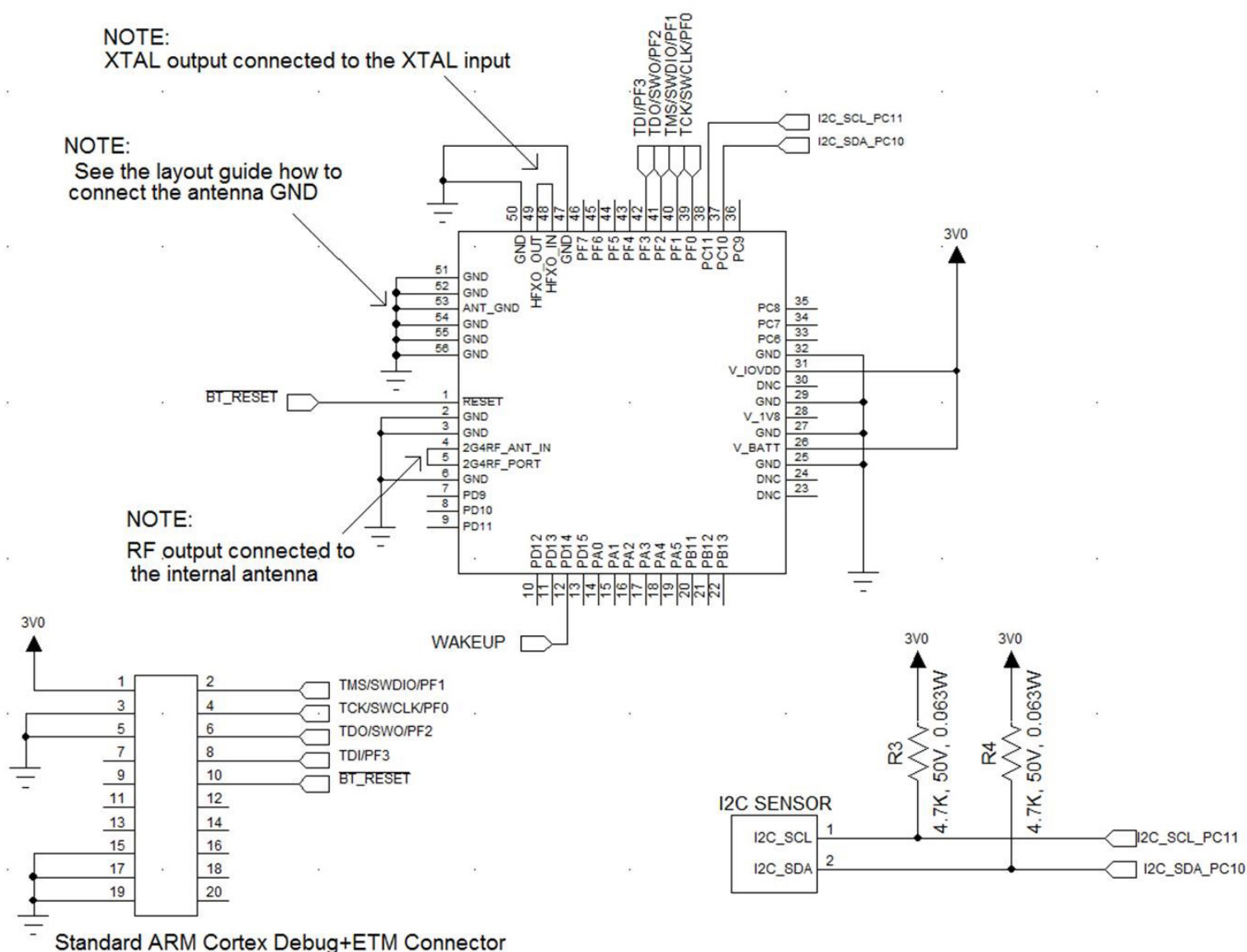


Figure 5.3. BGM121/BGM123 Module Connected with I²C Device

6. Layout Guidelines

For optimal performance of the BGM121/BGM123, please follow the PCB layout guidelines and ground plane recommendations indicated in this section.

6.1 Recommended Placement on the Application PCB

For optimal performance of the BGM121/BGM123 Module, please follow these guidelines:

- Place the module at the edge of the PCB, as shown in the figure below.
- Do not place any metal (traces, components, battery, etc.) within the clearance area of the antenna (shown in the figure below).
- Connect all ground pads directly to a solid ground plane.
- Place the ground vias as close to the ground pads as possible.

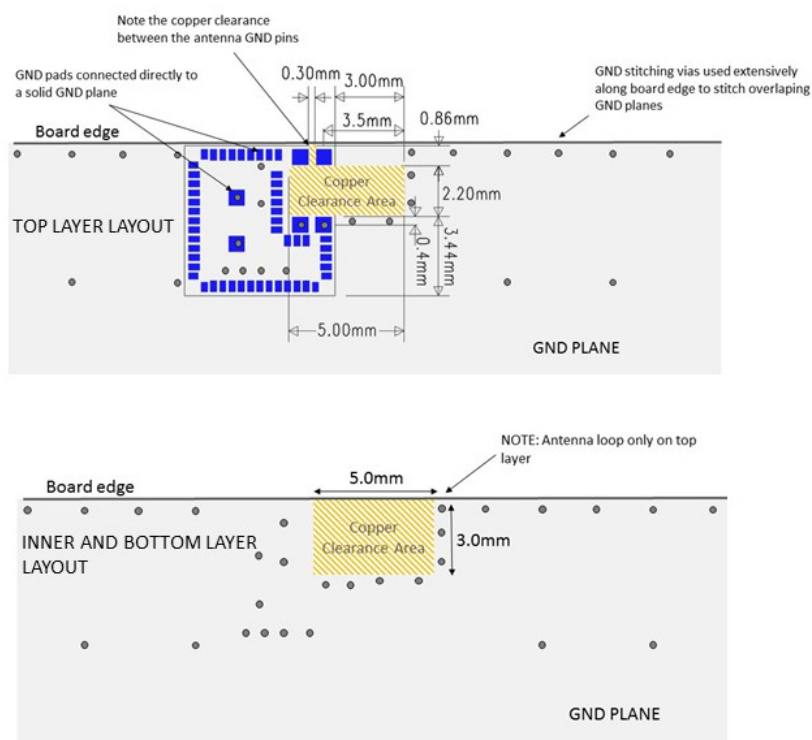


Figure 6.1. Recommended Application PCB Layout for the BGM121/BGM123 Module

The layouts in the next figure will result in severely degraded RF-performance.



Figure 6.2. Non-optimal Application PCB Layouts for the BGM121/BGM123 Module

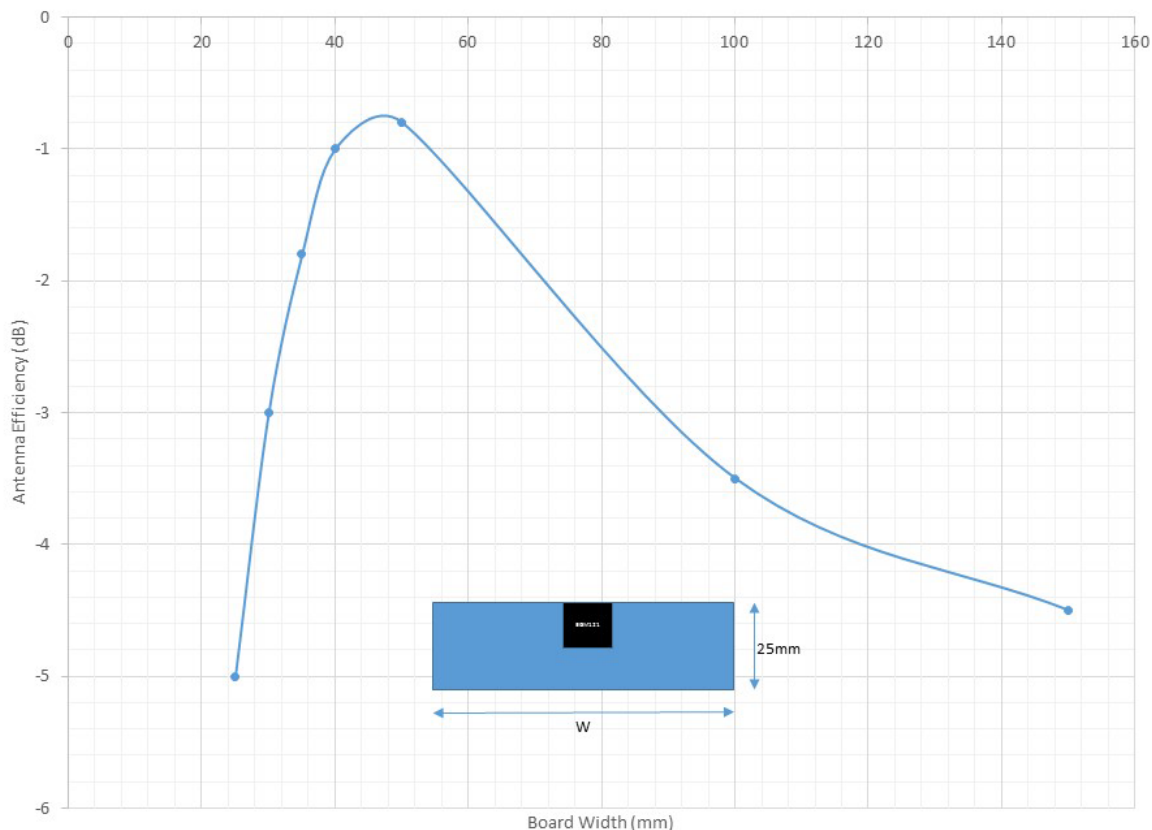


Figure 6.3. Effect of Ground Plane on Antenna Efficiency for the BGM121/BGM123

6.2 Effect of Plastic and Metal Materials

The antenna on the BGM121/BGM123 is insensitive to the effects of nearby plastic and other materials with low dielectric constant and no separation between the BGM121/BGM123 and plastic or other materials is needed.

The antenna on the BGM121/BGM123 is will be affected by nearby metal materials and a separation of 10mm is recommended between the BGM121/BGM123 and metal materials.

6.3 Locating the Module Close to Human Body

Placing the module in touch or very close to the human body will negatively impact antenna efficiency and reduce range.

6.4 2D Radiation Pattern Plots

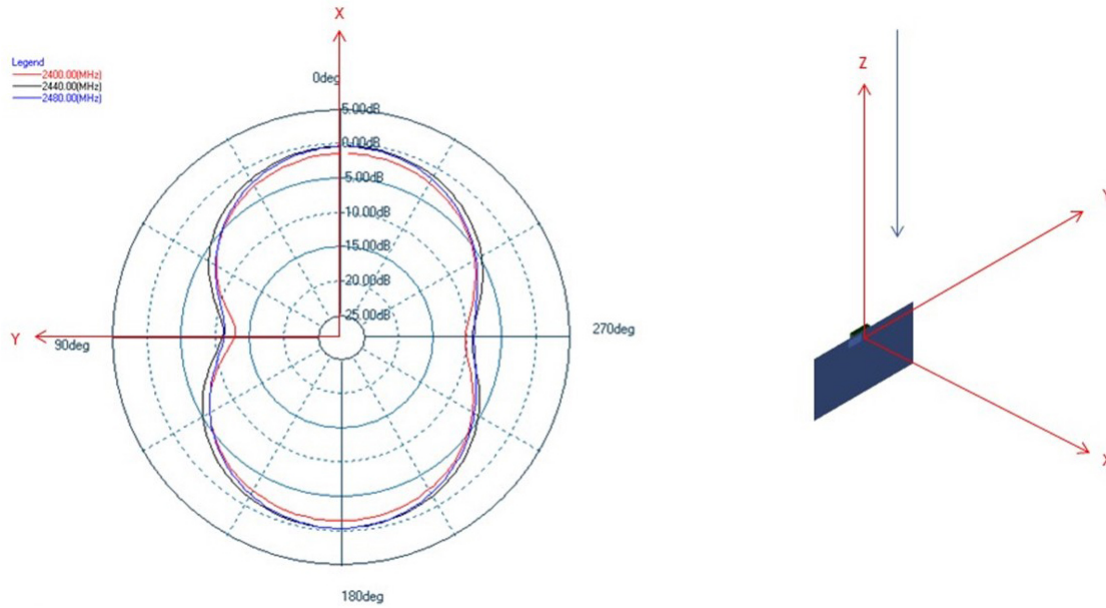


Figure 6.4. Typical 2D Radiation Pattern – Front View

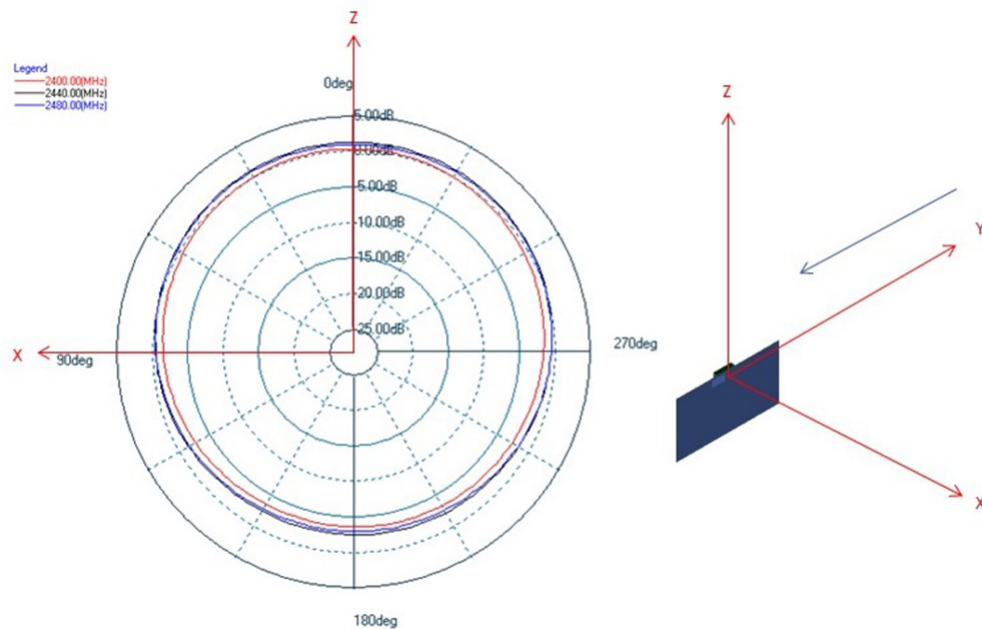


Figure 6.5. Typical 2D Radiation Pattern – Side View

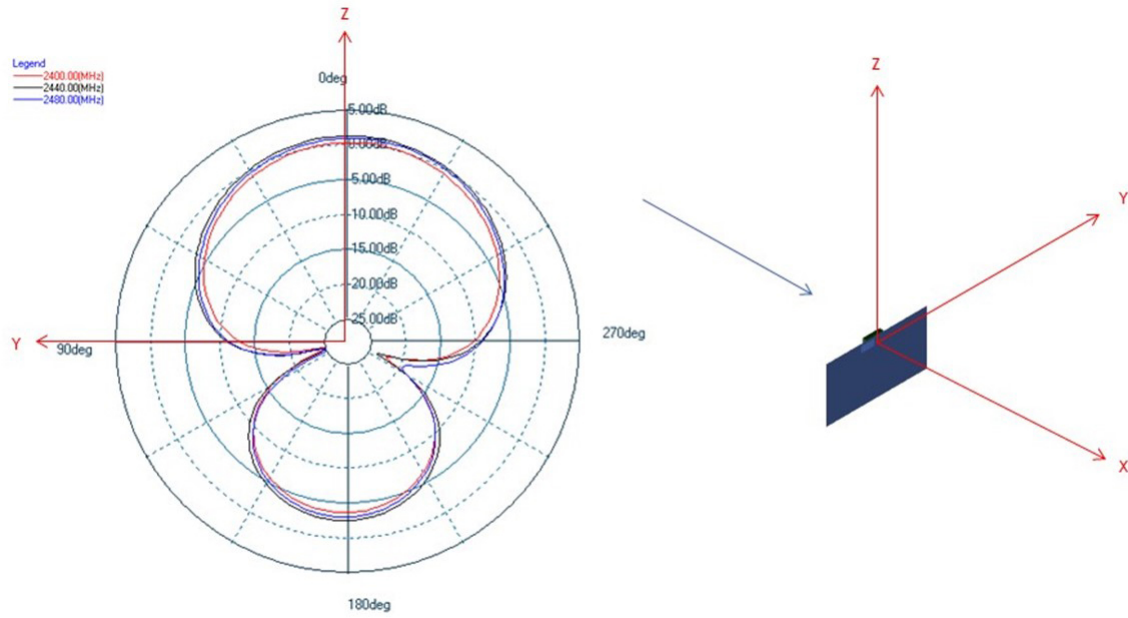


Figure 6.6. Typical 2D Radiation Pattern – Top View

7. Pin Definitions

7.1 Pin Definitions

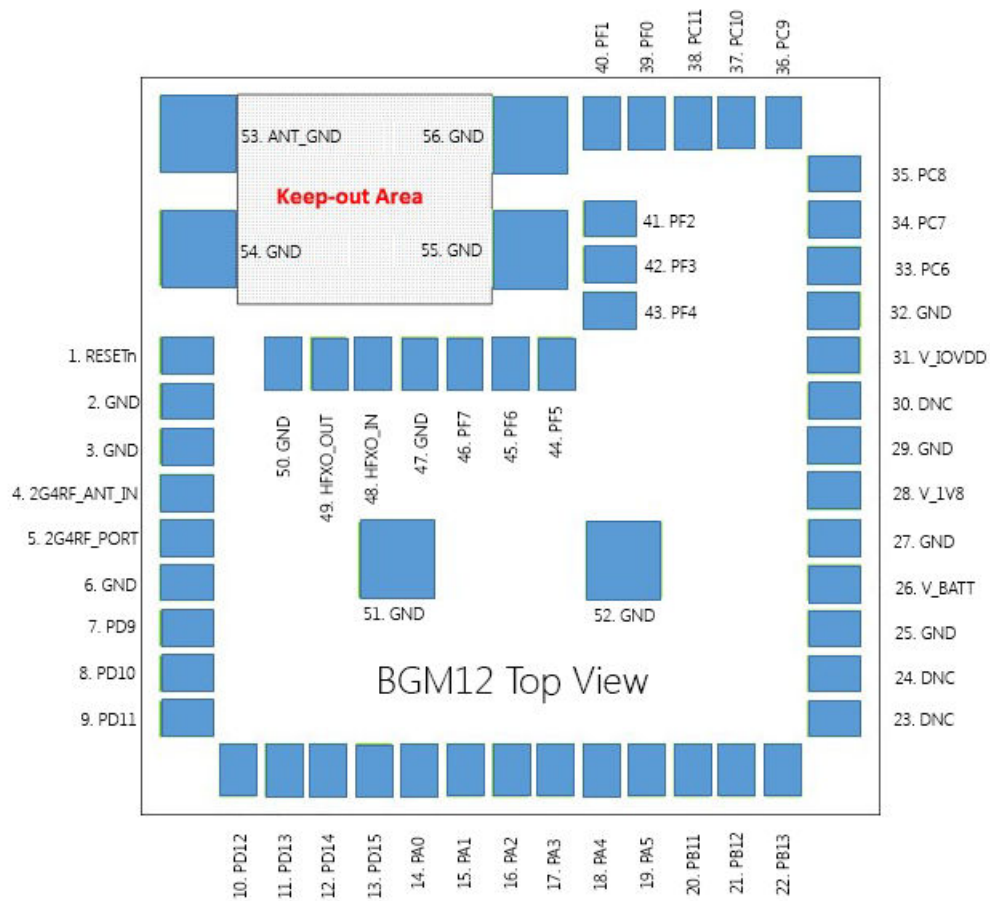


Figure 7.1. BGM121/BGM123 Pinout

Table 7.1. Device Pinout

Pin #	Pin Name	Pin Alternate Functionality / Description				
		Analog	Timers	Communication	Radio	Other
1	RESETn	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.				
2	GND	Ground				
3	GND	Ground				
4	2G4RF_ANT_IN	50 ohm input pin for the internal 2.4GHz antenna				
5	2G4RF_POR_T	50 ohm 2.4GHz RF input and output				
6	GND	Ground				
23	DNC	Do not connect but leave floating				
24	DNC	Do not connect but leave floating				
25	GND	Ground				
26	V_BATT	1.85 - 3.8VDC input to the internal DC-DC converter and AVDD.				
27	GND	Ground				
28	V_1V8	1.8V output of the internal DC-DC converter. Internally decoupled so do not use an external decoupling capacitor.				
29	GND	Ground				
30	DNC	Do not connect but leave floating				
31	V_IOVDD	Digital I/O power supply.				
32	GND	Ground				
47	GND	Ground				
48	HFXO_IN	38.4MHz XTAL input. Connect to HFXO_OUT.				
49	HFXO_OUT	38.4MHz XTAL output. Connect to HFXO_IN.				
50	GND	Ground				
51	GND	Ground				
52	GND	Ground				
53	ANT_GND	Antenna ground				
54	GND	Ground				
55	GND	Ground				
56	GND	Ground				

		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	Timers	Communication	Radio	Other
7	PD9	BUSCY [ADC0: APORT3YCH1 ACMP0: APORT3YCH1 ACMP1: APORT3YCH1 IDAC0: APORT1YCH1] BUSDX [ADC0: APORT4XCH1 ACMP0: APORT4XCH1 ACMP1: APORT4XCH1]	TIM0_CC0 #17 TIM0_CC1 #16 TIM0_CC2 #15 TIM0_CDTI0 #14 TIM0_CDTI1 #13 TIM0_CDTI2 #12 TIM1_CC0 #17 TIM1_CC1 #16 TIM1_CC2 #15 TIM1_CC3 #14 LE- TIM0_OUT0 #17 LETIM0_OUT1 #16 PCNT0_S0IN #17 PCNT0_S1IN #16	US0_TX #17 US0_RX #16 US0_CLK #15 US0_CS #14 US0_CTS #13 US0_RTS #12 US1_TX #17 US1_RX #16 US1_CLK #15 US1_CS #14 US1_CTS #13 US1_RTS #12 LEU0_TX #17 LEU0_RX #16 I2C0_SDA #17 I2C0_SCL #16	FRC_DCLK #17 FRC_DOUT #16 FRC_DFRAME #15 MODEM_DCLK #17 MODEM_DIN #16 MO- DEM_DOUT #15 MODEM_ANT0 #14 MO- DEM_ANT1 #13	CMU_CLK0 #4 PRS_CH3 #8 PRS_CH4 #0 PRS_CH5 #6 PRS_CH6 #11 ACMP0_O #17 ACMP1_O #17
8	PD10	BUSCX [ADC0: APORT3XCH2 ACMP0: APORT3XCH2 ACMP1: APORT3XCH2 IDAC0: APORT1XCH2] BUSDY [ADC0: APORT4YCH2 ACMP0: APORT4YCH2 ACMP1: APORT4YCH2]	TIM0_CC0 #18 TIM0_CC1 #17 TIM0_CC2 #16 TIM0_CDTI0 #15 TIM0_CDTI1 #14 TIM0_CDTI2 #13 TIM1_CC0 #18 TIM1_CC1 #17 TIM1_CC2 #16 TIM1_CC3 #15 LE- TIM0_OUT0 #18 LETIM0_OUT1 #17 PCNT0_S0IN #18 PCNT0_S1IN #17	US0_TX #18 US0_RX #17 US0_CLK #16 US0_CS #15 US0_CTS #14 US0_RTS #13 US1_TX #18 US1_RX #17 US1_CLK #16 US1_CS #15 US1_CTS #14 US1_RTS #13 LEU0_TX #18 LEU0_RX #17 I2C0_SDA #18 I2C0_SCL #17	FRC_DCLK #18 FRC_DOUT #17 FRC_DFRAME #16 MODEM_DCLK #18 MODEM_DIN #17 MO- DEM_DOUT #16 MODEM_ANT0 #15 MO- DEM_ANT1 #14	CMU_CLK1 #4 PRS_CH3 #9 PRS_CH4 #1 PRS_CH5 #0 PRS_CH6 #12 ACMP0_O #18 ACMP1_O #18
9	PD11	BUSCY [ADC0: APORT3YCH3 ACMP0: APORT3YCH3 ACMP1: APORT3YCH3 IDAC0: APORT1YCH3] BUSDX [ADC0: APORT4XCH3 ACMP0: APORT4XCH3 ACMP1: APORT4XCH3]	TIM0_CC0 #19 TIM0_CC1 #18 TIM0_CC2 #17 TIM0_CDTI0 #16 TIM0_CDTI1 #15 TIM0_CDTI2 #14 TIM1_CC0 #19 TIM1_CC1 #18 TIM1_CC2 #17 TIM1_CC3 #16 LE- TIM0_OUT0 #19 LETIM0_OUT1 #18 PCNT0_S0IN #19 PCNT0_S1IN #18	US0_TX #19 US0_RX #18 US0_CLK #17 US0_CS #16 US0_CTS #15 US0_RTS #14 US1_TX #19 US1_RX #18 US1_CLK #17 US1_CS #16 US1_CTS #15 US1_RTS #14 LEU0_TX #19 LEU0_RX #18 I2C0_SDA #19 I2C0_SCL #18	FRC_DCLK #19 FRC_DOUT #18 FRC_DFRAME #17 MODEM_DCLK #19 MODEM_DIN #18 MO- DEM_DOUT #17 MODEM_ANT0 #16 MO- DEM_ANT1 #15	PRS_CH3 #10 PRS_CH4 #2 PRS_CH5 #1 PRS_CH6 #13 ACMP0_O #19 ACMP1_O #19

		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	Timers	Communication	Radio	Other
10	PD12	BUSCX [ADC0: APORT3XCH4 ACMP0: APORT3XCH4 ACMP1: APORT3XCH4 IDAC0: APORT1XCH4] BUSDY [ADC0: APORT4YCH4 ACMP0: APORT4YCH4 ACMP1: APORT4YCH4]	TIM0_CC0 #20 TIM0_CC1 #19 TIM0_CC2 #18 TIM0_CDTI0 #17 TIM0_CDTI1 #16 TIM0_CDTI2 #15 TIM1_CC0 #20 TIM1_CC1 #19 TIM1_CC2 #18 TIM1_CC3 #17 LE- TIM0_OUT0 #20 LETIM0_OUT1 #19 PCNT0_S0IN #20 PCNT0_S1IN #19	US0_TX #20 US0_RX #19 US0_CLK #18 US0_CS #17 US0_CTS #16 US0_RTS #15 US1_TX #20 US1_RX #19 US1_CLK #18 US1_CS #17 US1_CTS #16 US1_RTS #15 LEU0_TX #20 LEU0_RX #19 I2C0_SDA #20 I2C0_SCL #19	FRC_DCLK #20 FRC_DOUT #19 FRC_DFRAME #18 MODEM_DCLK #20 MODEM_DIN #19 MO- DEM_DOUT #18 MODEM_ANT0 #17 MO- DEM_ANT1 #16	PRS_CH3 #11 PRS_CH4 #3 PRS_CH5 #2 PRS_CH6 #14 ACMP0_O #20 ACMP1_O #20
11	PD13	BUSCY [ADC0: APORT3YCH5 ACMP0: APORT3YCH5 ACMP1: APORT3YCH5 IDAC0: APORT1YCH5] BUSDX [ADC0: APORT4XCH5 ACMP0: APORT4XCH5 ACMP1: APORT4XCH5]	TIM0_CC0 #21 TIM0_CC1 #20 TIM0_CC2 #19 TIM0_CDTI0 #18 TIM0_CDTI1 #17 TIM0_CDTI2 #16 TIM1_CC0 #21 TIM1_CC1 #20 TIM1_CC2 #19 TIM1_CC3 #18 LE- TIM0_OUT0 #21 LETIM0_OUT1 #20 PCNT0_S0IN #21 PCNT0_S1IN #20	US0_TX #21 US0_RX #20 US0_CLK #19 US0_CS #18 US0_CTS #17 US0_RTS #16 US1_TX #21 US1_RX #20 US1_CLK #19 US1_CS #18 US1_CTS #17 US1_RTS #16 LEU0_TX #21 LEU0_RX #20 I2C0_SDA #21 I2C0_SCL #20	FRC_DCLK #21 FRC_DOUT #20 FRC_DFRAME #19 MODEM_DCLK #21 MODEM_DIN #20 MO- DEM_DOUT #19 MODEM_ANT0 #18 MO- DEM_ANT1 #17	PRS_CH3 #12 PRS_CH4 #4 PRS_CH5 #3 PRS_CH6 #15 ACMP0_O #21 ACMP1_O #21
12	PD14	BUSCX [ADC0: APORT3XCH6 ACMP0: APORT3XCH6 ACMP1: APORT3XCH6 IDAC0: APORT1XCH6] BUSDY [ADC0: APORT4YCH6 ACMP0: APORT4YCH6 ACMP1: APORT4YCH6]	TIM0_CC0 #22 TIM0_CC1 #21 TIM0_CC2 #20 TIM0_CDTI0 #19 TIM0_CDTI1 #18 TIM0_CDTI2 #17 TIM1_CC0 #22 TIM1_CC1 #21 TIM1_CC2 #20 TIM1_CC3 #19 LE- TIM0_OUT0 #22 LETIM0_OUT1 #21 PCNT0_S0IN #22 PCNT0_S1IN #21	US0_TX #22 US0_RX #21 US0_CLK #20 US0_CS #19 US0_CTS #18 US0_RTS #17 US1_TX #22 US1_RX #21 US1_CLK #20 US1_CS #19 US1_CTS #18 US1_RTS #17 LEU0_TX #22 LEU0_RX #21 I2C0_SDA #22 I2C0_SCL #21	FRC_DCLK #22 FRC_DOUT #21 FRC_DFRAME #20 MODEM_DCLK #22 MODEM_DIN #21 MO- DEM_DOUT #20 MODEM_ANT0 #19 MO- DEM_ANT1 #18	CMU_CLK0 #5 PRS_CH3 #13 PRS_CH4 #5 PRS_CH5 #4 PRS_CH6 #16 ACMP0_O #22 ACMP1_O #22 GPIO_EM4WU4

		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	Timers	Communication	Radio	Other
13	PD15	BUSCY [ADC0: APORT3YCH7 ACMP0: APORT3YCH7 ACMP1: APORT3YCH7 IDAC0: APORT1YCH7] BUSDX [ADC0: APORT4XCH7 ACMP0: APORT4XCH7 ACMP1: APORT4XCH7]	TIM0_CC0 #23 TIM0_CC1 #22 TIM0_CC2 #21 TIM0_CDTI0 #20 TIM0_CDTI1 #19 TIM0_CDTI2 #18 TIM1_CC0 #23 TIM1_CC1 #22 TIM1_CC2 #21 TIM1_CC3 #20 LE- TIM0_OUT0 #23 LETIM0_OUT1 #22 PCNT0_S0IN #23 PCNT0_S1IN #22	US0_TX #23 US0_RX #22 US0_CLK #21 US0_CS #20 US0_CTS #19 US0_RTS #18 US1_TX #23 US1_RX #22 US1_CLK #21 US1_CS #20 US1_CTS #19 US1_RTS #18 LEU0_TX #23 LEU0_RX #22 I2C0_SDA #23 I2C0_SCL #22	FRC_DCLK #23 FRC_DOUT #22 FRC_DFRAME #21 MODEM_DCLK #23 MODEM_DIN #22 MO- DEM_DOUT #21 MODEM_ANT0 #20 MO- DEM_ANT1 #19	CMU_CLK1 #5 PRS_CH3 #14 PRS_CH4 #6 PRS_CH5 #5 PRS_CH6 #17 ACMP0_O #23 ACMP1_O #23 DBG_SWO #2
14	PA0	ADC0_EXTN BUSCX [ADC0: APORT3XCH8 ACMP0: APORT3XCH8 ACMP1: APORT3XCH8 IDAC0: APORT1XCH8] BUSDY [ADC0: APORT4YCH8 ACMP0: APORT4YCH8 ACMP1: APORT4YCH8]	TIM0_CC0 #0 TIM0_CC1 #31 TIM0_CC2 #30 TIM0_CDTI0 #29 TIM0_CDTI1 #28 TIM0_CDTI2 #27 TIM1_CC0 #0 TIM1_CC1 #31 TIM1_CC2 #30 TIM1_CC3 #29 LE- TIM0_OUT0 #0 LE- TIM0_OUT1 #31 PCNT0_S0IN #0 PCNT0_S1IN #31	US0_TX #0 US0_RX #31 US0_CLK #30 US0_CS #29 US0_CTS #28 US0_RTS #27 US1_TX #0 US1_RX #31 US1_CLK #30 US1_CS #29 US1_CTS #28 US1_RTS #27 LEU0_TX #0 LEU0_RX #31 I2C0_SDA #0 I2C0_SCL #31	FRC_DCLK #0 FRC_DOUT #31 FRC_DFRAME #30 MODEM_DCLK #0 MODEM_DIN #31 MODEM_DOUT #30 MO- DEM_ANT0 #29 MODEM_ANT1 #28	CMU_CLK1 #0 PRS_CH6 #0 PRS_CH7 #10 PRS_CH8 #9 PRS_CH9 #8 ACMP0_O #0 ACMP1_O #0
15	PA1	ADC0_EXTP BUSCY [ADC0: APORT3YCH9 ACMP0: APORT3YCH9 ACMP1: APORT3YCH9 IDAC0: APORT1YCH9] BUSDX [ADC0: APORT4XCH9 ACMP0: APORT4XCH9 ACMP1: APORT4XCH9]	TIM0_CC0 #1 TIM0_CC1 #0 TIM0_CC2 #31 TIM0_CDTI0 #30 TIM0_CDTI1 #29 TIM0_CDTI2 #28 TIM1_CC0 #1 TIM1_CC1 #0 TIM1_CC2 #31 TIM1_CC3 #30 LE- TIM0_OUT0 #1 LE- TIM0_OUT1 #0 PCNT0_S0IN #1 PCNT0_S1IN #0	US0_TX #1 US0_RX #0 US0_CLK #31 US0_CS #30 US0_CTS #29 US0_RTS #28 US1_TX #1 US1_RX #0 US1_CLK #31 US1_CS #30 US1_CTS #29 US1_RTS #28 LEU0_TX #1 LEU0_RX #0 I2C0_SDA #1 I2C0_SCL #0	FRC_DCLK #1 FRC_DOUT #0 FRC_DFRAME #31 MODEM_DCLK #1 MODEM_DIN #0 MODEM_DOUT #31 MO- DEM_ANT0 #30 MODEM_ANT1 #29	CMU_CLK0 #0 PRS_CH6 #1 PRS_CH7 #0 PRS_CH8 #10 PRS_CH9 #9 ACMP0_O #1 ACMP1_O #1

		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	Timers	Communication	Radio	Other
16	PA2	BUSCX [ADC0: APORT3XCH10 ACMP0: APORT3XCH10 ACMP1: APORT3XCH10 IDAC0: APORT1XCH10] BUSDY [ADC0: APORT4YCH10 ACMP0: APORT4YCH10 ACMP1: APORT4YCH10]	TIM0_CC0 #2 TIM0_CC1 #1 TIM0_CC2 #0 TIM0_CDTI0 #31 TIM0_CDTI1 #30 TIM0_CDTI2 #29 TIM1_CC0 #2 TIM1_CC1 #1 TIM1_CC2 #0 TIM1_CC3 #31 LE- TIM0_OUT0 #2 LE- TIM0_OUT1 #1 PCNT0_S0IN #2 PCNT0_S1IN #1	US0_TX #2 US0_RX #1 US0_CLK #0 US0_CS #31 US0_CTS #30 US0_RTS #29 US1_TX #2 US1_RX #1 US1_CLK #0 US1_CS #31 US1_CTS #30 US1_RTS #29 LEU0_TX #2 LEU0_RX #1 I2C0_SDA #2 I2C0_SCL #1	FRC_DCLK #2 FRC_DOUT #1 FRC_DFRAME #0 MODEM_DCLK #2 MODEM_DIN #1 MODEM_DOUT #0 MODEM_ANT0 #31 MO- DEM_ANT1 #30	PRS_CH6 #2 PRS_CH7 #1 PRS_CH8 #0 PRS_CH9 #10 ACMP0_O #2 ACMP1_O #2
17	PA3	BUSCY [ADC0: APORT3YCH11 ACMP0: APORT3YCH11 ACMP1: APORT3YCH11 IDAC0: APORT1YCH11] BUSDX [ADC0: APORT4XCH11 ACMP0: APORT4XCH11 ACMP1: APORT4XCH11]	TIM0_CC0 #3 TIM0_CC1 #2 TIM0_CC2 #1 TIM0_CDTI0 #0 TIM0_CDTI1 #31 TIM0_CDTI2 #30 TIM1_CC0 #3 TIM1_CC1 #2 TIM1_CC2 #1 TIM1_CC3 #0 LE- TIM0_OUT0 #3 LE- TIM0_OUT1 #2 PCNT0_S0IN #3 PCNT0_S1IN #2	US0_TX #3 US0_RX #2 US0_CLK #1 US0_CS #0 US0_CTS #31 US0_RTS #30 US1_TX #3 US1_RX #2 US1_CLK #1 US1_CS #0 US1_CTS #31 US1_RTS #30 LEU0_TX #3 LEU0_RX #2 I2C0_SDA #3 I2C0_SCL #2	FRC_DCLK #3 FRC_DOUT #2 FRC_DFRAME #1 MODEM_DCLK #3 MODEM_DIN #2 MODEM_DOUT #1 MODEM_ANT0 #0 MODEM_ANT1 #31	PRS_CH6 #3 PRS_CH7 #2 PRS_CH8 #1 PRS_CH9 #0 ACMP0_O #3 ACMP1_O #3 GPIO_EM4WU8
18	PA4	BUSCX [ADC0: APORT3XCH12 ACMP0: APORT3XCH12 ACMP1: APORT3XCH12 IDAC0: APORT1XCH12] BUSDY [ADC0: APORT4YCH12 ACMP0: APORT4YCH12 ACMP1: APORT4YCH12]	TIM0_CC0 #4 TIM0_CC1 #3 TIM0_CC2 #2 TIM0_CDTI0 #1 TIM0_CDTI1 #0 TIM0_CDTI2 #31 TIM1_CC0 #4 TIM1_CC1 #3 TIM1_CC2 #2 TIM1_CC3 #1 LE- TIM0_OUT0 #4 LE- TIM0_OUT1 #3 PCNT0_S0IN #4 PCNT0_S1IN #3	US0_TX #4 US0_RX #3 US0_CLK #2 US0_CS #1 US0_CTS #0 US0_RTS #31 US1_TX #4 US1_RX #3 US1_CLK #2 US1_CS #1 US1_CTS #0 US1_RTS #31 LEU0_TX #4 LEU0_RX #3 I2C0_SDA #4 I2C0_SCL #3	FRC_DCLK #4 FRC_DOUT #3 FRC_DFRAME #2 MODEM_DCLK #4 MODEM_DIN #3 MODEM_DOUT #2 MODEM_ANT0 #1 MODEM_ANT1 #0	PRS_CH6 #4 PRS_CH7 #3 PRS_CH8 #2 PRS_CH9 #1 ACMP0_O #4 ACMP1_O #4

		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	Timers	Communication	Radio	Other
19	PA5	BUSCY [ADC0: APORT3YCH13 ACMP0: APORT3YCH13 ACMP1: APORT3YCH13 IDAC0: APORT1YCH13] BUSDX [ADC0: APORT4XCH13 ACMP0: APORT4XCH13 ACMP1: APORT4XCH13]	TIM0_CC0 #5 TIM0_CC1 #4 TIM0_CC2 #3 TIM0_CDTI0 #2 TIM0_CDTI1 #1 TIM0_CDTI2 #0 TIM1_CC0 #5 TIM1_CC1 #4 TIM1_CC2 #3 TIM1_CC3 #2 LE- TIM0_OUT0 #5 LE- TIM0_OUT1 #4 PCNT0_S0IN #5 PCNT0_S1IN #4	US0_TX #5 US0_RX #4 US0_CLK #3 US0_CS #2 US0_CTS #1 US0_RTS #0 US1_TX #5 US1_RX #4 US1_CLK #3 US1_CS #2 US1_CTS #1 US1_RTS #0 LEU0_TX #5 LEU0_RX #4 I2C0_SDA #5 I2C0_SCL #4	FRC_DCLK #5 FRC_DOUT #4 FRC_DFRAME #3 MODEM_DCLK #5 MODEM_DIN #4 MODEM_DOUT #3 MODEM_ANT0 #2 MODEM_ANT1 #1	PRS_CH6 #5 PRS_CH7 #4 PRS_CH8 #3 PRS_CH9 #2 ACMP0_O #5 ACMP1_O #5
20	PB11	BUSCY [ADC0: APORT3YCH27 ACMP0: APORT3YCH27 ACMP1: APORT3YCH27 IDAC0: APORT1YCH27] BUSDX [ADC0: APORT4XCH27 ACMP0: APORT4XCH27 ACMP1: APORT4XCH27]	TIM0_CC0 #6 TIM0_CC1 #5 TIM0_CC2 #4 TIM0_CDTI0 #3 TIM0_CDTI1 #2 TIM0_CDTI2 #1 TIM1_CC0 #6 TIM1_CC1 #5 TIM1_CC2 #4 TIM1_CC3 #3 LE- TIM0_OUT0 #6 LE- TIM0_OUT1 #5 PCNT0_S0IN #6 PCNT0_S1IN #5	US0_TX #6 US0_RX #5 US0_CLK #4 US0_CS #3 US0_CTS #2 US0_RTS #1 US1_TX #6 US1_RX #5 US1_CLK #4 US1_CS #3 US1_CTS #2 US1_RTS #1 LEU0_TX #6 LEU0_RX #5 I2C0_SDA #6 I2C0_SCL #5	FRC_DCLK #6 FRC_DOUT #5 FRC_DFRAME #4 MODEM_DCLK #6 MODEM_DIN #5 MODEM_DOUT #4 MODEM_ANT0 #3 MODEM_ANT1 #2	PRS_CH6 #6 PRS_CH7 #5 PRS_CH8 #4 PRS_CH9 #3 ACMP0_O #6 ACMP1_O #6
21	PB12	BUSCX [ADC0: APORT3XCH28 ACMP0: APORT3XCH28 ACMP1: APORT3XCH28 IDAC0: APORT1XCH28] BUSDY [ADC0: APORT4YCH28 ACMP0: APORT4YCH28 ACMP1: APORT4YCH28]	TIM0_CC0 #7 TIM0_CC1 #6 TIM0_CC2 #5 TIM0_CDTI0 #4 TIM0_CDTI1 #3 TIM0_CDTI2 #2 TIM1_CC0 #7 TIM1_CC1 #6 TIM1_CC2 #5 TIM1_CC3 #4 LE- TIM0_OUT0 #7 LE- TIM0_OUT1 #6 PCNT0_S0IN #7 PCNT0_S1IN #6	US0_TX #7 US0_RX #6 US0_CLK #5 US0_CS #4 US0_CTS #3 US0_RTS #2 US1_TX #7 US1_RX #6 US1_CLK #5 US1_CS #4 US1_CTS #3 US1_RTS #2 LEU0_TX #7 LEU0_RX #6 I2C0_SDA #7 I2C0_SCL #6	FRC_DCLK #7 FRC_DOUT #6 FRC_DFRAME #5 MODEM_DCLK #7 MODEM_DIN #6 MODEM_DOUT #5 MODEM_ANT0 #4 MODEM_ANT1 #3	PRS_CH6 #7 PRS_CH7 #6 PRS_CH8 #5 PRS_CH9 #4 ACMP0_O #7 ACMP1_O #7

		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	Timers	Communication	Radio	Other
22	PB13	BUSCY [ADC0: APORT3YCH29 ACMP0: APORT3YCH29 ACMP1: APORT3YCH29 IDAC0: APORT1YCH29] BUSDX [ADC0: APORT4XCH29 ACMP0: APORT4XCH29 ACMP1: APORT4XCH29]	TIM0_CC0 #8 TIM0_CC1 #7 TIM0_CC2 #6 TIM0_CDTI0 #5 TIM0_CDTI1 #4 TIM0_CDTI2 #3 TIM1_CC0 #8 TIM1_CC1 #7 TIM1_CC2 #6 TIM1_CC3 #5 LE- TIM0_OUT0 #8 LE- TIM0_OUT1 #7 PCNT0_S0IN #8 PCNT0_S1IN #7	US0_TX #8 US0_RX #7 US0_CLK #6 US0_CS #5 US0_CTS #4 US0_RTS #3 US1_TX #8 US1_RX #7 US1_CLK #6 US1_CS #5 US1_CTS #4 US1_RTS #3 LEU0_TX #8 LEU0_RX #7 I2C0_SDA #8 I2C0_SCL #7	FRC_DCLK #8 FRC_DOUT #7 FRC_DFRAME #6 MODEM_DCLK #8 MODEM_DIN #7 MODEM_DOUT #6 MODEM_ANT0 #5 MODEM_ANT1 #4	PRS_CH6 #8 PRS_CH7 #7 PRS_CH8 #6 PRS_CH9 #5 ACMP0_O #8 ACMP1_O #8 DBG_SWO #1 GPIO_EM4WU9
33	PC6	BUSAX [ADC0: APORT1XCH6 ACMP0: APORT1XCH6 ACMP1: APORT1XCH6] BUSBY [ADC0: APORT2YCH6 ACMP0: APORT2YCH6 ACMP1: APORT2YCH6]	TIM0_CC0 #11 TIM0_CC1 #10 TIM0_CC2 #9 TIM0_CDTI0 #8 TIM0_CDTI1 #7 TIM0_CDTI2 #6 TIM1_CC0 #11 TIM1_CC1 #10 TIM1_CC2 #9 TIM1_CC3 #8 LE- TIM0_OUT0 #11 LETIM0_OUT1 #10 PCNT0_S0IN #11 PCNT0_S1IN #10	US0_TX #11 US0_RX #10 US0_CLK #9 US0_CS #8 US0_CTS #7 US0_RTS #6 US1_TX #11 US1_RX #10 US1_CLK #9 US1_CS #8 US1_CTS #7 US1_RTS #6 LEU0_TX #11 LEU0_RX #10 I2C0_SDA #11 I2C0_SCL #10	FRC_DCLK #11 FRC_DOUT #10 FRC_DFRAME #9 MODEM_DCLK #11 MODEM_DIN #10 MO- DEM_DOUT #9 MODEM_ANT0 #8 MODEM_ANT1 #7	CMU_CLK0 #2 PRS_CH0 #8 PRS_CH9 #11 PRS_CH10 #0 PRS_CH11 #5 ACMP0_O #11 ACMP1_O #11
34	PC7	BUSAY [ADC0: APORT1YCH7 ACMP0: APORT1YCH7 ACMP1: APORT1YCH7] BUSBX [ADC0: APORT2XCH7 ACMP0: APORT2XCH7 ACMP1: APORT2XCH7]	TIM0_CC0 #12 TIM0_CC1 #11 TIM0_CC2 #10 TIM0_CDTI0 #9 TIM0_CDTI1 #8 TIM0_CDTI2 #7 TIM1_CC0 #12 TIM1_CC1 #11 TIM1_CC2 #10 TIM1_CC3 #9 LE- TIM0_OUT0 #12 LETIM0_OUT1 #11 PCNT0_S0IN #12 PCNT0_S1IN #11	US0_TX #12 US0_RX #11 US0_CLK #10 US0_CS #9 US0_CTS #8 US0_RTS #7 US1_TX #12 US1_RX #11 US1_CLK #10 US1_CS #9 US1_CTS #8 US1_RTS #7 LEU0_TX #12 LEU0_RX #11 I2C0_SDA #12 I2C0_SCL #11	FRC_DCLK #12 FRC_DOUT #11 FRC_DFRAME #10 MODEM_DCLK #12 MODEM_DIN #11 MO- DEM_DOUT #10 MODEM_ANT0 #9 MODEM_ANT1 #8	CMU_CLK1 #2 PRS_CH0 #9 PRS_CH9 #12 PRS_CH10 #1 PRS_CH11 #0 ACMP0_O #12 ACMP1_O #12

		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	Timers	Communication	Radio	Other
35	PC8	BUSAX [ADC0: APORT1XCH8 ACMP0: APORT1XCH8 ACMP1: APORT1XCH8]	TIM0_CC0 #13 TIM0_CC1 #12 TIM0_CC2 #11 TIM0_CDTI0 #10 TIM0_CDTI1 #9 TIM0_CDTI2 #8 TIM1_CC0 #13 TIM1_CC1 #12 TIM1_CC2 #11 TIM1_CC3 #10 LE- TIM0_OUT0 #13 LETIM0_OUT1 #12 PCNT0_S0IN #13 PCNT0_S1IN #12	US0_TX #13 US0_RX #12 US0_CLK #11 US0_CS #10 US0_CTS #9 US0_RTS #8 US1_TX #13 US1_RX #12 US1_CLK #11 US1_CS #10 US1_CTS #9 US1_RTS #8 LEU0_TX #13 LEU0_RX #12 I2C0_SDA #13 I2C0_SCL #12	FRC_DCLK #13 FRC_DOUT #12 FRC_DFRAME #11 MODEM_DCLK #13 MODEM_DIN #12 MO- DEM_DOUT #11 MODEM_ANT0 #10 MO- DEM_ANT1 #9	PRS_CH0 #10 PRS_CH9 #13 PRS_CH10 #2 PRS_CH11 #1 ACMP0_O #13 ACMP1_O #13
		BUSBY [ADC0: APORT2YCH8 ACMP0: APORT2YCH8 ACMP1: APORT2YCH8]				
36	PC9	BUSAY [ADC0: APORT1YCH9 ACMP0: APORT1YCH9 ACMP1: APORT1YCH9]	TIM0_CC0 #14 TIM0_CC1 #13 TIM0_CC2 #12 TIM0_CDTI0 #11 TIM0_CDTI1 #10 TIM0_CDTI2 #9 TIM1_CC0 #14 TIM1_CC1 #13 TIM1_CC2 #12 TIM1_CC3 #11 LE- TIM0_OUT0 #14 LETIM0_OUT1 #13 PCNT0_S0IN #14 PCNT0_S1IN #13	US0_TX #14 US0_RX #13 US0_CLK #12 US0_CS #11 US0_CTS #10 US0_RTS #9 US1_TX #14 US1_RX #13 US1_CLK #12 US1_CS #11 US1_CTS #10 US1_RTS #9 LEU0_TX #14 LEU0_RX #13 I2C0_SDA #14 I2C0_SCL #13	FRC_DCLK #14 FRC_DOUT #13 FRC_DFRAME #12 MODEM_DCLK #14 MODEM_DIN #13 MO- DEM_DOUT #12 MODEM_ANT0 #11 MO- DEM_ANT1 #10	PRS_CH0 #11 PRS_CH9 #14 PRS_CH10 #3 PRS_CH11 #2 ACMP0_O #14 ACMP1_O #14
		BUSBX [ADC0: APORT2XCH9 ACMP0: APORT2XCH9 ACMP1: APORT2XCH9]				
37	PC10	BUSAX [ADC0: APORT1XCH10 ACMP0: APORT1XCH10 ACMP1: APORT1XCH10]	TIM0_CC0 #15 TIM0_CC1 #14 TIM0_CC2 #13 TIM0_CDTI0 #12 TIM0_CDTI1 #11 TIM0_CDTI2 #10 TIM1_CC0 #15 TIM1_CC1 #14 TIM1_CC2 #13 TIM1_CC3 #12 LE- TIM0_OUT0 #15 LETIM0_OUT1 #14 PCNT0_S0IN #15 PCNT0_S1IN #14	US0_TX #15 US0_RX #14 US0_CLK #13 US0_CS #12 US0_CTS #11 US0_RTS #10 US1_TX #15 US1_RX #14 US1_CLK #13 US1_CS #12 US1_CTS #11 US1_RTS #10 LEU0_TX #15 LEU0_RX #14 I2C0_SDA #15 I2C0_SCL #14	FRC_DCLK #15 FRC_DOUT #14 FRC_DFRAME #13 MODEM_DCLK #15 MODEM_DIN #14 MO- DEM_DOUT #13 MODEM_ANT0 #12 MO- DEM_ANT1 #11	CMU_CLK1 #3 PRS_CH0 #12 PRS_CH9 #15 PRS_CH10 #4 PRS_CH11 #3 ACMP0_O #15 ACMP1_O #15 GPIO_EM4WU12
		BUSBY [ADC0: APORT2YCH10 ACMP0: APORT2YCH10 ACMP1: APORT2YCH10]				

		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	Timers	Communication	Radio	Other
38	PC11	BUSAY [ADC0: APORT1YCH11 ACMP0: APORT1YCH11 ACMP1: APORT1YCH11] BUSBX [ADC0: APORT2XCH11 ACMP0: APORT2XCH11 ACMP1: APORT2XCH11]	TIM0_CC0 #16 TIM0_CC1 #15 TIM0_CC2 #14 TIM0_CDTI0 #13 TIM0_CDTI1 #12 TIM0_CDTI2 #11 TIM1_CC0 #16 TIM1_CC1 #15 TIM1_CC2 #14 TIM1_CC3 #13 LE- TIM0_OUT0 #16 LETIM0_OUT1 #15 PCNT0_S0IN #16 PCNT0_S1IN #15	US0_TX #16 US0_RX #15 US0_CLK #14 US0_CS #13 US0_CTS #12 US0_RTS #11 US1_TX #16 US1_RX #15 US1_CLK #14 US1_CS #13 US1_CTS #12 US1_RTS #11 LEU0_TX #16 LEU0_RX #15 I2C0_SDA #16 I2C0_SCL #15	FRC_DCLK #16 FRC_DOUT #15 FRC_DFRAME #14 MODEM_DCLK #16 MODEM_DIN #15 MO- DEM_DOUT #14 MODEM_ANT0 #13 MO- DEM_ANT1 #12	CMU_CLK0 #3 PRS_CH0 #13 PRS_CH9 #16 PRS_CH10 #5 PRS_CH11 #4 ACMP0_O #16 ACMP1_O #16 DBG_SWO #3
39	PF0	BUSAX [ADC0: APORT1XCH16 ACMP0: APORT1XCH16 ACMP1: APORT1XCH16] BUSBY [ADC0: APORT2YCH16 ACMP0: APORT2YCH16 ACMP1: APORT2YCH16]	TIM0_CC0 #24 TIM0_CC1 #23 TIM0_CC2 #22 TIM0_CDTI0 #21 TIM0_CDTI1 #20 TIM0_CDTI2 #19 TIM1_CC0 #24 TIM1_CC1 #23 TIM1_CC2 #22 TIM1_CC3 #21 LE- TIM0_OUT0 #24 LETIM0_OUT1 #23 PCNT0_S0IN #24 PCNT0_S1IN #23	US0_TX #24 US0_RX #23 US0_CLK #22 US0_CS #21 US0_CTS #20 US0_RTS #19 US1_TX #24 US1_RX #23 US1_CLK #22 US1_CS #21 US1_CTS #20 US1_RTS #19 LEU0_TX #24 LEU0_RX #23 I2C0_SDA #24 I2C0_SCL #23	FRC_DCLK #24 FRC_DOUT #23 FRC_DFRAME #22 MODEM_DCLK #24 MODEM_DIN #23 MO- DEM_DOUT #22 MODEM_ANT0 #21 MO- DEM_ANT1 #20	PRS_CH0 #0 PRS_CH1 #7 PRS_CH2 #6 PRS_CH3 #5 ACMP0_O #24 ACMP1_O #24 DBG_SWCLKTCK #0
40	PF1	BUSAY [ADC0: APORT1YCH17 ACMP0: APORT1YCH17 ACMP1: APORT1YCH17] BUSBX [ADC0: APORT2XCH17 ACMP0: APORT2XCH17 ACMP1: APORT2XCH17]	TIM0_CC0 #25 TIM0_CC1 #24 TIM0_CC2 #23 TIM0_CDTI0 #22 TIM0_CDTI1 #21 TIM0_CDTI2 #20 TIM1_CC0 #25 TIM1_CC1 #24 TIM1_CC2 #23 TIM1_CC3 #22 LE- TIM0_OUT0 #25 LETIM0_OUT1 #24 PCNT0_S0IN #25 PCNT0_S1IN #24	US0_TX #25 US0_RX #24 US0_CLK #23 US0_CS #22 US0_CTS #21 US0_RTS #20 US1_TX #25 US1_RX #24 US1_CLK #23 US1_CS #22 US1_CTS #21 US1_RTS #20 LEU0_TX #25 LEU0_RX #24 I2C0_SDA #25 I2C0_SCL #24	FRC_DCLK #25 FRC_DOUT #24 FRC_DFRAME #23 MODEM_DCLK #25 MODEM_DIN #24 MO- DEM_DOUT #23 MODEM_ANT0 #22 MO- DEM_ANT1 #21	PRS_CH0 #1 PRS_CH1 #0 PRS_CH2 #7 PRS_CH3 #6 ACMP0_O #25 ACMP1_O #25 DBG_SWDIOTMS #0

		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	Timers	Communication	Radio	Other
41	PF2	BUSAX [ADC0: APORT1XCH18 ACMP0: APORT1XCH18 ACMP1: APORT1XCH18] BUSBY [ADC0: APORT2YCH18 ACMP0: APORT2YCH18 ACMP1: APORT2YCH18]	TIM0_CC0 #26 TIM0_CC1 #25 TIM0_CC2 #24 TIM0_CDTI0 #23 TIM0_CDTI1 #22 TIM0_CDTI2 #21 TIM1_CC0 #26 TIM1_CC1 #25 TIM1_CC2 #24 TIM1_CC3 #23 LE- TIM0_OUT0 #26 LETIM0_OUT1 #25 PCNT0_S0IN #26 PCNT0_S1IN #25	US0_TX #26 US0_RX #25 US0_CLK #24 US0_CS #23 US0_CTS #22 US0_RTS #21 US1_TX #26 US1_RX #25 US1_CLK #24 US1_CS #23 US1_CTS #22 US1_RTS #21 LEU0_TX #26 LEU0_RX #25 I2C0_SDA #26 I2C0_SCL #25	FRC_DCLK #26 FRC_DOUT #25 FRC_DFRAME #24 MODEM_DCLK #26 MODEM_DIN #25 MO- DEM_DOUT #24 MODEM_ANT0 #23 MO- DEM_ANT1 #22	CMU_CLK0 #6 PRS_CH0 #2 PRS_CH1 #1 PRS_CH2 #0 PRS_CH3 #7 ACMP0_O #26 ACMP1_O #26 DBG_TDO #0 DBG_SWO #0 GPIO_EM4WU0
42	PF3	BUSAY [ADC0: APORT1YCH19 ACMP0: APORT1YCH19 ACMP1: APORT1YCH19] BUSBX [ADC0: APORT2XCH19 ACMP0: APORT2XCH19 ACMP1: APORT2XCH19]	TIM0_CC0 #27 TIM0_CC1 #26 TIM0_CC2 #25 TIM0_CDTI0 #24 TIM0_CDTI1 #23 TIM0_CDTI2 #22 TIM1_CC0 #27 TIM1_CC1 #26 TIM1_CC2 #25 TIM1_CC3 #24 LE- TIM0_OUT0 #27 LETIM0_OUT1 #26 PCNT0_S0IN #27 PCNT0_S1IN #26	US0_TX #27 US0_RX #26 US0_CLK #25 US0_CS #24 US0_CTS #23 US0_RTS #22 US1_TX #27 US1_RX #26 US1_CLK #25 US1_CS #24 US1_CTS #23 US1_RTS #22 LEU0_TX #27 LEU0_RX #26 I2C0_SDA #27 I2C0_SCL #26	FRC_DCLK #27 FRC_DOUT #26 FRC_DFRAME #25 MODEM_DCLK #27 MODEM_DIN #26 MO- DEM_DOUT #25 MODEM_ANT0 #24 MO- DEM_ANT1 #23	CMU_CLK1 #6 PRS_CH0 #3 PRS_CH1 #2 PRS_CH2 #1 PRS_CH3 #0 ACMP0_O #27 ACMP1_O #27 DBG_TDI #0
43	PF4	BUSAX [ADC0: APORT1XCH20 ACMP0: APORT1XCH20 ACMP1: APORT1XCH20] BUSBY [ADC0: APORT2YCH20 ACMP0: APORT2YCH20 ACMP1: APORT2YCH20]	TIM0_CC0 #28 TIM0_CC1 #27 TIM0_CC2 #26 TIM0_CDTI0 #25 TIM0_CDTI1 #24 TIM0_CDTI2 #23 TIM1_CC0 #28 TIM1_CC1 #27 TIM1_CC2 #26 TIM1_CC3 #25 LE- TIM0_OUT0 #28 LETIM0_OUT1 #27 PCNT0_S0IN #28 PCNT0_S1IN #27	US0_TX #28 US0_RX #27 US0_CLK #26 US0_CS #25 US0_CTS #24 US0_RTS #23 US1_TX #28 US1_RX #27 US1_CLK #26 US1_CS #25 US1_CTS #24 US1_RTS #23 LEU0_TX #28 LEU0_RX #27 I2C0_SDA #28 I2C0_SCL #27	FRC_DCLK #28 FRC_DOUT #27 FRC_DFRAME #26 MODEM_DCLK #28 MODEM_DIN #27 MO- DEM_DOUT #26 MODEM_ANT0 #25 MO- DEM_ANT1 #24	PRS_CH0 #4 PRS_CH1 #3 PRS_CH2 #2 PRS_CH3 #1 ACMP0_O #28 ACMP1_O #28

		Pin Alternate Functionality / Description				
Pin #	Pin Name	Analog	Timers	Communication	Radio	Other
44	PF5	BUSAY [ADC0: APORT1YCH21 ACMP0: APORT1YCH21 ACMP1: APORT1YCH21] BUSBX [ADC0: APORT2XCH21 ACMP0: APORT2XCH21 ACMP1: APORT2XCH21]	TIM0_CC0 #29 TIM0_CC1 #28 TIM0_CC2 #27 TIM0_CDTI0 #26 TIM0_CDTI1 #25 TIM0_CDTI2 #24 TIM1_CC0 #29 TIM1_CC1 #28 TIM1_CC2 #27 TIM1_CC3 #26 LE- TIM0_OUT0 #29 LETIM0_OUT1 #28 PCNT0_S0IN #29 PCNT0_S1IN #28	US0_TX #29 US0_RX #28 US0_CLK #27 US0_CS #26 US0_CTS #25 US0_RTS #24 US1_TX #29 US1_RX #28 US1_CLK #27 US1_CS #26 US1_CTS #25 US1_RTS #24 LEU0_TX #29 LEU0_RX #28 I2C0_SDA #29 I2C0_SCL #28	FRC_DCLK #29 FRC_DOUT #28 FRC_DFRAME #27 MODEM_DCLK #29 MODEM_DIN #28 MO- DEM_DOUT #27 MODEM_ANT0 #26 MO- DEM_ANT1 #25	PRS_CH0 #5 PRS_CH1 #4 PRS_CH2 #3 PRS_CH3 #2 ACMP0_O #29 ACMP1_O #29
45	PF6	BUSAX [ADC0: APORT1XCH22 ACMP0: APORT1XCH22 ACMP1: APORT1XCH22] BUSBY [ADC0: APORT2YCH22 ACMP0: APORT2YCH22 ACMP1: APORT2YCH22]	TIM0_CC0 #30 TIM0_CC1 #29 TIM0_CC2 #28 TIM0_CDTI0 #27 TIM0_CDTI1 #26 TIM0_CDTI2 #25 TIM1_CC0 #30 TIM1_CC1 #29 TIM1_CC2 #28 TIM1_CC3 #27 LE- TIM0_OUT0 #30 LETIM0_OUT1 #29 PCNT0_S0IN #30 PCNT0_S1IN #29	US0_TX #30 US0_RX #29 US0_CLK #28 US0_CS #27 US0_CTS #26 US0_RTS #25 US1_TX #30 US1_RX #29 US1_CLK #28 US1_CS #27 US1_CTS #26 US1_RTS #25 LEU0_TX #30 LEU0_RX #29 I2C0_SDA #30 I2C0_SCL #29	FRC_DCLK #30 FRC_DOUT #29 FRC_DFRAME #28 MODEM_DCLK #30 MODEM_DIN #29 MO- DEM_DOUT #28 MODEM_ANT0 #27 MO- DEM_ANT1 #26	CMU_CLK1 #7 PRS_CH0 #6 PRS_CH1 #5 PRS_CH2 #4 PRS_CH3 #3 ACMP0_O #30 ACMP1_O #30
46	PF7	BUSAY [ADC0: APORT1YCH23 ACMP0: APORT1YCH23 ACMP1: APORT1YCH23] BUSBX [ADC0: APORT2XCH23 ACMP0: APORT2XCH23 ACMP1: APORT2XCH23]	TIM0_CC0 #31 TIM0_CC1 #30 TIM0_CC2 #29 TIM0_CDTI0 #28 TIM0_CDTI1 #27 TIM0_CDTI2 #26 TIM1_CC0 #31 TIM1_CC1 #30 TIM1_CC2 #29 TIM1_CC3 #28 LE- TIM0_OUT0 #31 LETIM0_OUT1 #30 PCNT0_S0IN #31 PCNT0_S1IN #30	US0_TX #31 US0_RX #30 US0_CLK #29 US0_CS #28 US0_CTS #27 US0_RTS #26 US1_TX #31 US1_RX #30 US1_CLK #29 US1_CS #28 US1_CTS #27 US1_RTS #26 LEU0_TX #31 LEU0_RX #30 I2C0_SDA #31 I2C0_SCL #30	FRC_DCLK #31 FRC_DOUT #30 FRC_DFRAME #29 MODEM_DCLK #31 MODEM_DIN #30 MO- DEM_DOUT #29 MODEM_ANT0 #28 MO- DEM_ANT1 #27	CMU_CLK0 #7 PRS_CH0 #7 PRS_CH1 #6 PRS_CH2 #5 PRS_CH3 #4 ACMP0_O #31 ACMP1_O #31 GPIO_EM4WU1

7.1.1 GPIO Overview

The GPIO pins are organized as 16-bit ports indicated by letters A through F, and the individual pins on each port are indicated by a number from 15 down to 0.

Table 7.2. GPIO Pinout

Port	Pin 15	Pin 14	Pin 13	Pin 12	Pin 11	Pin 10	Pin 9	Pin 8	Pin 7	Pin 6	Pin 5	Pin 4	Pin 3	Pin 2	Pin 1	Pin 0
Port A	-	-	-	-	-	-	-	-	-	-	PA5 (5V)	PA4 (5V)	PA3 (5V)	PA2 (5V)	PA1	PA0
Port B			PB13 ² (5V)	PB12 ² (5V)	PB11 ² (5V)	-	-	-	-	-	-	-	-	-	-	-
Port C	-	-	-	-	PC11 (5V)	PC10 (5V)	PC9 (5V)	PC8 (5V)	PC7 (5V)	PC6 (5V)	-	-	-	-	-	-
Port D	PD15 ² (5V)	PD14 ² (5V)	PD13 ² (5V)	PD12 (5V)	PD11 (5V)	PD10 (5V)	PD9 (5V)	-	-	-	-	-	-	-	-	-
Port F	-	-	-	-	-	-	-	-	PF7 (5V)	PF6 (5V)	PF5 (5V)	PF4 (5V)	PF3 (5V)	PF2 (5V)	PF1 (5V)	PF0 (5V)

Note:

1. GPIO with 5V compatibility are indicated by (5V)
2. Pins PA2, PA3, PA4, PB11, PB12, PD13, PD14 and PD15 will not be 5V compatible on all future devices.

In order to preserve upgrade options with full hardware compatibility, do not use the pins listed in Note 2 with 5V domains.

7.2 Alternate Functionality Pinout

A wide selection of alternate functionality is available for multiplexing to various pins. The following table shows the name of the alternate functionality in the first column, followed by columns showing the possible LOCATION bitfield settings.

Note: Some functionality, such as analog interfaces, do not have alternate settings or a LOCATION bitfield. In these cases, the pinout is shown in the column corresponding to LOCATION 0.

Table 7.3. Alternate functionality overview

Alternate	LOCATION								
Functionality	0 - 3	4 - 7	8 - 11	12 - 15	16 - 19	20 - 23	24 - 27	28 - 31	Description
ACMP0_O	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11 17: PD9 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	Analog comparator ACMP0, digital output.
ACMP1_O	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11 17: PD9 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	Analog comparator ACMP1, digital output.
ADC0_EXTN	0: PA0								Analog to digital converter ADC0 external reference input negative pin
ADC0_EXTP	0: PA1								Analog to digital converter ADC0 external reference input positive pin
CMU_CLK0	0: PA1 2: PC6 3: PC11	4: PD9 5: PD14 6: PF2 7: PF7							Clock Management Unit, clock output number 0.
CMU_CLK1	0: PA0 2: PC7 3: PC10	4: PD10 5: PD15 6: PF3 7: PF6							Clock Management Unit, clock output number 1.
DBG_SWCLKTCK	0: PF0								Debug-interface Serial Wire clock input and JTAG Test Clock. Note that this function is enabled to the pin out of reset, and has a built-in pull down.
DBG_SWDIOTMS	0: PF1								Debug-interface Serial Wire data input / output and JTAG Test Mode Select. Note that this function is enabled to the pin out of reset, and has a built-in pull up.

Alternate	LOCATION								
Functionality	0 - 3	4 - 7	8 - 11	12 - 15	16 - 19	20 - 23	24 - 27	28 - 31	Description
DBG_SWO	0: PF2 1: PB13 2: PD15 3: PC11								Debug-interface Serial Wire viewer Output. Note that this function is not enabled after reset, and must be enabled by software to be used.
DBG_TDI	0: PF3								Debug-interface JTAG Test Data In. Note that this function is enabled to pin out of reset, and has a built-in pull up.
DBG_TDO	0: PF2								Debug-interface JTAG Test Data Out. Note that this function is enabled to pin out of reset.
FRC_DCLK	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	Frame Controller, Data Sniffer Clock.
FRC_DFRAME	0: PA2 1: PA3 2: PA4 3: PA5	4: PB11 5: PB12 6: PB13	9: PC6 10: PC7 11: PC8	12: PC9 13: PC10 14: PC11	16: PD10 17: PD11 18: PD12 19: PD13	20: PD14 21: PD15 22: PF0 23: PF1	24: PF2 25: PF3 26: PF4 27: PF5	28: PF6 29: PF7 30: PA0 31: PA1	Frame Controller, Data Sniffer Frame active
FRC_DOUT	0: PA1 1: PA2 2: PA3 3: PA4	4: PA5 5: PB11 6: PB12 7: PB13	10: PC6 11: PC7	12: PC8 13: PC9 14: PC10 15: PC11	17: PD10 18: PD11 19: PD12	20: PD13 21: PD14 22: PD15 23: PF0	24: PF1 25: PF2 26: PF3 27: PF4	28: PF5 29: PF6 30: PF7 31: PA0	Frame Controller, Data Sniffer Output.
GPIO_EM4WU0	0: PF2								Pin can be used to wake the system up from EM4
GPIO_EM4WU1	0: PF7								Pin can be used to wake the system up from EM4
GPIO_EM4WU4	0: PD14								Pin can be used to wake the system up from EM4
GPIO_EM4WU8	0: PA3								Pin can be used to wake the system up from EM4
GPIO_EM4WU9	0: PB13								Pin can be used to wake the system up from EM4
GPIO_EM4WU12	0: PC10								Pin can be used to wake the system up from EM4

Alternate	LOCATION								
Functionality	0 - 3	4 - 7	8 - 11	12 - 15	16 - 19	20 - 23	24 - 27	28 - 31	Description
I2C0_SCL	0: PA1 1: PA2 2: PA3 3: PA4	4: PA5 5: PB11 6: PB12 7: PB13	10: PC6 11: PC7	12: PC8 13: PC9 14: PC10 15: PC11	16: PD9 17: PD10 18: PD11 19: PD12	20: PD13 21: PD14 22: PD15 23: PF0	24: PF1 25: PF2 26: PF3 27: PF4	28: PF5 29: PF6 30: PF7 31: PA0	I2C0 Serial Clock Line input / output.
I2C0_SDA	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11 17: PD9 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	I2C0 Serial Data in- put / output.
LETIM0_OUT0	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC8 13: PC9 14: PC10 15: PC11	16: PC11 17: PD9 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	Low Energy Timer LETIM0, output channel 0.
LETIM0_OUT1	0: PA1 1: PA2 2: PA3 3: PA4	4: PA5 5: PB11 6: PB12 7: PB13	10: PC6 11: PC7	12: PC8 13: PC9 14: PC10 15: PC11	16: PD9 17: PD10 18: PD11 19: PD12	20: PD13 21: PD14 22: PD15 23: PF0	24: PF1 25: PF2 26: PF3 27: PF4	28: PF5 29: PF6 30: PF7 31: PA0	Low Energy Timer LETIM0, output channel 1.
LEU0_RX	0: PA1 1: PA2 2: PA3 3: PA4	4: PA5 5: PB11 6: PB12 7: PB13	10: PC6 11: PC7	12: PC8 13: PC9 14: PC10 15: PC11	16: PD9 17: PD10 18: PD11 19: PD12	20: PD13 21: PD14 22: PD15 23: PF0	24: PF1 25: PF2 26: PF3 27: PF4	28: PF5 29: PF6 30: PF7 31: PA0	LEUART0 Receive input.
LEU0_TX	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11 17: PD9 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	LEUART0 Transmit output. Also used as receive input in half duplex commu- nication.
LFXTAL_N									Connected internal- ly to a Low Fre- quency Crystal (32.768 kHz). Leave unconnected externally.
LFXTAL_P									Connected internal- ly to a Low Fre- quency Crystal (32.768 kHz). Leave unconnected externally.
MODEM_ANT0	0: PA3 1: PA4 2: PA5 3: PB11	4: PB12 5: PB13	8: PC6 9: PC7 10: PC8 11: PC9	12: PC10 13: PC11 15: PD10	16: PD11 17: PD12 18: PD13 19: PD14	20: PD15 21: PF0 22: PF1 23: PF2	24: PF3 25: PF4 26: PF5 27: PF6	28: PF7 29: PA0 30: PA1 31: PA2	MODEM antenna control output 0, used for antenna diversity.
MODEM_ANT1	0: PA4 1: PA5 2: PB11 3: PB12	4: PB13 7: PC6	8: PC7 9: PC8 10: PC9 11: PC11	12: PC11 14: PD10 15: PD11	16: PD12 17: PD13 18: PD14 19: PD15	20: PF0 21: PF1 22: PF2 23: PF3	24: PF4 25: PF5 26: PF6 27: PF7	28: PA0 29: PA1 30: PA2 31: PA3	MODEM antenna control output 1, used for antenna diversity.
MODEM_DCLK	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	MODEM data clock out.

Alternate	LOCATION								
Functionality	0 - 3	4 - 7	8 - 11	12 - 15	16 - 19	20 - 23	24 - 27	28 - 31	Description
MODEM_DIN	0: PA1 1: PA2 2: PA3 3: PA4	4: PA5 5: PB11 6: PB12 7: PB13	10: PC6 11: PC7	12: PC8 13: PC9 14: PC10 15: PC11	17: PD10 18: PD11 19: PD12	20: PD13 21: PD14 22: PD15 23: PF0	24: PF1 25: PF2 26: PF3 27: PF4	28: PF5 29: PF6 30: PF7 31: PA0	MODEM data in.
MODEM_DOUT	0: PA2 1: PA3 2: PA4 3: PA5	4: PB11 5: PB12 6: PB13	9: PC6 10: PC7 11: PC8	12: PC9 13: PC10 14: PC11	16: PD10 17: PD11 18: PD12 19: PD13	20: PD14 21: PD15 22: PF0 23: PF1	24: PF2 25: PF3 26: PF4 27: PF5	28: PF6 29: PF7 30: PA0 31: PA1	MODEM data out.
PCNT0_S0IN	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11 17: PD9 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	Pulse Counter PCNT0 input number 0.
PCNT0_S1IN	0: PA1 1: PA2 2: PA3 3: PA4	4: PA5 5: PB11 6: PB12 7: PB13	10: PC6 11: PC7	12: PC8 13: PC9 14: PC10 15: PC11	16: PD9 17: PD10 18: PD11 19: PD12	20: PD13 21: PD14 22: PD15 23: PF0	24: PF1 25: PF2 26: PF3 27: PF4	28: PF5 29: PF6 30: PF7 31: PA0	Pulse Counter PCNT0 input number 1.
PRS_CH0	0: PF0 1: PF1 2: PF2 3: PF3	4: PF4 5: PF5 6: PF6 7: PF7	8: PC6 9: PC7 10: PC8 11: PC9	12: PC10 13: PC11					Peripheral Reflex System PRS, channel 0.
PRS_CH1	0: PF1 1: PF2 2: PF3 3: PF4	4: PF5 5: PF6 6: PF7 7: PF0							Peripheral Reflex System PRS, channel 1.
PRS_CH2	0: PF2 1: PF3 2: PF4 3: PF5	4: PF6 5: PF7 6: PF0 7: PF1							Peripheral Reflex System PRS, channel 2.
PRS_CH3	0: PF3 1: PF4 2: PF5 3: PF6	4: PF7 5: PF0 6: PF1 7: PF2	8: PD9 9: PD10 10: PD11 11: PD12	12: PD13 13: PD14 14: PD15					Peripheral Reflex System PRS, channel 3.
PRS_CH4	0: PD9 1: PD10 2: PD11 3: PD12	4: PD13 5: PD14 6: PD15							Peripheral Reflex System PRS, channel 4.
PRS_CH5	0: PD10 1: PD11 2: PD12 3: PD13	4: PD14 5: PD15 6: PD9							Peripheral Reflex System PRS, channel 5.
PRS_CH6	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PD9	12: PD10 13: PD11 14: PD12 15: PD13	16: PD14 17: PD15				Peripheral Reflex System PRS, channel 6.
PRS_CH7	0: PA1 1: PA2 2: PA3 3: PA4	4: PA5 5: PB11 6: PB12 7: PB13	10: PA0						Peripheral Reflex System PRS, channel 7.

Alternate	LOCATION								
Functionality	0 - 3	4 - 7	8 - 11	12 - 15	16 - 19	20 - 23	24 - 27	28 - 31	Description
PRS_CH8	0: PA2 1: PA3 2: PA4 3: PA5	4: PB11 5: PB12 6: PB13	9: PA0 10: PA1						Peripheral Reflex System PRS, channel 8.
PRS_CH9	0: PA3 1: PA4 2: PA5 3: PB11	4: PB12 5: PB13	8: PA0 9: PA1 10: PA2 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11				Peripheral Reflex System PRS, channel 9.
PRS_CH10	0: PC6 1: PC7 2: PC8 3: PC9	4: PC10 5: PC11							Peripheral Reflex System PRS, channel 10.
PRS_CH11	0: PC7 1: PC8 2: PC9 3: PC10	4: PC11 5: PC6							Peripheral Reflex System PRS, channel 11.
TIM0_CC0	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11 17: PD9 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	Timer 0 Capture Compare input / output channel 0.
TIM0_CC1	0: PA1 1: PA2 2: PA3 3: PA4	4: PA5 5: PB11 6: PB12 7: PB13	10: PC6 11: PC7	12: PC8 13: PC9 14: PC10 15: PC11	16: PD9 17: PD10 18: PD11 19: PD12	20: PD13 21: PD14 22: PD15 23: PF0	24: PF1 25: PF12 26: PF3 27: PF4	28: PF5 29: PF6 30: PF7 31: PA0	Timer 0 Capture Compare input / output channel 1.
TIM0_CC2	0: PA2 1: PA3 2: PA4 3: PA5	4: PB11 5: PB12 6: PB13	9: PC6 10: PC7 11: PC8	12: PC9 13: PC10 14: PC11 15: PD9	16: PD10 17: PD11 18: PD12 19: PD13	20: PD14 21: PD15 22: PF0 23: PF1	24: PF2 25: PF3 26: PF4 27: PF5	28: PF6 29: PF7 30: PA0 31: PA1	Timer 0 Capture Compare input / output channel 2.
TIM0_CDTI0	0: PA3 1: PA4 2: PA5 3: PB11	4: PB12 5: PB13	8: PC6 9: PC7 10: PC8 11: PC9	12: PC10 13: PC11 14: PD9 15: PD10	16: PD11 17: PD12 18: PD13 19: PD14	20: PD15 21: PF0 22: PF1 23: PF2	24: PF3 25: PF4 26: PF5 27: PF6	28: PF7 29: PA0 30: PA1 31: PA2	Timer 0 Complimentary Dead Time Insertion channel 0.
TIM0_CDTI1	0: PA4 1: PA5 2: PB11 3: PB12	4: PB13 7: PC6	8: PC7 9: PC8 10: PC9 11: PC10	12: PC11 13: PD9 14: PD10 15: PD11	16: PD12 17: PD13 18: PD14 19: PD15	20: PF0 21: PF1 22: PF2 23: PF3	24: PF4 25: PF5 26: PF6 27: PF7	28: PA0 29: PA1 30: PA2 31: PA3	Timer 0 Complimentary Dead Time Insertion channel 1.
TIM0_CDTI2	0: PA5 1: PB11 2: PB12 3: PB13	6: PC6 7: PC7	8: PC8 9: PC9 10: PC10 11: PC11	12: PD9 13: PD10 14: PD11 15: PD12	16: PD13 17: PD14 18: PD15 19: PF0	20: PF1 21: PF2 22: PF3 23: PF4	24: PF5 25: PF6 26: PF7 27: PA0	28: PA1 29: PA2 30: PA3 31: PA4	Timer 0 Complimentary Dead Time Insertion channel 2.
TIM1_CC0	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11 17: PD9 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	Timer 1 Capture Compare input / output channel 0.
TIM1_CC1	0: PA1 1: PA2 2: PA3 3: PA4	4: PA5 5: PB11 6: PB12 7: PB13	10: PC6 11: PC7	12: PC8 13: PC9 14: PC10 15: PC11	16: PD9 17: PD10 18: PD11 19: PD12	20: PD13 21: PD14 22: PD15 23: PF0	24: PF1 25: PF2 26: PF3 27: PF4	28: PF5 29: PF6 30: PF7 31: PA0	Timer 1 Capture Compare input / output channel 1.

Alternate	LOCATION								
Functionality	0 - 3	4 - 7	8 - 11	12 - 15	16 - 19	20 - 23	24 - 27	28 - 31	Description
TIM1_CC2	0: PA2 1: PA3 2: PA4 3: PA5	4: PB11 5: PB12 6: PB13	9: PC6 10: PC7 11: PC8	12: PC9 13: PC10 14: PC11 15: PD9	16: PD10 17: PD11 18: PD12 19: PD13	20: PD14 21: PD15 22: PF0 23: PF1	24: PF2 25: PF3 26: PF4 27: PF5	28: PF6 29: PF7 30: PA0 31: PA1	Timer 1 Capture Compare input / output channel 2.
TIM1_CC3	0: PA3 1: PA4 2: PA5 3: PB11	4: PB12 5: PB13	8: PC6 9: PC7 10: PC8 11: PC9	12: PC10 13: PC11 14: PD9 15: PD10	16: PD11 17: PD12 18: PD13 19: PD14	20: PD15 21: PF0 22: PF1 23: PF2	24: PF3 25: PF4 26: PF5 27: PF6	28: PF7 29: PA0 30: PA1 31: PA2	Timer 1 Capture Compare input / output channel 3.
US0_CLK	0: PA2 1: PA3 2: PA4 3: PA5	4: PB11 5: PB12 6: PB13	9: PC6 10: PC7 11: PC8	12: PC9 13: PC10 14: PC11 15: PD9	16: PD10 17: PD11 18: PD12 19: PD13	20: PD14 21: PD15 22: PF0 23: PF1	24: PF2 25: PF3 26: PF4 27: PF5	28: PF6 29: PF7 30: PA0 31: PA1	USART0 clock input / output.
US0_CS	0: PA3 1: PA4 2: PA5 3: PB11	4: PB12 5: PB13	8: PC6 9: PC7 10: PC8 11: PC9	12: PC10 13: PC11 14: PD9 15: PD10	16: PD11 17: PD12 18: PD13 19: PD14	20: PD15 21: PF0 22: PF1 23: PF2	24: PF3 25: PF4 26: PF5 27: PF6	28: PF7 29: PA0 30: PA1 31: PA2	USART0 chip select input / output.
US0_CTS	0: PA4 1: PA5 2: PB11 3: PB12	4: PB13 7: PC6	8: PC7 9: PC8 10: PC9 11: PC10	12: PC11 13: PD9 14: PD10 15: PD11	16: PD12 17: PD13 18: PD14 19: PD15	20: PF0 21: PF1 22: PF2 23: PF3	24: PF4 25: PF5 26: PF6 27: PF7	28: PA0 29: PA1 30: PA2 31: PA3	USART0 Clear To Send hardware flow control input.
US0_RTS	0: PA5 1: PB11 2: PB12 3: PB13	6: PC6 7: PC7	8: PC8 9: PC9 10: PC10 11: PC11	12: PD9 13: PD10 14: PD11 15: PD12	16: PD13 17: PD14 18: PD15 19: PF0	20: PF1 21: PF2 22: PF3 23: PF4	24: PF5 25: PF6 26: PF7 27: PA0	28: PA1 29: PA2 30: PA3 31: PA4	USART0 Request To Send hardware flow control output.
US0_RX	0: PA1 1: PA2 2: PA3 3: PA4	4: PA5 5: PB11 6: PB12 7: PB13	10: PC6 11: PC7	12: PC8 13: PC9 14: PC10 15: PC11	16: PD9 17: PD10 18: PD11 19: PD12	20: PD13 21: PD14 22: PD15 23: PF0	24: PF1 25: PF2 26: PF3 27: PF4	28: PF5 29: PF6 30: PF7 31: PA0	USART0 Asynchronous Receive. USART0 Synchronous mode Master Input / Slave Output (MISO).
US0_TX	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11 17: PD9 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	USART0 Asynchronous Transmit. Also used as receive input in half duplex communication. USART0 Synchronous mode Master Output / Slave Input (MOSI).
US1_CLK	0: PA2 1: PA3 2: PA4 3: PA5	4: PB11 5: PB12 6: PB13	9: PC6 10: PC7 11: PC8	12: PC9 13: PC10 14: PC11 15: PD9	16: PD10 17: PD11 18: PD12 19: PD13	20: PD14 21: PD15 22: PF0 23: PF1	24: PF2 25: PF3 26: PF4 27: PF5	28: PF6 29: PF7 30: PA0 31: PA1	USART1 clock input / output.
US1_CS	0: PA3 1: PA4 2: PA5 3: PB11	4: PB12 5: PB13	8: PC6 9: PC7 10: PC8 11: PC9	12: PC10 13: PC11 14: PD9 15: PD10	16: PD11 17: PD12 18: PD13 19: PD14	20: PD15 21: PF0 22: PF1 23: PF2	24: PF3 25: PF4 26: PF5 27: PF6	28: PF7 29: PA0 30: PA1 31: PA2	USART1 chip select input / output.
US1_CTS	0: PA4 1: PA5 2: PB11 3: PB12	4: PB13 7: PC6	8: PC7 9: PC8 10: PC9 11: PC10	12: PC11 13: PD9 14: PD10 15: PD11	16: PD12 17: PD13 18: PD14 19: PD15	20: PF0 21: PF1 22: PF2 23: PF3	24: PF4 25: PF5 26: PF6 27: PF7	28: PA0 29: PA1 30: PA2 31: PA3	USART1 Clear To Send hardware flow control input.

Alternate	LOCATION								
Functionality	0 - 3	4 - 7	8 - 11	12 - 15	16 - 19	20 - 23	24 - 27	28 - 31	Description
US1_RTS	0: PA5 1: PB11 2: PB12 3: PB13	6: PC6 7: PC7	8: PC8 9: PC9 10: PC10 11: PC11	12: PD9 13: PD10 14: PD11 15: PD12	16: PD13 17: PD14 18: PD15 19: PF0	20: PF1 21: PF2 22: PF3 23: PF4	24: PF5 25: PF6 26: PF7 27: PA0	28: PA1 29: PA2 30: PA3 31: PA4	USART1 Request To Send hardware flow control output.
US1_RX	0: PA1 1: PA2 2: PA3 3: PA4	4: PA5 5: PB11 6: PB12 7: PB13	10: PC6 11: PC7	12: PC8 13: PC9 14: PC10 15: PC11	16: PD9 17: PD10 18: PD11 19: PD12	20: PD13 21: PD14 22: PD15 23: PF0	24: PF1 25: PF2 26: PF3 27: PF4	28: PF5 29: PF6 30: PF7 31: PA0	USART1 Asynchronous Receive. USART1 Synchronous mode Master Input / Slave Output (MISO).
US1_TX	0: PA0 1: PA1 2: PA2 3: PA3	4: PA4 5: PA5 6: PB11 7: PB12	8: PB13 11: PC6	12: PC7 13: PC8 14: PC9 15: PC10	16: PC11 17: PD9 18: PD10 19: PD11	20: PD12 21: PD13 22: PD14 23: PD15	24: PF0 25: PF1 26: PF2 27: PF3	28: PF4 29: PF5 30: PF6 31: PF7	USART1 Asynchronous Transmit. Also used as receive input in half duplex communication. USART1 Synchronous mode Master Output / Slave Input (MOSI).

7.3 Analog Port (APORT)

The Analog Port (APORT) is an infrastructure used to connect chip pins with on-chip analog clients such as analog comparators, ADCs, and DACs. The APORT consists of wires, switches, and control needed to configurably implement the routes. Please see the device Reference Manual for a complete description.

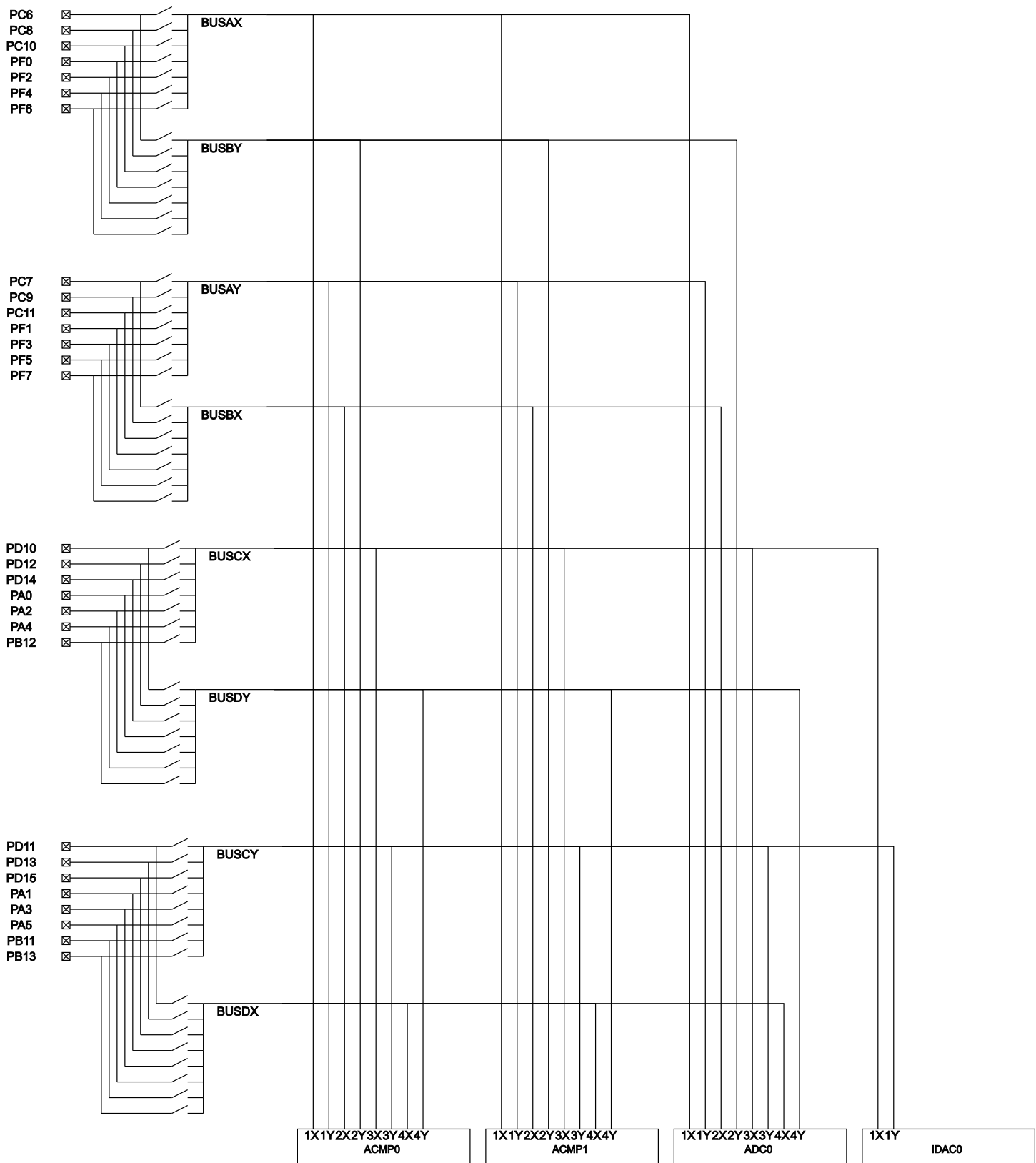


Figure 7.2. BGM121/BGM123 APORT

Table 7.4. APORT Client Map

Analog Module	Analog Module Channel	Shared Bus	Pin
ACMP0	APORT1XCH6	BUSAX	PC6
	APORT1XCH8		PC8
	APORT1XCH10		PC10
	APORT1XCH16		PF0
	APORT1XCH18		PF2
	APORT1XCH20		PF4
	APORT1XCH22		PF6
ACMP0	APORT1YCH7	BUSAY	PC7
	APORT1YCH9		PC9
	APORT1YCH11		PC11
	APORT1YCH17		PF1
	APORT1YCH19		PF3
	APORT1YCH21		PF5
	APORT1YCH23		PF7
ACMP0	APORT2XCH7	BUSBX	PC7
	APORT2XCH9		PC9
	APORT2XCH11		PC11
	APORT2XCH17		PF1
	APORT2XCH19		PF3
	APORT2XCH21		PF5
	APORT2XCH23		PF7
ACMP0	APORT2YCH6	BUSBY	PC6
	APORT2YCH8		PC8
	APORT2YCH10		PC10
	APORT2YCH16		PF0
	APORT2YCH18		PF2
	APORT2YCH20		PF4
	APORT2YCH22		PF6

Analog Module	Analog Module Channel	Shared Bus	Pin
ACMP0	APOINT3XCH2	BUSCX	
	APOINT3XCH4		
	APOINT3XCH6		PD14
	APOINT3XCH8		PA0
	APOINT3XCH10		PA2
	APOINT3XCH12		PA4
	APOINT3XCH28		
	APOINT3XCH30		
ACMP0	APOINT3YCH3	BUSCY	
	APOINT3YCH5		PD13
	APOINT3YCH7		PD15
	APOINT3YCH9		PA1
	APOINT3YCH11		PA3
	APOINT3YCH13		PA5
	APOINT3YCH27		PB11
	APOINT3YCH29		PB13
ACMP0	APOINT4XCH3	BUSDX	
	APOINT4XCH5		PD13
	APOINT4XCH7		PD15
	APOINT4XCH9		PA1
	APOINT4XCH11		PA3
	APOINT4XCH13		PA5
	APOINT4XCH27		PB11
	APOINT4XCH29		PB13
ACMP0	APOINT4YCH2	BUSDY	
	APOINT4YCH4		
	APOINT4YCH6		PD14
	APOINT4YCH8		PA0
	APOINT4YCH10		PA2
	APOINT4YCH12		PA4
	APOINT4YCH28		
	APOINT4YCH30		

Analog Module	Analog Module Channel	Shared Bus	Pin
ACMP1	APOINT1XCH6	BUSAX	PC6
	APOINT1XCH8		PC8
	APOINT1XCH10		PC10
	APOINT1XCH16		PF0
	APOINT1XCH18		PF2
	APOINT1XCH20		PF4
	APOINT1XCH22		PF6
ACMP1	APOINT1YCH7	BUSAY	PC7
	APOINT1YCH9		PC9
	APOINT1YCH11		PC11
	APOINT1YCH17		PF1
	APOINT1YCH19		PF3
	APOINT1YCH21		PF5
	APOINT1YCH23		PF7
ACMP1	APOINT2XCH7	BUSBX	PC7
	APOINT2XCH9		PC9
	APOINT2XCH11		PC11
	APOINT2XCH17		PF1
	APOINT2XCH19		PF3
	APOINT2XCH21		PF5
	APOINT2XCH23		PF7
ACMP1	APOINT2YCH6	BUSBY	PC6
	APOINT2YCH8		PC8
	APOINT2YCH10		PC10
	APOINT2YCH16		PF0
	APOINT2YCH18		PF2
	APOINT2YCH20		PF4
	APOINT2YCH22		PF6
ACMP1	APOINT3XCH2	BUSCX	
	APOINT3XCH4		
	APOINT3XCH6		PD14
	APOINT3XCH8		PA0
	APOINT3XCH10		PA2
	APOINT3XCH12		PA4
	APOINT3XCH28		
	APOINT3XCH30		

Analog Module	Analog Module Channel	Shared Bus	Pin
ACMP1	APOINT3YCH3	BUSCY	
	APOINT3YCH5		PD13
	APOINT3YCH7		PD15
	APOINT3YCH9		PA1
	APOINT3YCH11		PA3
	APOINT3YCH13		PA5
	APOINT3YCH27		PB11
	APOINT3YCH29		PB13
	APOINT3YCH31		
ACMP1	APOINT4XCH3	BUSDX	
	APOINT4XCH5		PD13
	APOINT4XCH7		PD15
	APOINT4XCH9		PA1
	APOINT4XCH11		PA3
	APOINT4XCH13		PA5
	APOINT4XCH27		PB11
	APOINT4XCH29		PB13
	APOINT4XCH31		
ACMP1	APOINT4YCH2	BUSDY	
	APOINT4YCH4		
	APOINT4YCH6		PD14
	APOINT4YCH8		PA0
	APOINT4YCH10		PA2
	APOINT4YCH12		PA4
	APOINT4YCH28		
	APOINT4YCH30		
ADC0	APOINT1XCH6	BUSAX	PC6
	APOINT1XCH8		PC8
	APOINT1XCH10		PC10
	APOINT1XCH16		PF0
	APOINT1XCH18		PF2
	APOINT1XCH20		PF4
	APOINT1XCH22		PF6

Analog Module	Analog Module Channel	Shared Bus	Pin
ADC0	APOINT1YCH7	BUSAY	PC7
	APOINT1YCH9		PC9
	APOINT1YCH11		PC11
	APOINT1YCH17		PF1
	APOINT1YCH19		PF3
	APOINT1YCH21		PF5
	APOINT1YCH23		PF7
ADC0	APOINT2XCH7	BUSBX	PC7
	APOINT2XCH9		PC9
	APOINT2XCH11		PC11
	APOINT2XCH17		PF1
	APOINT2XCH19		PF3
	APOINT2XCH21		PF5
	APOINT2XCH23		PF7
ADC0	APOINT2YCH6	BUSBY	PC6
	APOINT2YCH8		PC8
	APOINT2YCH10		PC10
	APOINT2YCH16		PF0
	APOINT2YCH18		PF2
	APOINT2YCH20		PF4
	APOINT2YCH22		PF6
ADC0	APOINT3XCH2	BUSCX	
	APOINT3XCH4		
	APOINT3XCH6		PD14
	APOINT3XCH8		PA0
	APOINT3XCH10		PA2
	APOINT3XCH12		PA4
	APOINT3XCH28		
	APOINT3XCH30		

Analog Module	Analog Module Channel	Shared Bus	Pin
ADC0	APOINT3YCH3	BUSCY	
	APOINT3YCH5		PD13
	APOINT3YCH7		PD15
	APOINT3YCH9		PA1
	APOINT3YCH11		PA3
	APOINT3YCH13		PA5
	APOINT3YCH27		PB11
	APOINT3YCH29		PB13
	APOINT3YCH31		
ADC0	APOINT4XCH3	BUSDX	
	APOINT4XCH5		PD13
	APOINT4XCH7		PD15
	APOINT4XCH9		PA1
	APOINT4XCH11		PA3
	APOINT4XCH13		PA5
	APOINT4XCH27		PB11
	APOINT4XCH29		PB13
	APOINT4XCH31		
ADC0	APOINT4YCH2	BUSDY	
	APOINT4YCH4		
	APOINT4YCH6		PD14
	APOINT4YCH8		PA0
	APOINT4YCH10		PA2
	APOINT4YCH12		PA4
	APOINT4YCH28		
	APOINT4YCH30		
IDAC0	APOINT1XCH2	BUSCX	
	APOINT1XCH4		
	APOINT1XCH6		PD14
	APOINT1XCH8		PA0
	APOINT1XCH10		PA2
	APOINT1XCH12		PA4
	APOINT1XCH28		
	APOINT1XCH30		

Analog Module	Analog Module Channel	Shared Bus	Pin
IDAC0	APOINT1YCH3	BUSCY	
	APOINT1YCH5		PD13
	APOINT1YCH7		PD15
	APOINT1YCH9		PA1
	APOINT1YCH11		PA3
	APOINT1YCH13		PA5
	APOINT1YCH27		PB11
	APOINT1YCH29		PB13
	APOINT1YCH31		

8. Package Specifications

8.1 BGM121/BGM123 Dimensions

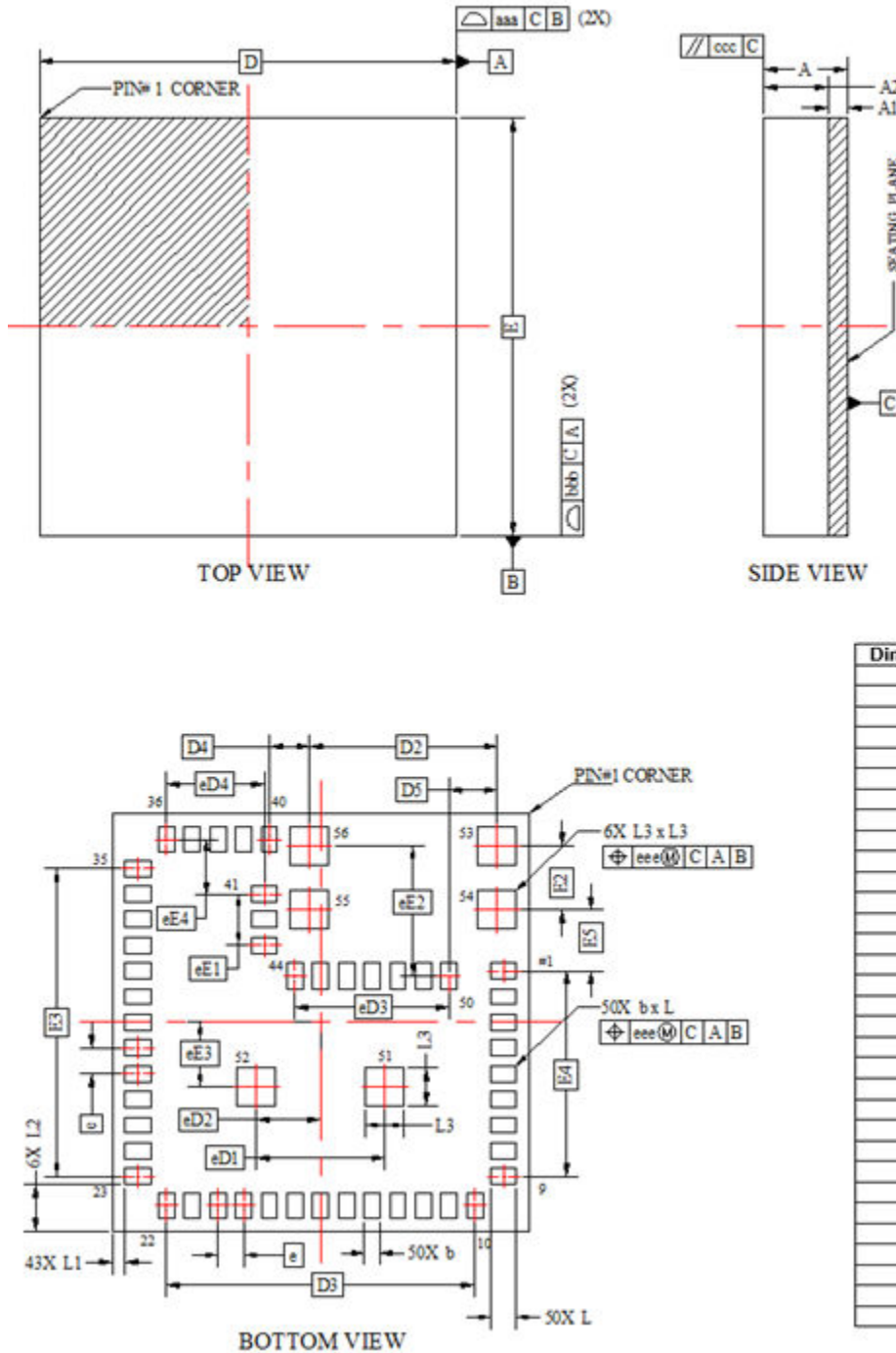


Figure 8.1. BGM121/BGM123 Package Dimensions

8.2 BGM121/BGM123 Module Dimensions and Footprint

The figure below shows the Module dimensions and footprint.

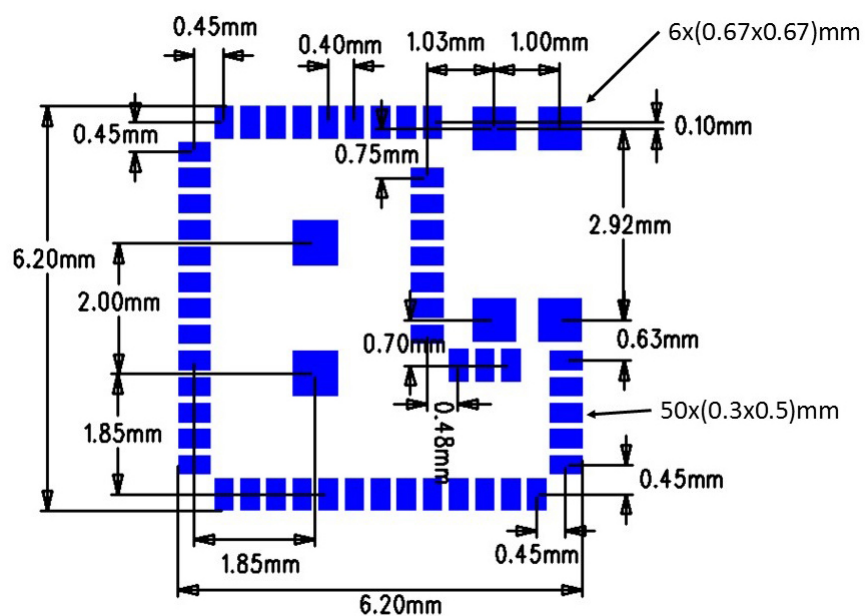
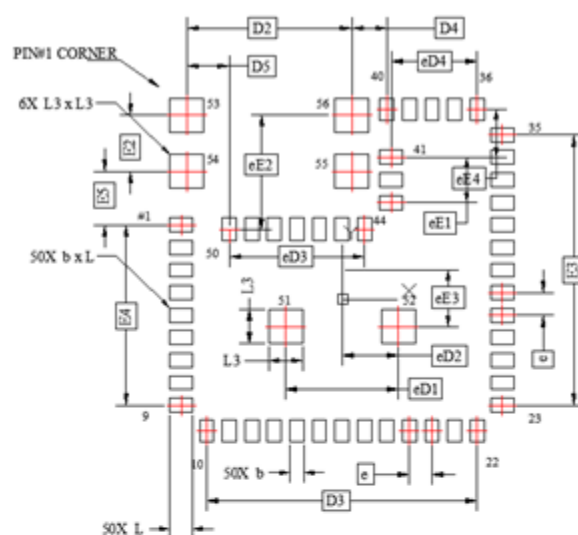


Figure 8.2. BGM121/BGM123 Dimensions and Footprint

8.3 BGM121/BGM123 Land Pattern

The figure below shows the recommended land pattern.



Symbol	MIN	NOM (mm)	MAX
b	0.15	0.25	0.35
D2		2.925 BSC	
D3		4.80 BSC	
D4		0.625 BSC	
D5		0.75 BSC	
e		0.40 BSC	
E2		1.00 BSC	
E3		4.80 BSC	
E4		3.20 BSC	
E5		0.95 BSC	
L	0.30	0.40	0.50
L3	0.50	0.60	0.70
eD1		2.00 BSC	
eD2		1.00 BSC	
eD3		2.40 BSC	
eD4		1.525 BSC	
eE1		0.80 BSC	
eE2		2.025 BSC	
eE3		1.00 BSC	
eE4		0.85 BSC	

Figure 8.3. BGM121/BGM123 Land Pattern

8.4 BGM121/BGM123 Package Marking

The figure below shows the Module markings printed on the RF-shield.



Figure 8.4. BGM121/BGM123 Package Marking

9. Tape and Reel Specifications

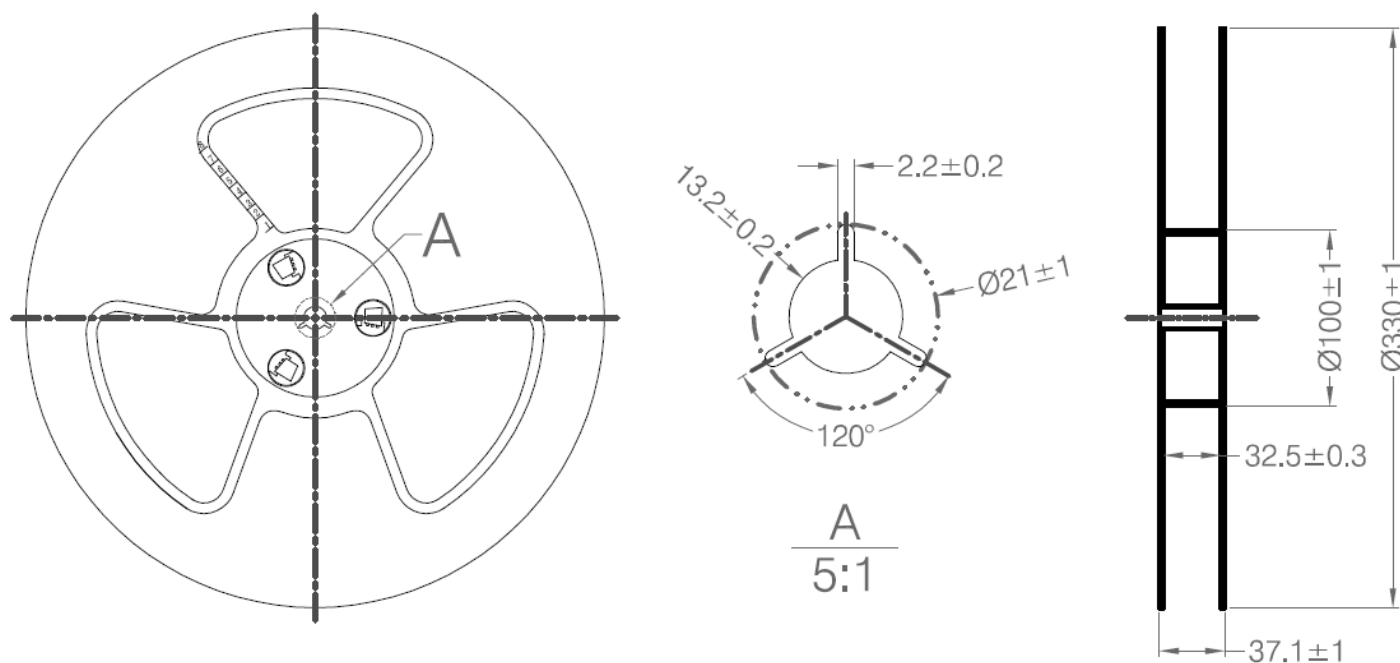
9.1 Tape and Reel Packaging

This section contains information regarding the tape and reel packaging for the BGM121/BGM123 Blue Gecko Module.

9.2 Reel and Tape Specifications

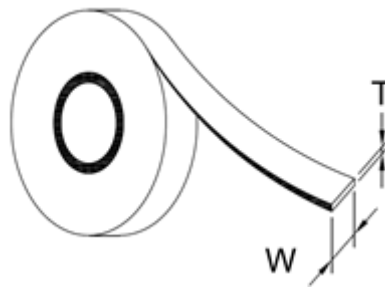
- Reel material: Polystyrene (PS)
- Reel diameter: 13 inches (330 mm)
- Number of modules per reel: 1000 pcs
- Disk deformation, folding whitening and mold imperfections: Not allowed
- Disk set: consists of two 13 inch (330 mm) rotary round disks and one central axis (100 mm)
- Antistatic treatment: Required
- Surface resistivity: $10^4 - 10^9 \Omega/\text{sq.}$

Figure 9.1. Reel Dimensions - Side View



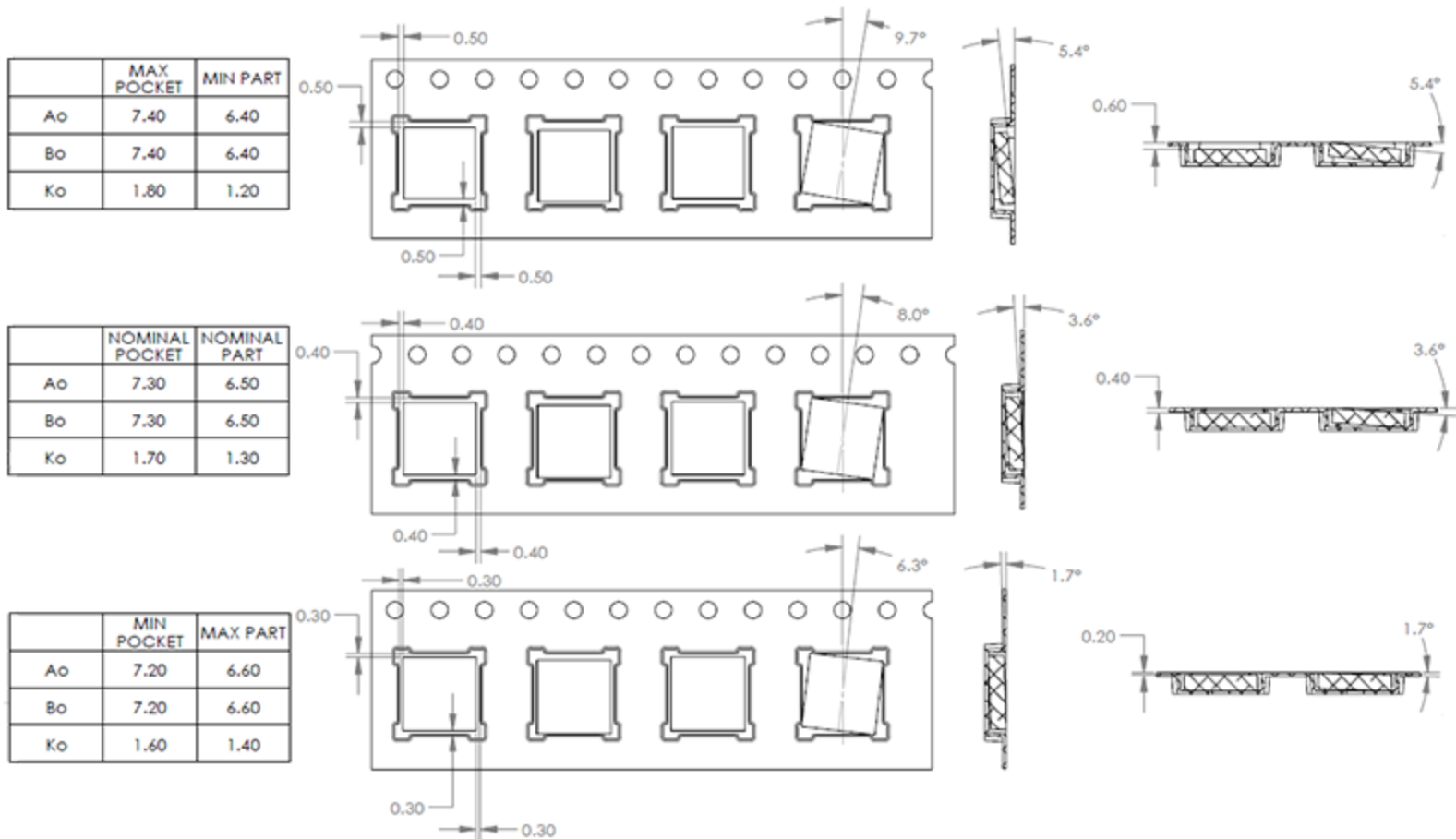
Symbol	Dimensions [mm]
W0	32.5 ± 0.3
W1	37.1 ± 1.0

Figure 9.2. Cover tape information



Symbol	Dimensions [mm]
Thickness (T)	0.061
Width (W)	25.5 + 0.2

Figure 9.3. Tape information



9.3 Orientation and Tape Feed

The user direction of feed, start and end of tape on reel and orientation of the Modules on the tape are shown in the figures below.

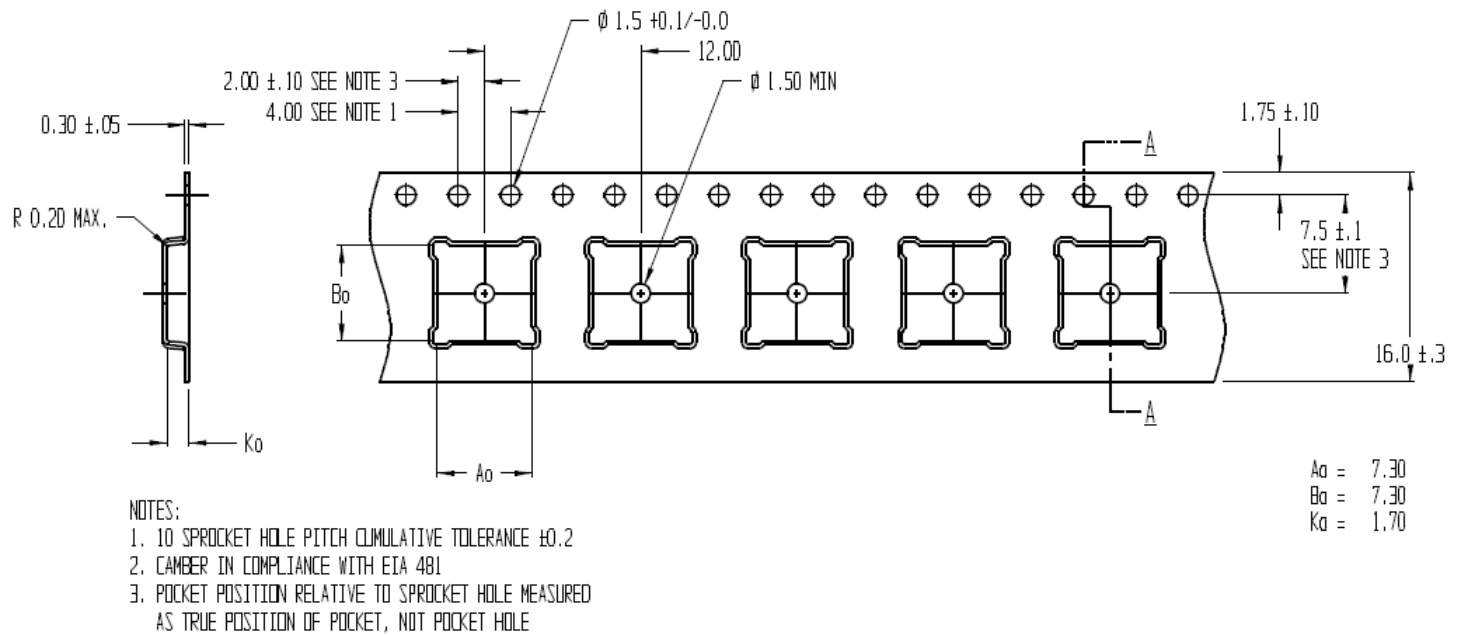
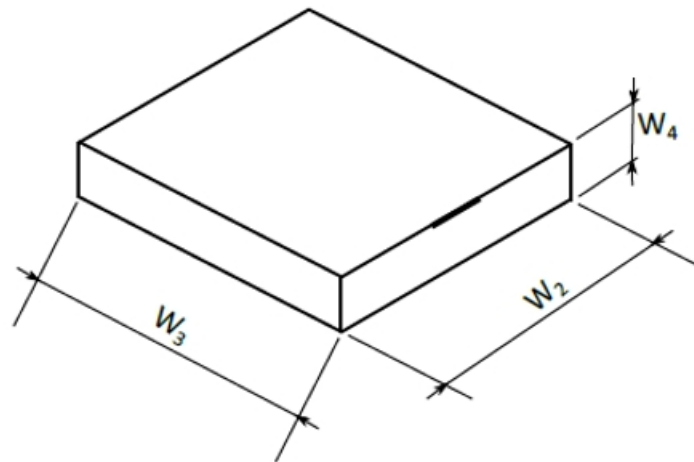


Figure 9.4. Module Orientation and Feed Direction

9.4 Tape and Reel Box Dimensions

Figure 9.5. Tape and Reel Box Dimensions



Symbol	Dimensions [mm]
W_2	368
W_3	338
W_4	72

9.5 Moisture Sensitivity Level

Reels are delivered in packing which conforms to MSL3 (Moisture Sensitivity Level 3) requirements.

10. Soldering Recommendations

10.1 Soldering Recommendations

This section describes the soldering recommendations regarding BGM121/BGM123 Module.

BGM121/BGM123 is compatible with industrial standard reflow profile for Pb-free solders. The reflow profile used is dependent on the thermal mass of the entire populated PCB, heat transfer efficiency of the oven, and particular type of solder paste used.

- Refer to technical documentations of particular solder paste for profile configurations.
- Avoid using more than two reflow cycles.
- Aperture size of the stencil should be 1:1 with the pad size.
- A no-clean, type-3 solder paste is recommended.
- For further recommendation, please refer to the JEDEC/IPC J-STD-020, IPC-SM-782 and IPC 7351 guidelines.

11. Certifications

11.1 Bluetooth

The BGM121/BGM123 Bluetooth qualification is pending.

11.2 CE

The BGM121/BGM123 CE certification is pending.

11.3 FCC

The BGM121/BGM123 FCC certification is pending.

11.4 IC

The BGM121/BGM123 IC certification is pending.

11.5 Japan

The BGM121/BGM123 Japan certification is pending.

12. Revision History

12.1 Revision 0.83

- Minor updates

12.2 Revision 0.82

- Updated electrical characteristics
- Updated package dimensions
- Updated footprint

12.3 Revision 0.81

- Layout guidelines updated
- Reference schematics added
- Tape and Reel specifications added

12.4 Revision 0.80

- Soldering recommendatoions added
- EM4 shutoff maximum current updated
- Radion patterns added
- Package marking added

12.5 Revision 0.79

- Electrical characterisitics updated

12.6 Revision 0.78

- Name of datasheet changed from "BGM12 Datasheet" to "BGM121/BGM123 Datasheet"
- Port D9 / Pin 7 marked as "Reserved".
- Number of GPIO pins reduced from 32 to 29.
- Number of pins connected to Analog Port reduced from 32 to 29.
- Ordering info for full production part numbers included.

12.7 Revision 0.77

- Power, Ground, Debug, Host UART, SPI, I2C Connections figure updated.

12.8 Revision 0.76

- GPIO pin data updated
- Module pinout corrected (V_1V8 and V_BATT exchanged)
- PB14 and PB15 marked DNC (Do Not Connect)

12.9 Revision 0.75

- OPN table updated
- Max TX power updated

12.10 Revision 0.74

- Land pattern added

12.11 Revision 0.73

- Updated pin definitions
- Updated pinout

12.12 Revision 0.72

- Updated pin definitions
- Updated package specifications
- Added SPI reference schematic
- Updated layout guidelines

12.13 Revision 0.71

- Updated electrical characteristics

12.14 Revision 0.70

- Initial draft

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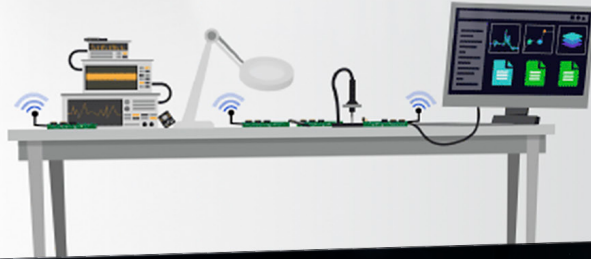
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